

Service Manual

Telephone Equipment

Model No. **KX-TG6551CAM**
KX-TGA650RUM
KX-TGA651RUM

AOH and Caller ID Compatible

Digital Cordless Phone

M: Metallic Grey Version

(for Kazakhstan)

(for Tajikistan)

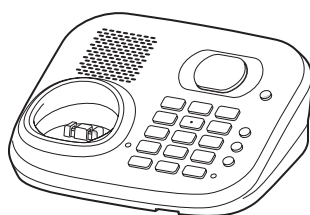
(for Uzbekistan)

(for Turkmenistan)

(for Kyrgyzstan)



KX-TGA650RUM/651RUM
(Handset)



KX-TG6551CAM
(Base Unit)



(Charger Unit)

Configuration for each model


Model No	Base Unit	Handset	Charger Unit	Expandable
KX-TG6551	1 (TG6551)	1 (TGA650)		Up to 6
KX-TGA651*		1 (TGA651)	1	

* KX-TGA651 is also an optional accessory, which contains a handset and a charger.

**WARNING**

This service information is designed for experienced repair technicians only and is not designed for use by the general public. It does not contain warnings or cautions to advise non-technical individuals of potential dangers in attempting to service a product. Products powered by electricity should be serviced or repaired only by experienced professional technicians. Any attempt to service or repair the product or products dealt with in this service information by anyone else could result in serious injury or death.

IMPORTANT SAFETY NOTICE

There are special components used in this equipment which are important for safety. These parts are marked by  in the Schematic Diagrams, Circuit Board Diagrams, Exploded Views and Replacement Parts List. It is essential that these critical parts should be replaced with manufacturer's specified parts to prevent shock, fire or other hazards. Do not modify the original design without permission of manufacturer.

IMPORTANT INFORMATION ABOUT LEAD FREE, (PbF), SOLDERING

If lead free solder was used in the manufacture of this product, the printed circuit boards will be marked PbF. Standard leaded, (Pb), solder can be used as usual on boards without the PbF mark. When this mark does appear, please read and follow the special instructions described in this manual on the use of PbF and how it might be permissible to use Pb solder during service and repair work.

- When you note the serial number, write down all 11 digits. The serial number may be found on the bottom of the unit.
- The illustrations in this Service Manual may vary slightly from the actual product.

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1 Safety Precautions

1.1. For Service Technicians

- **Repair service shall be provided in accordance with repair technology information such as service manual so as to prevent fires, injury or electric shock, which can be caused by improper repair work.**

1. When repair services are provided, neither the products nor their parts or members shall be remodeled.
2. If a lead wire assembly is supplied as a repair part, the lead wire assembly shall be replaced.
3. FASTON terminals shall be plugged straight in and unplugged straight out.

- **ICs and LSIs are vulnerable to static electricity.**

When repairing, the following precautions will help prevent recurring malfunctions.

1. Cover plastic parts boxes with aluminum foil.
2. Ground the soldering irons.
3. Use a conductive mat on worktable.
4. Do not grasp IC or LSI pins with bare fingers.

2 Warning

2.1. Battery Caution

1. Danger of explosion if battery is incorrectly replaced.
2. Replace only with the same or equivalent type recommended by the manufacturer.
3. Dispose of used batteries according to the manufacture's Instructions.

2.2. About Lead Free Solder (Pbf: Pb free)

Note:

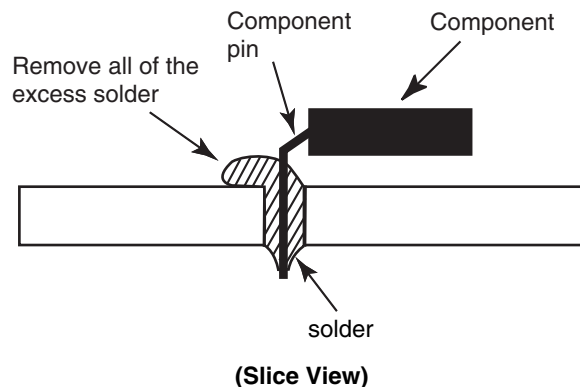
In the information below, Pb, the symbol for lead in the periodic table of elements, will refer to standard solder or solder that contains lead.

We will use PbF solder when discussing the lead free solder used in our manufacturing process which is made from Tin (Sn), Silver (Ag), and Copper (Cu).

This model, and others like it, manufactured using lead free solder will have PbF stamped on the PCB. For service and repair work we suggest using the same type of solder.

Caution

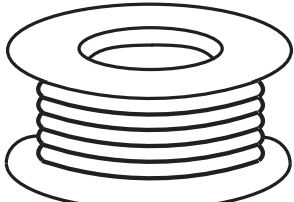
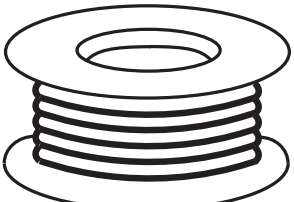
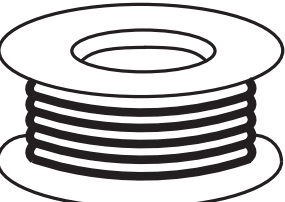
- PbF solder has a melting point that is 50 °F ~ 70 °F (30 °C ~ 40 °C) higher than Pb solder. Please use a soldering iron with temperature control and adjust it to 700 °F ± 20 °F (370 °C ± 10 °C).
- Exercise care while using higher temperature soldering irons.:
Do not heat the PCB for too long time in order to prevent solder splash or damage to the PCB.
- PbF solder will tend to splash if it is heated much higher than its melting point, approximately 1100 °F (600 °C).
- When applying PbF solder to double layered boards, please check the component side for excess which may flow onto the opposite side (See the figure below).



2.2.1. Suggested PbF Solder

There are several types of PbF solder available commercially. While this product is manufactured using Tin, Silver, and Copper (Sn+Ag+Cu), you can also use Tin and Copper (Sn+Cu) or Tin, Zinc, and Bismuth (Sn+Zn+Bi). Please check the manufacturer's specific instructions for the melting points of their products and any precautions for using their product with other materials.

The following lead free (PbF) solder wire sizes are recommended for service of this product: 0.3 mm, 0.6 mm and 1.0 mm.

0.3 mm X 100 g	0.6 mm X 100 g	1.0 mm X 100 g
		

2.3. Discarding of P.C. Board

When discarding P. C. Board, delete all personal information such as telephone directory and caller list or scrap P. C. Board.

3 Specifications

■ **Standard:**

DECT (Digital Enhanced Cordless Telecommunications),
GAP (Generic Access Profile)

■ **Number of channels:**

120 Duplex Channels

■ **Frequency range:**

1.88 GHz to 1.90 GHz

■ **Duplex procedure:**

TDMA (Time Division Multiple Access)

■ **Channel spacing:**

1,728 kHz

■ **Bit rate:**

1,152 kbit/s

■ **Modulation:**

GFSK (Gaussian Frequency Shift Keying)

■ **RF transmission power:**

Approx. 10 mW (average power per channel)

■ **Voice coding:**

ADPCM 32 kbit/s

■ **Power source (AC Adaptor):**

220–240 V AC, 50/60 Hz

Base unit: PQLV219CEW

Charger: PQLV219CEW

■ **Power consumption**

Base unit:

Standby: Approx. 0.6 W

Maximum: Approx. 4.0 W

Charger:

Standby: Approx. 0.2 W

Maximum: Approx. 3.0 W

■ **Operating conditions:**

0 °C–40 °C, 20 %–80 % relative air humidity (dry)

■ **Dimensions:**

Base unit: Approx. 149 mm x 128 mm x 64 mm

Handset: Approx. 48 mm x 32 mm x 160 mm

Charger: Approx. 72 mm x 85 mm x 52 mm

■ **Mass (weight):**

Base unit: Approx. 260 g

Handset: Approx. 130 g

Charger: Approx. 60 g

Note:

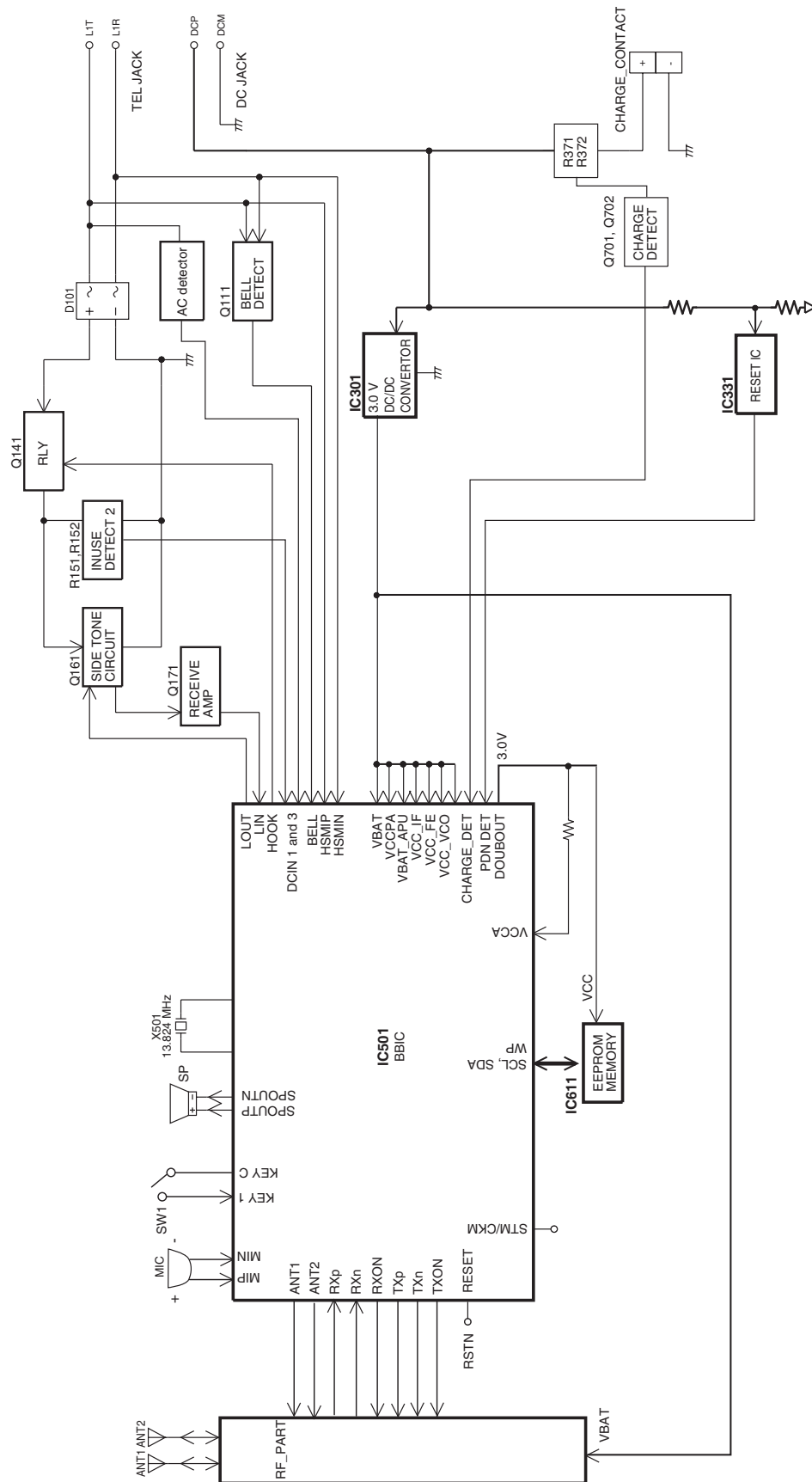
- Design and specifications are subject to change without notice.

Note for Service:

- **Operation range:** Up to 300 m outdoors, Up to 50 m indoors, depending on the condition.
- **Analog telephone connection:** Telephone Line

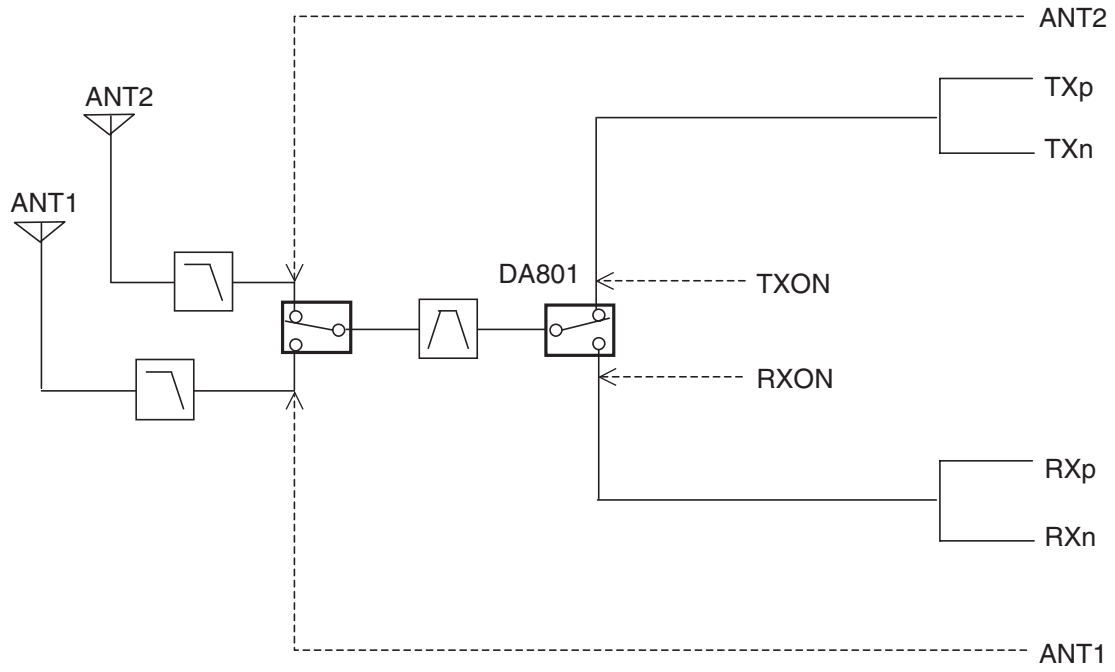
4 Technical Descriptions

4.1. Block Diagram (Base Unit_Main)



KX-TG6551 BLOCK DIAGRAM (Base Unit_Main)

4.2. Block Diagram (Base Unit_RF Part)



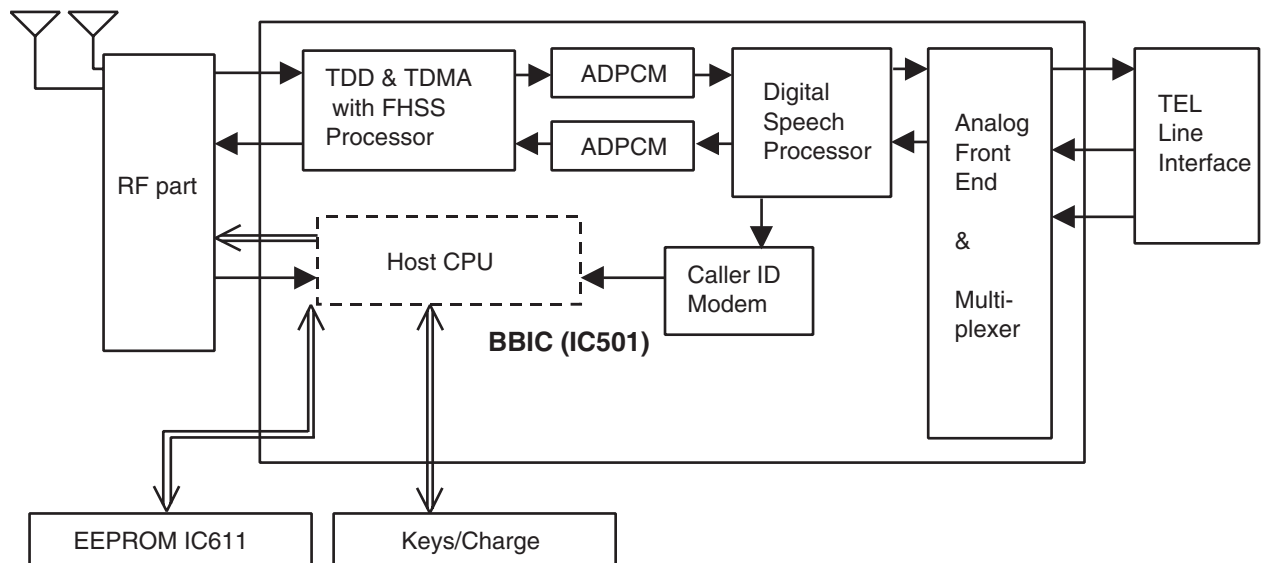
KX-TG6551 BLOCK DIAGRAM (Base Unit_RF Part)

4.3. Circuit Operation (Base Unit)

General Description:

(BBIC, EEPROM) is a digital speech/signal processing system that implements all the functions of speech compression, record and playback, and memory management required in a digital telephone.

The BBIC system is fully controlled by a host processor. The host processor provides activation and control of all that functions as follows.



4.3.1. BBIC (Base Band IC: IC501)

- **DTMF Generator**

When the DTMF data from the handset is received, the DTMF signal is output.

- **Caller ID demodulation**

The BBIC implements monitor and demodulate the FSK/DTMF signals that provide CID information from the Central Office.

- **Digital Switching**

The voice signal from telephone line is transmitted to the handset or the voice signal from the handset is transmitted to the Telephone line, etc. They are determined by the signal path route operation of voice signal.

- **Block Interface Circuit**

RF part, Key scan, Telephone line.

4.3.2. EEPROM (IC611)

Following information data is stored.

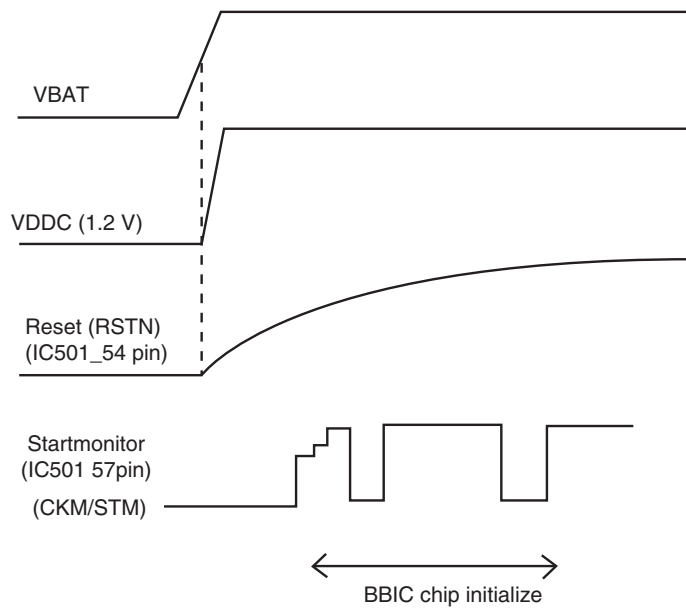
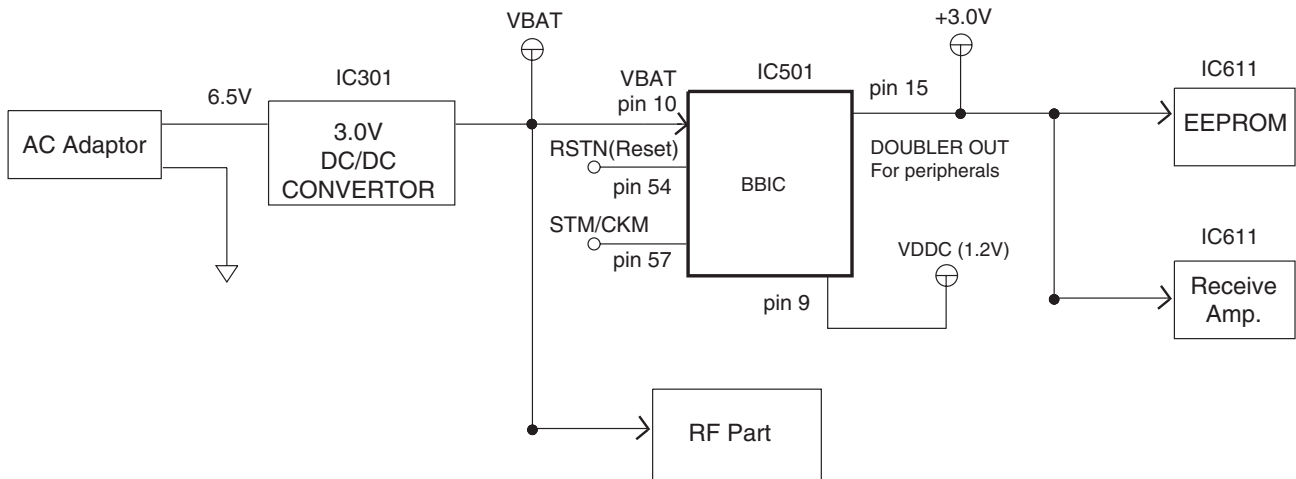
- **Settings**

ex: message numbers, ID code, Flash Time, Tone/Pulse

4.3.3. Power Supply Circuit/Reset Circuit

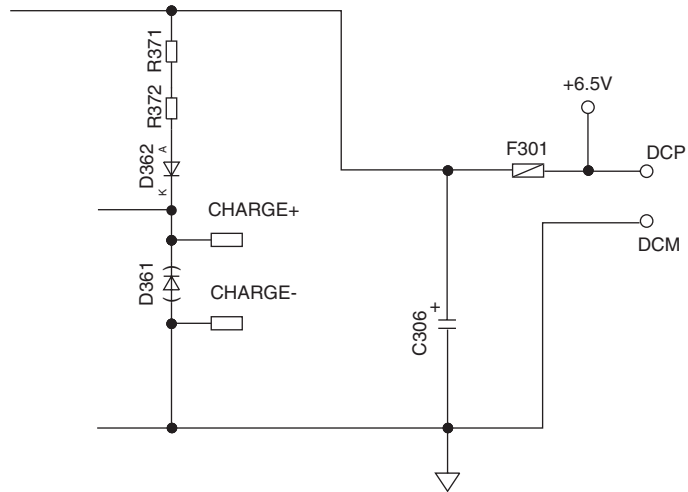
The power supply voltage from AC adaptor is converted to VBAT (3.0V) in IC302. And +3.0V for peripherals and analog part is insulated from VBAT by Doubler of BBIC.

Circuit Operation:



4.3.3.1. Charge Circuit

The voltage from the AC adaptor is supplied to the charge circuits.



4.3.4. Telephone Line Interface

Telephone Line Interface Circuit:

Function

- Bell signal detection
- ON/OFF hook and pulse dial circuit
- Side tone circuit

Bell signal detection and OFF HOOK circuit:

In the idle mode, Q141 is open to cut the DC loop current and decrease the ring load. When ring voltage appears at the Tip (T) and Ring (R) leads (When the telephone rings), the AC ring voltage is transferred as follows:

T → L101 → R111 → C111 → Q111 → BBIC pin 5 [BELL]

When the CPU (BBIC) detects a ring signal, Q141 turns on, thus providing an off-hook condition (active DC current flow through the circuit). Following signal flow is the DC current flow.

T → L101 → D101 → Q141 → Q161 → R163 → R167 → D101 → L102 → P101 → R

ON HOOK Circuit:

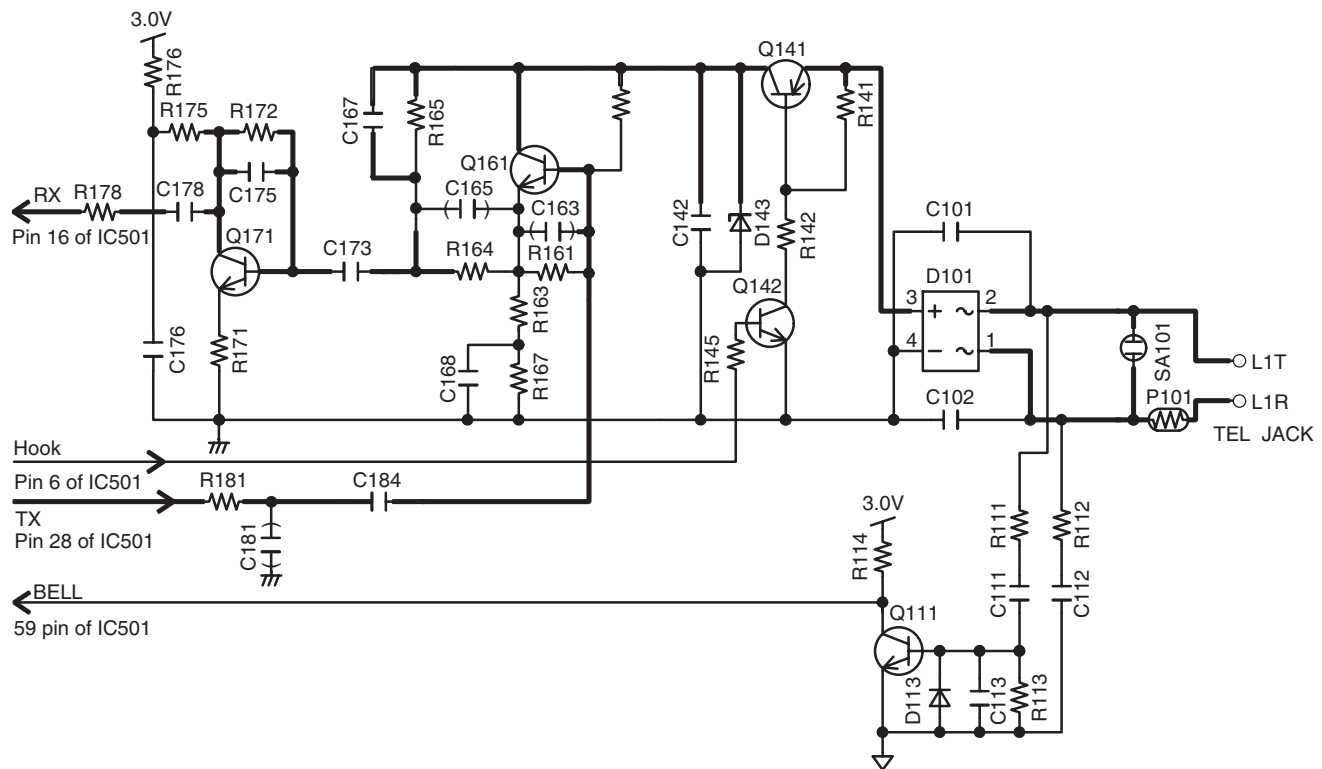
Q141 is open, Q141 is connected as to cut the DC loop current and to cut the voice signal. The unit is consequently in an on-hook condition.

Pulse Dial Circuit:

Pin 6 of BBIC turns Q141 ON/OFF to make the pulse dialing.

Side Tone Circuit:

Basically this circuit prevents the TX signal from feeding back to RX signal. As for this unit, TX signal feed back from Q161 is canceled by the canceller circuit of BBIC.



4.3.5. Parallel Connection Detect Circuit

Function:

In order to disable call waiting and stutter tone functions when using telephones connected in parallel, it is necessary to have a circuit that judges whether a telephone connected in parallel is in use or not. This circuit determines whether the telephone connected in parallel is on hook or off hook by detecting changes in the T/R voltage.

Circuit Operation:

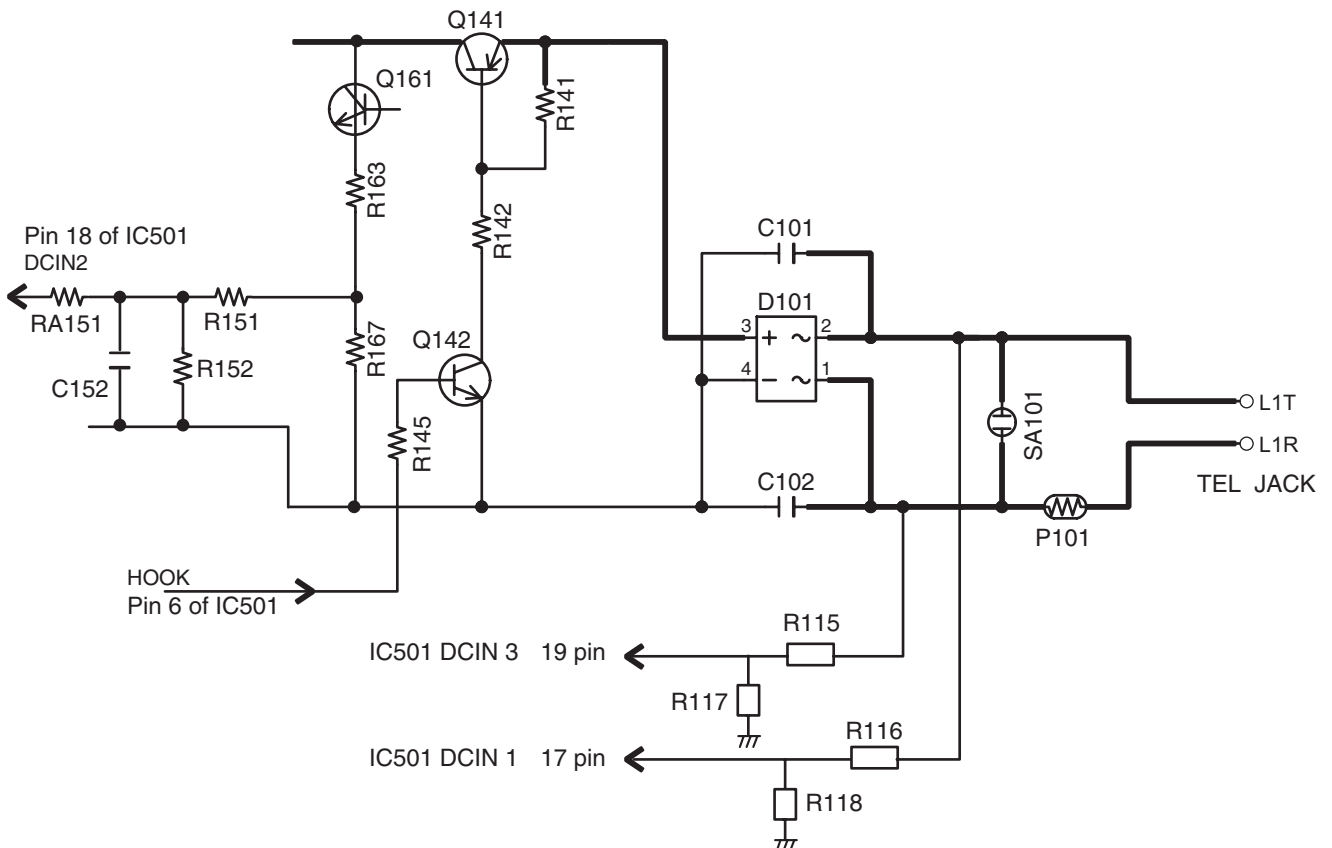
Parallel connection detection when on hook:

When on hook, the voltage is monitored at pin 17 of IC501. There is no parallel connection if the voltage is 0.54 V or higher, while a parallel connection is deemed to exist if the voltage is lower.

Parallel connection detection when off hook:

When off hook, the voltage is monitored at pin 18 of IC501; the presence/absence of a parallel connection is determined by detecting the voltage changes.

If the Auto disconnect function is ON and statuses are Hold, receiving ICM, OGM transmitting, BBIC disconnects the line after detecting parallel connection is off hook.



4.3.6. Transmitter/Receiver

- Audio Circuits and DTMF tone signal circuits.

Base Unit and Handset mainly consist of RF Module and DECT BBIC.

Base Unit and Handset transmit/receive voice signal and data signal through the antenna on carrier frequency.

Signal Path:

*Refer to **Signal Route** (P.18).

4.3.6.1. Transmitter Block

The voice signal input from the TEL LINE interface goes to through DECT BBIC (IC501) as shown in **Block Diagram (Base Unit_Main)** (P.7)

The voice signal passes through the analog part of IC501 where it is amplified and converted to a digital audio stream signal. The burst switch controller processes this stream performing encryption and scrambling, adding the various other fields to produce the GAP (**Generic Access Profile**) standard DECT frame, assigning to a time slot and channel etc.

In IC501, the carrier frequency is changing, and frequency modulated RF signal is generated. RF signal is amplified, and radiated from antenna. Handset detects the voice signal or data signal in the circuit same as the following explanation of Receiver Block.

4.3.6.2. Receiver Block

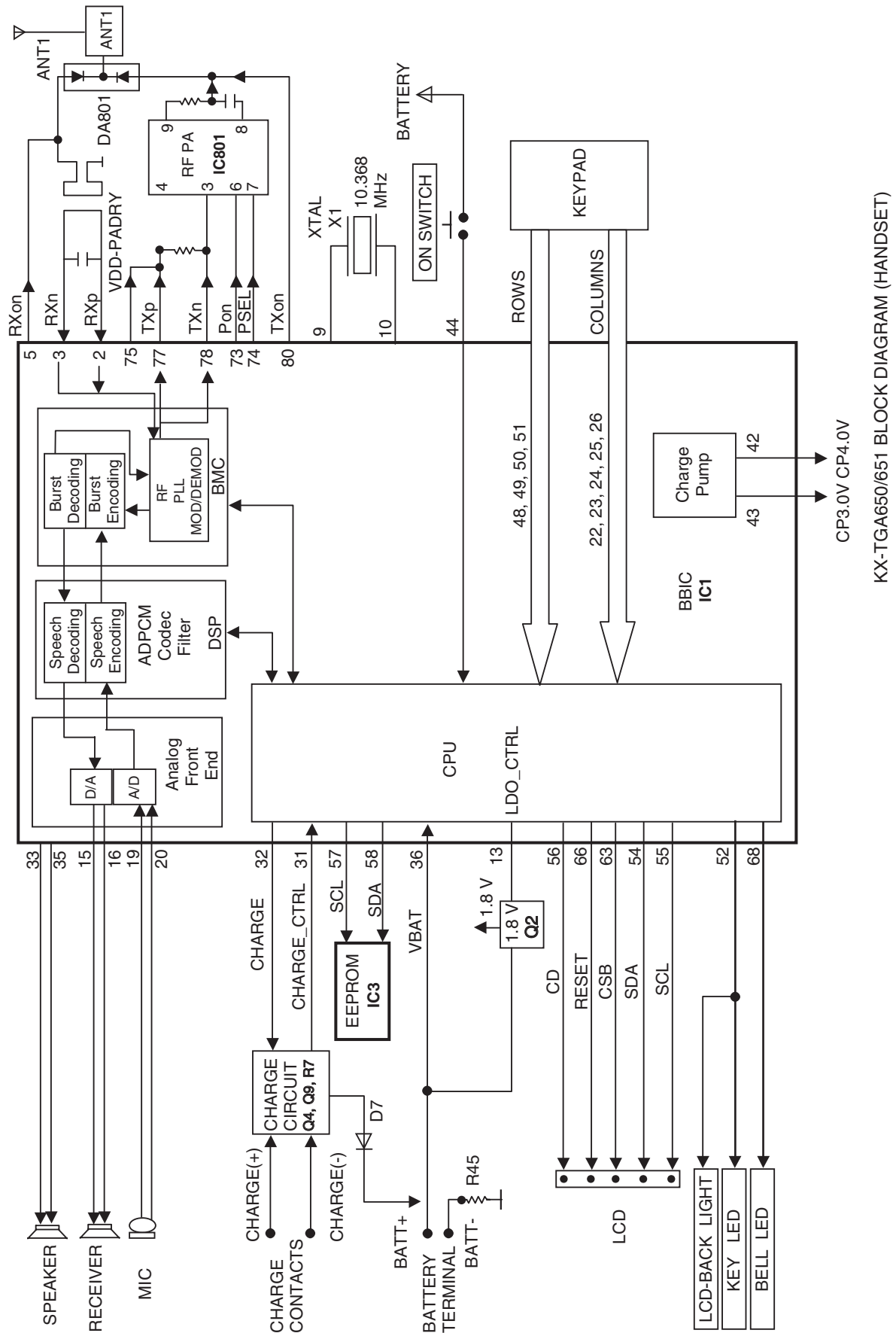
The signal of 1900 MHz band (1881.792 MHz ~ 1897.344 MHz) which is input from antenna is input to IC501 as shown in **Block Diagram (Base Unit_Main)** (P.7).

In IC501, the signal of 1900 MHz band is downconverted to 864 kHz signal and demodulated, as GAP (**Generic Access Profile**) standard DECT frames. It passes through the decoding section burst switch controller where it separates out the frame information and performs de-encryption and de-scrambling as required. It then goes to the DSP section where it is turned back into analog audio. This is amplified by the analog front end, and goes to the TEL LINE Interface.

4.3.7. Pulse Dialling

During pulse dialling the hookswitch (Q3, Q4) is used to generate the pulses using the HOOK control signal, which is set high during pulses. To force the line impedance low during the “pause” intervals between dial pulses, the PULSE_DIAL signal turns on Q2.

4.4. Block Diagram (Handset)



4.5. Circuit Operation (Handset)

4.5.1. Outline

Handset consists of the following ICs as shown in **Block Diagram (Handset)** (P.15).

- DECT BBIC (**B**ase **B**and IC): IC1
 - All data signals (forming/analyzing ACK or CMD signal)
 - All interfaces (ex: Key, Detector Circuit, Charge, DC/DC Converter, EEPROM, LCD, RF Power Amp.)
 - PLL Oscillator
 - Detector
 - Compress/Expander
 - Reception
- RF Power Amp: IC801
 - Amplifier for transmission
- EEPROM: IC3
 - Temporary operating parameters (for RF, etc.)

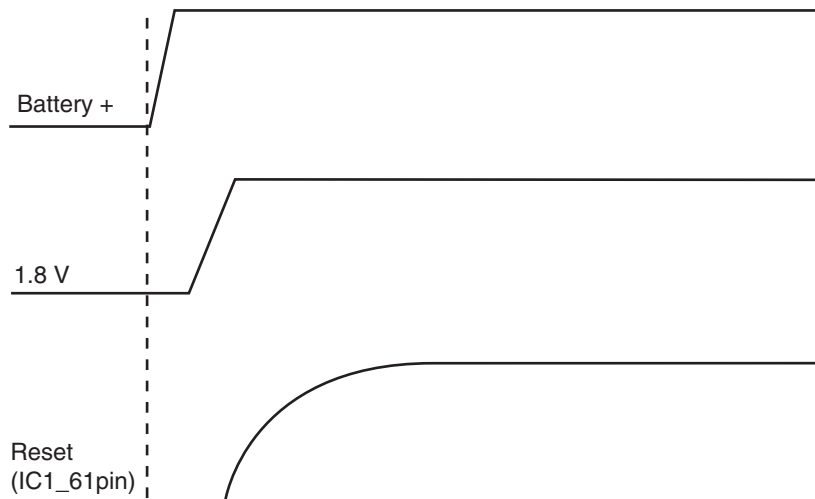
4.5.2. Power Supply Circuit/Reset Circuit

Circuit Operation:

When power on the Handset, the voltage is as follows;

BATTERY(2.2 V ~ 2.6 V: BATT+) → F1 → Q2 (1.8 V), IC1-43pin (2.5V)

The Reset signal generates IC1 (61 pin) and 1.8 V.



4.5.3. Charge Circuit

Circuit Operation:

When charging the handset on the Base Unit, the charge current is as follows;

DC+(6.5 V) → R56 → R55 → D22 → CHARGE+(Base) → CHARGE+(Handset) → Q4 → D7 → F1 → BATTERY+... Battery...

BATTERY- → R45 → GND → CHARGE-(Handset) → CHARGE-(Base) → GND → DC-(GND)

In this way, the BBIC on Handset detects the fact that the battery is charged.

The charge current is controlled by switching Q9 of Handset.

Refer to Fig.101 in **Power Supply Circuit/Reset Circuit** (P.10).

4.5.4. Battery Low/Power Down Detector

Circuit Operation:

"Battery Low" and "Power Down" are detected by BBIC which check the voltage from battery.

The detected voltage is as follows;

- Battery Low

Battery voltage: $V(\text{Batt}) \leq 2.25 \text{ V} \pm 50 \text{ mV}$

The BBIC detects this level and "☐" starts flashing.

- Power Down

Battery voltage: $V(\text{Batt}) \leq 2.0 \text{ V} \pm 50 \text{ mV}$

The BBIC detects this level and power down.

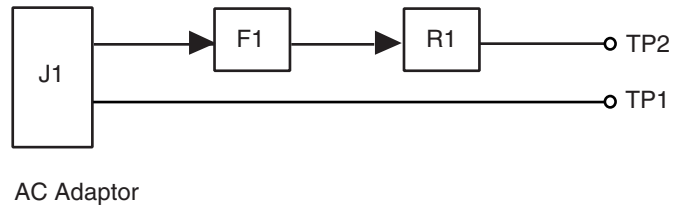
4.5.5. Speakerphone

The hands-free loudspeaker at SP+ and SP- is used to generate the ring alarm.

4.6. Circuit Operation (Charger Unit)

4.6.1. Power Supply Circuit

The power supply is as shown.



4.7. Signal Route

SIGNAL ROUTE	IN	→	ROUTE	→	OUT
HANDSET TX	<div> <HANDSET_RF_TX_ROUTE> - ANT. --- </div>				
	<div> ---ANT. - <BASE_UNIT_RF_RX_ROUTE> - IC501(46/47 - 28) - R181 - C184 - Q161 - Q141 - D101 - L101/[L102 - P101] - T/R(TEL LINE) </div>				
HANDSET RX	<div> T/R(TEL LINE) - L101/[P101 - L102] - D101 - Q141 - R165 - C173 - Q171 - C178 - R178 - IC501(16 - 44/45) - <BASE_UNIT_RF_TX_ROUTE> - ANT. --- </div>				
	<div> --- ANT. - <HANDSET_RF_RX_ROUTE> - IC1(28/27) - C86 - L74 - HEADSET_JACK(5 - 4) - R11 - HANDSET SPEAKER </div>				
HANDSET SP-Phone TX	<div> HANDSET MIC - R73/74 - C11/13 - RA4 - IC1(22/23) - <HANDSET_RF_TX_ROUTE> - ANT. --- </div>				
	<div> ---ANT. - <BASE_UNIT_RF_RX_ROUTE> - IC501(46/47 - 28) - R181 - C184 - Q161 - Q141 - D101 - L101/[L102 - P101] - T/R(TEL LINE) </div>				
HANDSET SP-Phone RX	<div> T/R(TEL LINE) - L101/[P101 - L102] - D101 - Q141 - R165 - C173 - Q171 - C178 - R178 - IC501(16-44/45) - <BASE_UNIT_RF_TX_ROUTE> - ANT. --- </div>				
	<div> --- ANT. - <HANDSET_RF_RX_ROUTE> - IC1(29/31) - Backside SP </div>				
BASE SP-Phone TX	<div> MIC - C457/C458 - RA452 - IC501 (23/22 - 28) - R181 - C184 - Q161 - Q141 - D101 - L101/[L102 - P101] - T/R(TEL LINE) </div>				
BASE SP-Phone RX	<div> T/R(TEL LINE) - L101/[P101 - L102] - D101 - Q141 - R165 - C173 - Q171 - C178 - R178 - IC501 (16 - 29/31) - L474/L476 - SPEAKER </div>				
INTERCOM HANDSET TO BASE UNIT	<div> HANDSET MIC - R73/74 - C11/13 - RA4 - IC1(22/23) - <HANDSET_RF_TX_ROUTE> - ANT. --- </div>				
	<div> --- ANT. - <BASE_UNIT_RF_RX_ROUTE> - IC501(46/47 - 29/31) - L474/L476 - SPEAKER </div>				
INTERCOM BASE UNIT TO HANDSET	<div> MIC - C457/C458 - RA452 - IC501(23/22 - 44/45) - <BASE_UNIT_RF_TX_ROUTE> - ANT. --- </div>				
	<div> --- ANT. - <HANDSET_RF_RX_ROUTE> - IC1(28/27) - C86 - L74 - HEADSET_JACK(5 - 4) - R11 - HANDSET SPEAKER </div>				
DTMF SIGNAL TO TEL LINE	<div> IC501(28) - R181 - C184 - Q161 - Q141 - D101 - L101/[L102 - P101] - T/R(TEL LINE) </div>				
CALLER ID	<div> T/R(TEL LINE) - L101/[P101 - L102] - C121/C122 - R121/R122 - IC501(24/25) </div>				
BELL DETECTION	<div> T/R(TEL LINE) - L101/[P101 - L102] - R111/R112 - C111/C112 - Q111 - IC501(5 </div>				

Note:

: inside of Handset

SIGNAL ROUTE	IN	→	ROUTE	→	OUT
HANDSET RF [TX_ROUTE]	IC1(44/45) - L809 - C812 - DA801 - C895 - ANT				
HANDSET RF [RX_ROUTE]	ANT - C895 - DA801 - C826 - IC1(46/47)				
BASE UNIT RF [TX_ROUTE]	IC501(44/45) - C812 - L809 - DA801 - C895 - DA802 - C893/C894 - ANT1/ANT2				
BASE UNIT RF [RX_ROUTE]	ANT1/ANT2 - C893/C894 - DA802 - C895 - DA801 - C826 - IC501(46/47)				

Note:

: inside of Handset

5 Location of Controls and Components

Refer to the Operating Instructions.

Note:

You can download and refer to the Operating Instructions (Instruction book) on TSN Server.

6 Installation Instructions

Refer to the Operating Instructions.

Note:

You can download and refer to the Operating Instructions (Instruction book) on TSN Server.



7 Operating Instructions

Refer to the Operating Instructions.

Note:

You can download and refer to the Operating Instructions (Instruction book) on TSN Server.

7.1. For Service Hint

Items	Contents
Battery	You could use other rechargeable batteries sold in a market, but the unit is not guaranteed to work properly.
	The battery strength may not be indicated correctly if the battery is disconnected and connected again, even after it is fully charged. In that case, by recharging the battery as mentioned in the Operating Instructions, you will get a correct indication of the battery strength.
PIN Code	<p>Change the PIN using the following method.</p> <p>1  → [#][1][3][2]</p> <p>2 [*][7][0][0][0]</p> <p>3 Enter the new 4-digit base unit PIN. → OK → []</p>

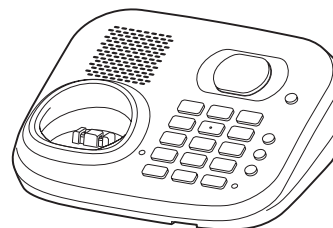
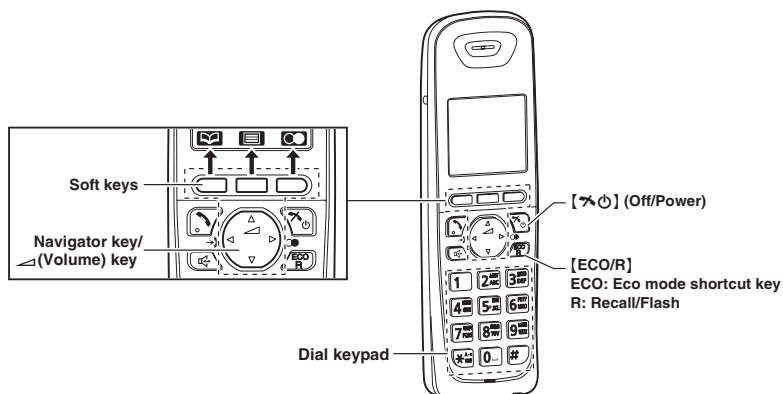
8 Service Mode

8.1. Engineering Mode

8.1.1. Base Unit

Important:

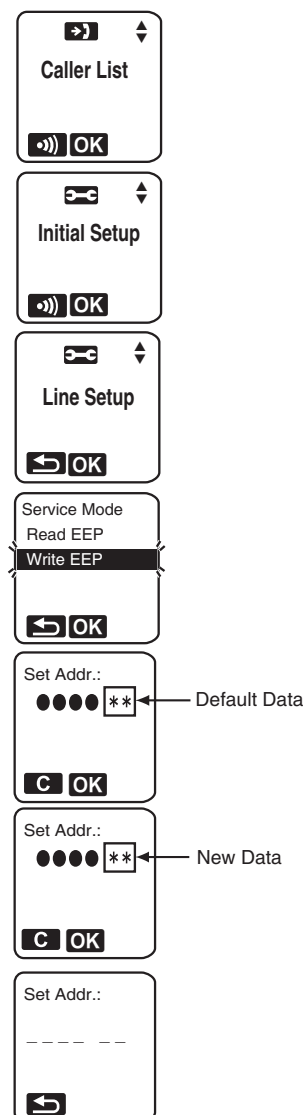
Make sure the address on LCD is correct when entering new data. Otherwise, you may ruin the unit.



H/S key operation

- 1). Register a Handset to a Base Unit. (*1)
- 2). Press .
- 3). Select "Initial Setup" using [] or [] then press **OK** or [] .
- 4). Select "Line Setup" using [] or [] then press **OK** or [] .
- 5). Enter "7", "2", "6", "2", "7", "6", "6", "4".
Note: 7262 7664 = PANA SONI
(see letters printed on dial keys)
- 6). Select "Write EEP" using [] or [] then press **OK** or [] .
- 7). Enter "0", "0", "0", "0" (Address). (*2)
- 8). Enter "*", "*" (New Data). (*2)
- 9). Press **OK** , a long confirmation beep will be heard.
- 10). Press [] (off) to return to standby mode.
After that, turn the base unit power off and then power on.

H/S LCD



Frequently Used Items (Base Unit)

ex.)

Items	Address	Default Data	New Data		Remarks
Frequency	00 08/00 07	01/00	-	-	Use these items in a READ-ONLY mode to confirm the contents. Careless rewriting may cause serious damage to the computer system.
ID	00 02~00 06	Given value	-	-	
Bell length	02 7B	32 (5sec) (*3)	1E (3 sec)	14 (2 sec)	This is time until bell stops ringing. (Unit: 100 ms)
PULSE Dial speed (10PPS -> 20PPS)	02 56	28 (40msec) (*3)	14 (20msec)	-	This is pulse make time. (Unit:1ms)
	02 57	3C (60msec) (*3)	1E (30msec)	-	This is pulse break time. (Unit:1ms)
	02 6A	57 (870msec) (*3)	2C (440msec)	-	This is inter-digit time in pulse mode. (Unit: 10ms)

Note:

(*1) Refer to **Registering a Handset to the Base Unit** (P.38).

(*2) When you enter the address or New Data, please refer to the table below.

Desired Number (hex)	Input Keys	Desired Number (hex)	Input Keys
0	0	A	[R] + 0
1	1	B	[R] + 1
.	.	C	[R] + 2
.	.	D	[R] + 3
.	.	E	[R] + 4
9	9	F	[R] + 5

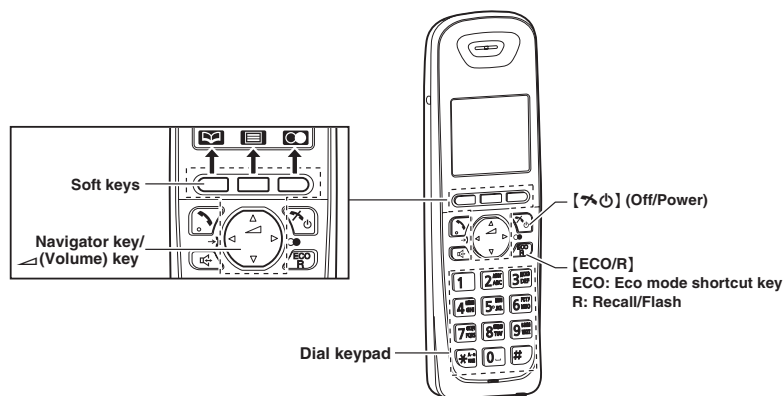
(*3)

Bell length	32(hex) = 50(dec) → $50 \times 100 \text{ msec} = 5000 \text{ msec}$ (5 sec)
PULSE Dial speed (10PPS -> 20PPS)	28(hex) = 40(dec) → $40 \times 1 \text{ msec} = 40 \text{ msec}$
	3C(hex) = 30(dec) → $60 \times 1 \text{ msec} = 60 \text{ msec}$
	57 (hex) = 87(dec) → $87 \times 10 \text{ msec} = 870 \text{ msec}$

8.1.2. Handset

Important:

Make sure the address on LCD is correct when entering new data. Otherwise, you may ruin the unit.



H/S key operation

- 1). Press .
- 2). Select "Initial Setup" using [] or [] then press **OK** or [].
- 3). Enter "7", "2", "6", "2", "7", "6", "6", "4".
Note: 7262 7664 = PANA SONI
(see letters printed on dial keys)
- 4). Select "Write EEP" using [] or [] then press **OK** or [].

- 5). Enter "●", "●", "●", "●" (Address). (*1)

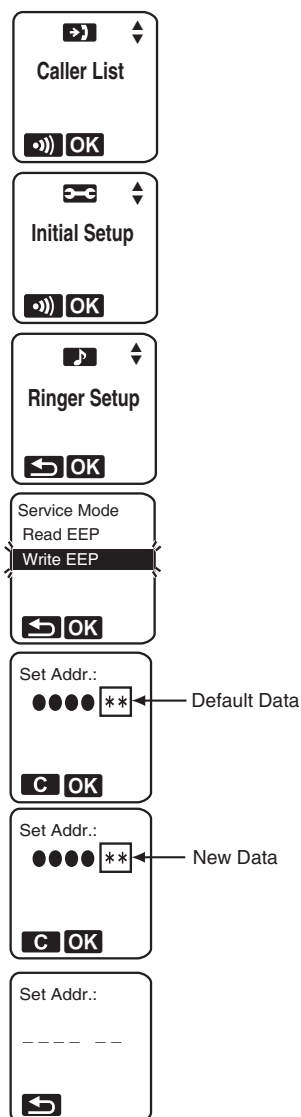
- 6). Enter " * ", " * " (New Data). (*1)

- 7). Press **OK**, a long confirmation beep will be heard.

- 8). Press [] (off) to return to standby mode.

After that, remove and reinsert the batteries. Press the Power button for about 1 second if the power is not turned on.

H/S LCD



Frequently Used Items (Handset)

ex.)

Items	Address	Default Data	New Data	Possible Adjusted Value MAX (hex)	Possible Adjusted Value MIN (hex)	Remarks
Sending level	03 17	Adjusted value	Given value	6F	00	(*2)
Receiving level	03 18	Adjusted value	Given value	00	3F	(*3)
Battery Low	00 09	70	-	-	-	(*4)
Frequency	00 08/00 07	02/70	-	-	-	
ID	00 10~00 14	Given value	-	-	-	

Note:

(*1) When you enter the address or New Data, please refer to the table below.

Desired Number (hex.)	Input Keys	Desired Number (hex.)	Input Keys
0	0	A	[R] + 0
1	1	B	[R] + 1
.	.	C	[R] + 2
.	.	D	[R] + 3
.	.	E	[R] + 4
9	9	F	[R] + 5

(*2) When adding "01" (hex) to default value, sending level increases by 0.25 dB.

ex.)

Item	Default Data	New Data	
	E7	EB	E3
Sending level	-5dBm	-4dBm	-6dBm

(*3) When reducing "01" (hex) from default value, receiving level increases by 0.25 dB.

ex.)

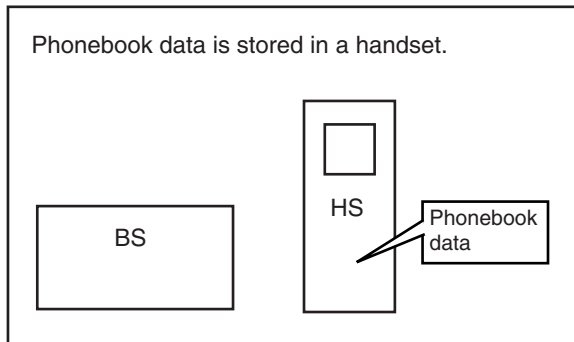
Item	Default Data	New Data	
	E7	EB	E3
Receiving level	-25dBm	-26dBm	-24dBm

(*4) Use these items in a READ-ONLY mode to confirm the contents. Careless rewriting may cause serious damage to the handset.

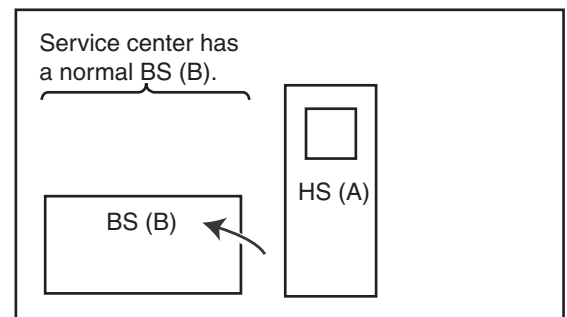
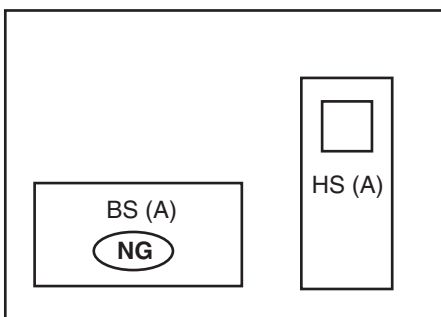
8.2. Copying Phonebook Items when Repairing

You can copy the handset phonebook to another (compatible Panasonic) handset. This will help to save the original phonebook data which the customer has registered.

Refer to the following procedures.

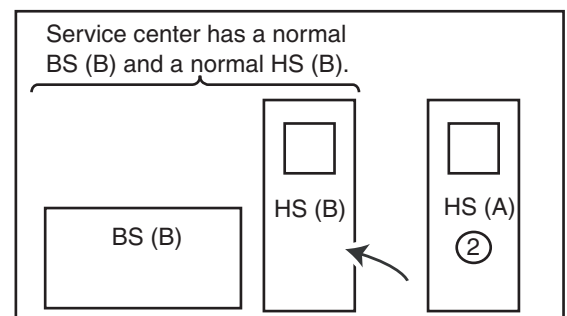
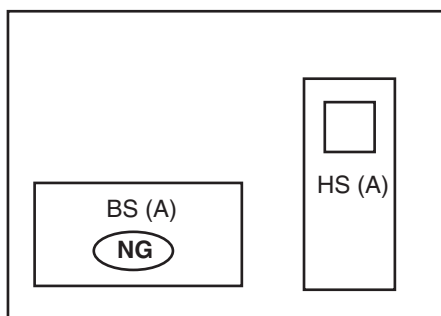


Case 1: A base unit has a defect.
(Replacing a base unit PCB etc...)



1. Register HS (A) to BS (B).
HS (A) is normal, therefore no need to copy the phonebook data.

Case 2: A base unit has a defect.
(Replacing both a base unit and a handset)

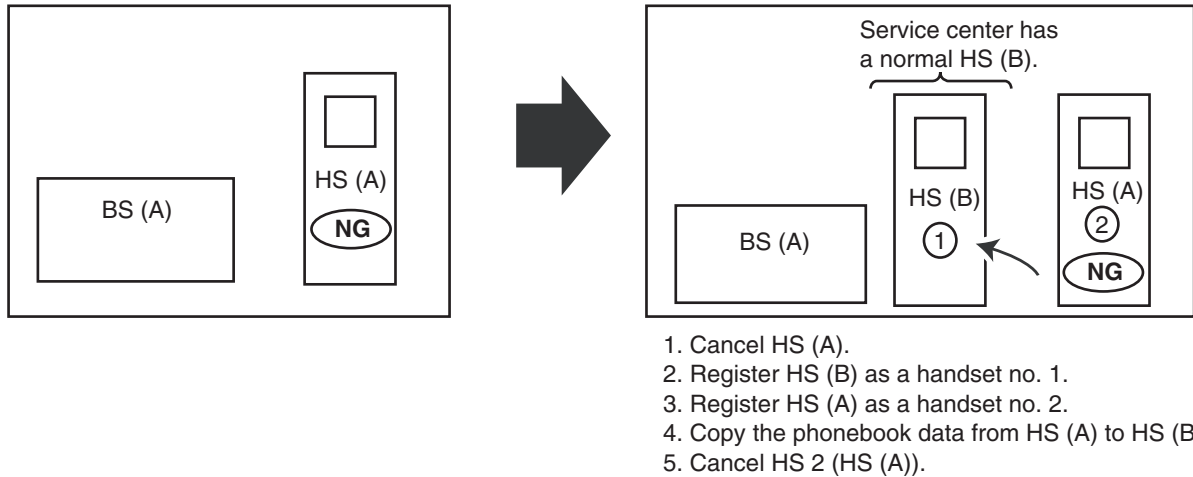


1. Register HS (A) to BS (B) as a handset no. 2.
2. Copy the phonebook data from HS (A) to HS (B).
3. Cancel the HS 2 (HS (A)).

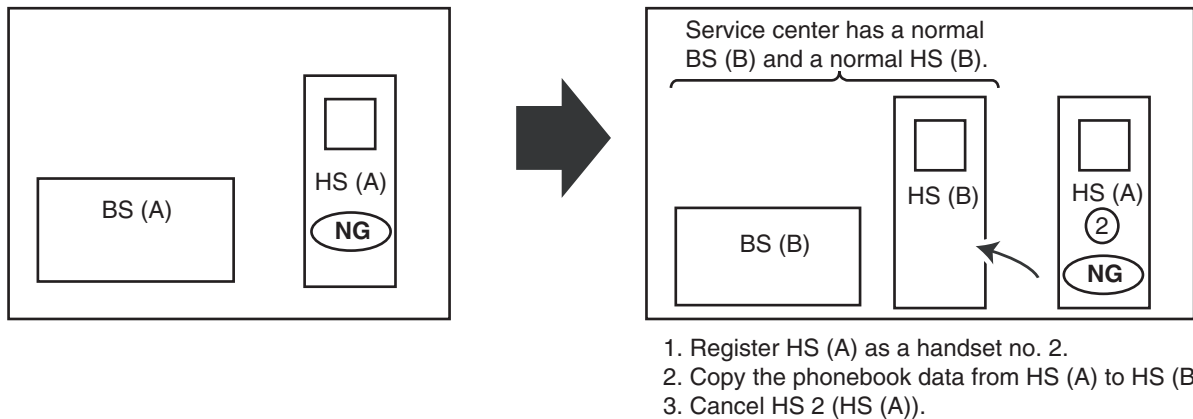
Note:

- BS=Base Unit, HS=Handset
- If the max number of handsets are already registered to the base unit, a new handset cannot be registered.
- To register the handset, refer to **Registering a Handset to the Base Unit** (P.38).
- To cancel the handset, refer to **Deregistering a Handset** (P.38).
- To copy the handset phonebook, refer to **Copying Phonebook Entries** in the Operating Instructions.

Case 3: A handset has a defect.
(Radio transmission is functioning.)



Case 4: A handset has a defect.
(Radio transmission is functioning.)



Note:

- BS=Base Unit, HS=Handset
- If the max number of handsets are already registered to the base unit, a new handset cannot be registered.
- To register the handset, refer to **Registering a Handset to the Base Unit** (P.38).
- To cancel the handset, refer to **Deregistering a Handset** (P.38).
- To copy the handset phonebook, refer to **Copying Phonebook Entries** in the Operating Instructions.

8.3. How to Clear User Setting

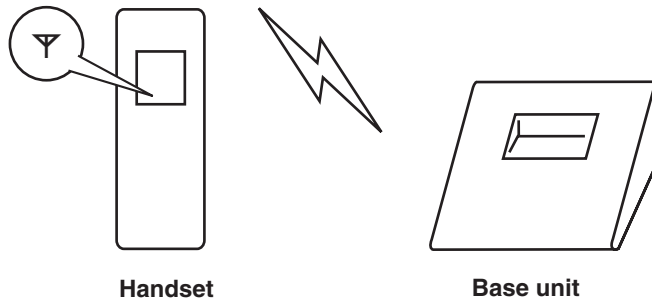
Units are reset to the Factory settings by this operation (Erase recorded Voice messages, stored Phone numbers, Caller list and etc.)

Note:

- Some menus are not reset. Refer to **Operating Instructions** (P.20).
- The reset menus differ depending on the following operations.
- **This operation should not be performed for a usual repair.**

8.3.1. Resetting both base unit and handset

Both the base unit and the registered handset which you did the following steps ① to ⑤ are reset. Other registered handsets will not be reset.



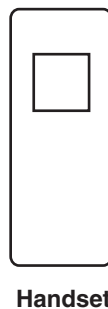
- ① Connect the AC adaptor to the base unit and install the charged batteries into the handset.
- ② Confirm the handset is registered to the base unit (㊚ lights).
If the handset is not registered to the base unit (㊚ lights), register it. (*1)
- ③ Lift the handset and press **【㊚①】** to put the handset in standby mode.
- ④ Press **【1】**, **【5】**, **【9】** and **【✖】** key of the handset simultaneously until a confirmation tone is heard.
- ⑤ Disconnect the AC adaptor, then remove the battery.

Note:

(*1) Refer to **Registering a Handset to the Base Unit** (P.38).

8.3.2. Resetting only handset

The only handset is reset by doing the following steps ① to ④.



- ① Install the charged batteries into the handset.
- ② Lift the handset and press **【㊚①】** to put the handset in standby mode.
- ③ Press **【3】**, **【5】**, **【7】** and **【#】** key of the handset simultaneously until a confirmation tone is heard. (*2)
- ④ Remove the battery.

Note: (*2)

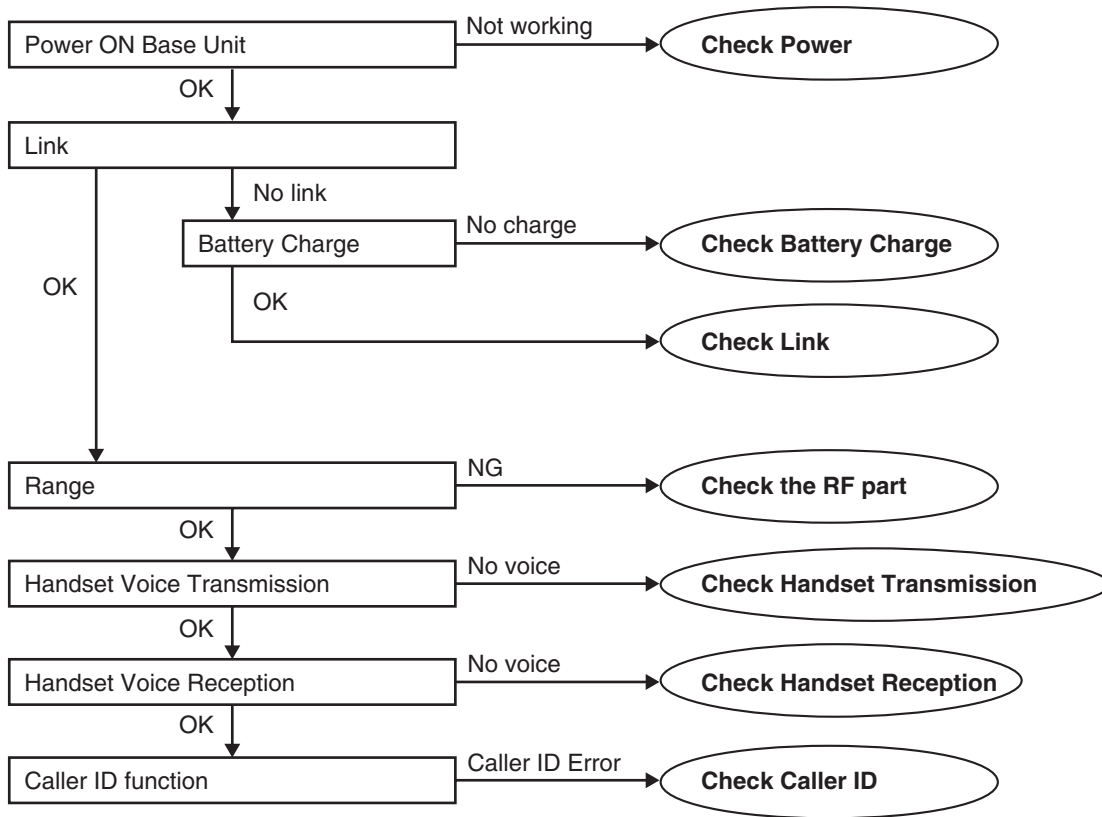
- The handset registration to the base unit is cancelled.
- If the handset needs to be registered to the base unit, refer to **Registering a Handset to the Base Unit** (P.38).
- If users do not bring the base unit with them, the registration procedure has to be done by users themselves.

9 Troubleshooting Guide

9.1. Troubleshooting Flowchart

Flow Chart

FLOW CHART



Cross Reference:

Check Power (P.29)

Check Battery Charge (P.30)

Check Link (P.31)

Check the RF part (P.35)

Check Handset Transmission (P.39)

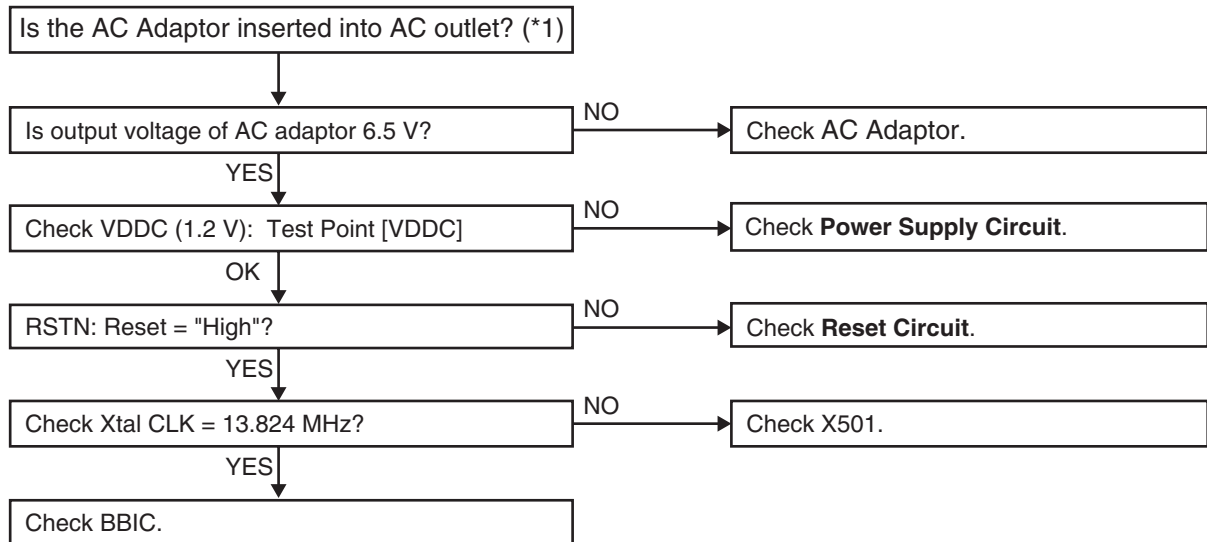
Check Handset Reception (P.39)

Check Caller ID (P.39)

9.1.1. Check Power

9.1.1.1. Base Unit

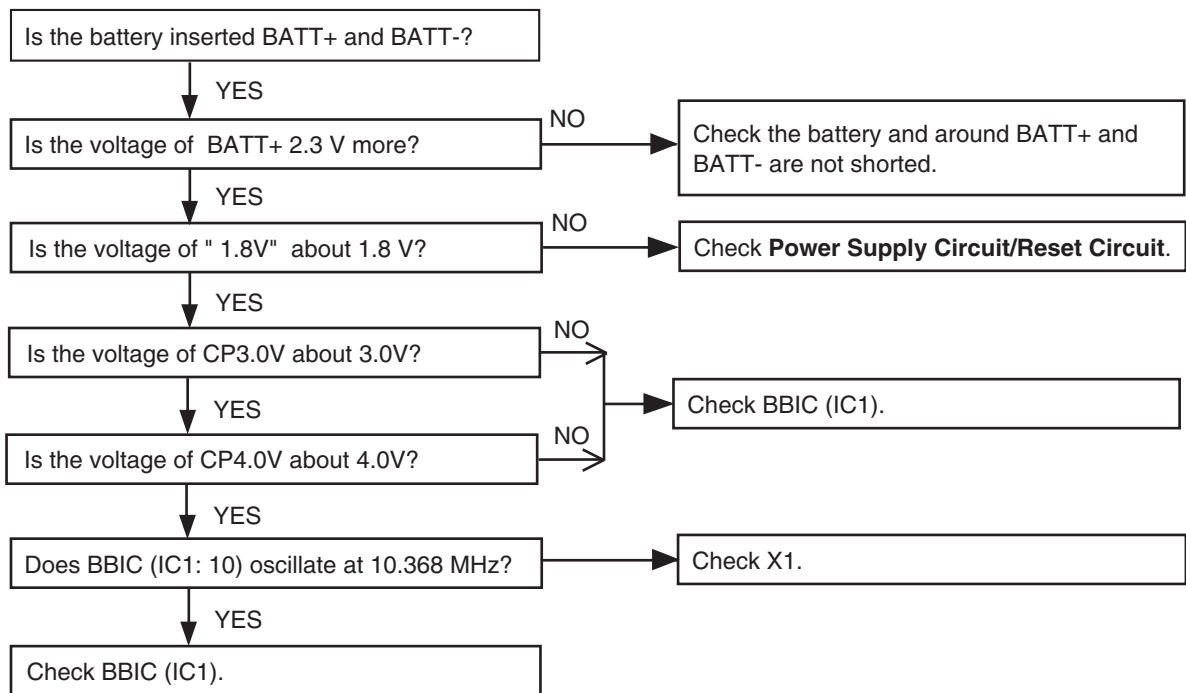
Is the AC Adaptor inserted into AC outlet? (*1)



Cross Reference:
Power Supply Circuit/Reset Circuit (P.10)

Note:
 BBIC is IC501.
 (*1) Refer to Specifications (P.6) for part number and supply voltage of AC adaptor.

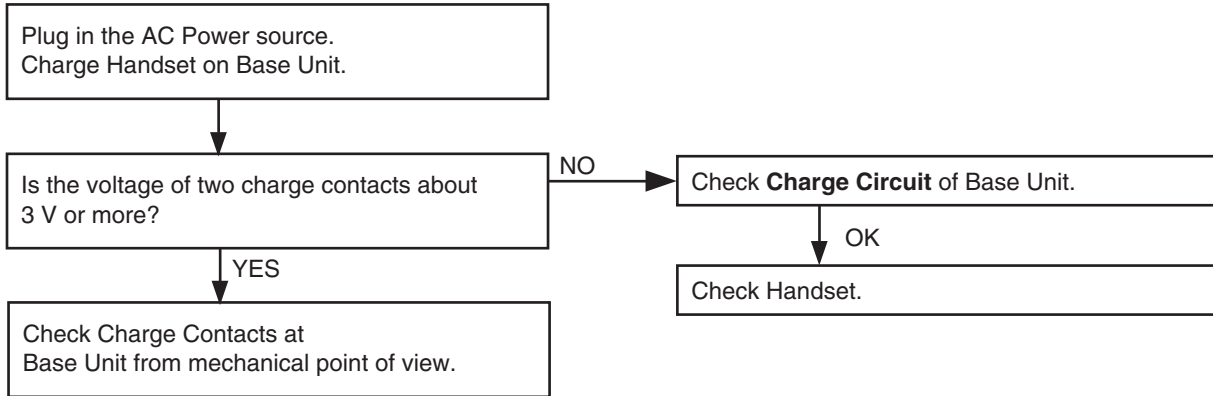
9.1.1.2. Handset



Cross Reference:
Power Supply Circuit/Reset Circuit (P.16)

9.1.2. Check Battery Charge

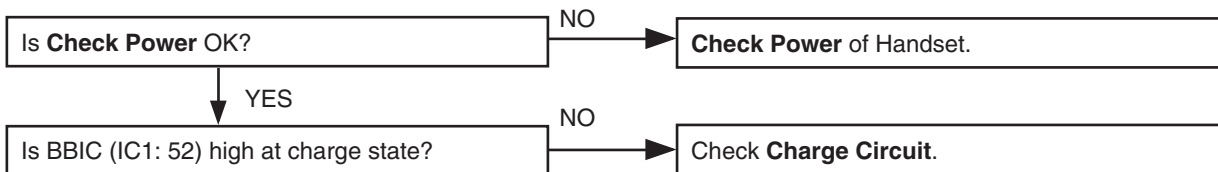
9.1.2.1. Base Unit



Cross Reference:

Charge Circuit (P.11)

9.1.2.2. Handset

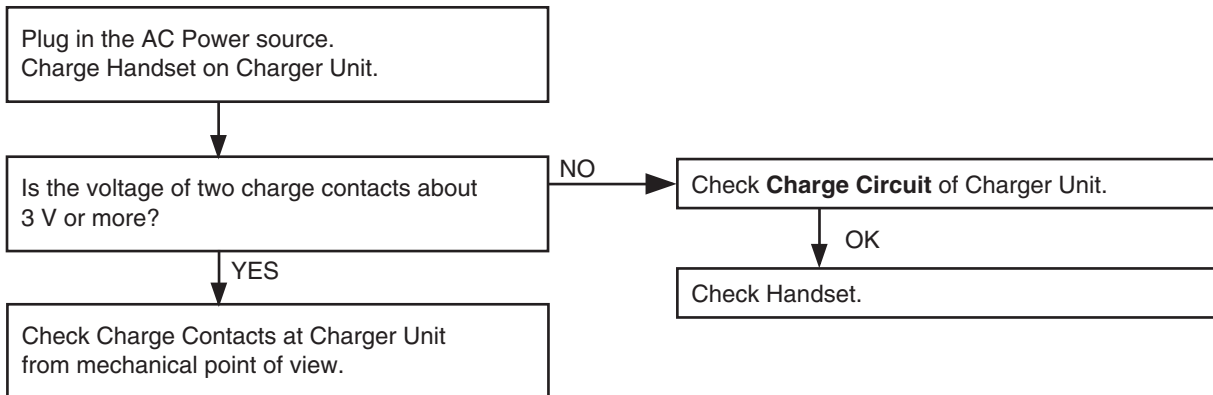


Cross Reference:

Check Power (P.29)

Charge Circuit (P.16)

9.1.2.3. Charger Unit

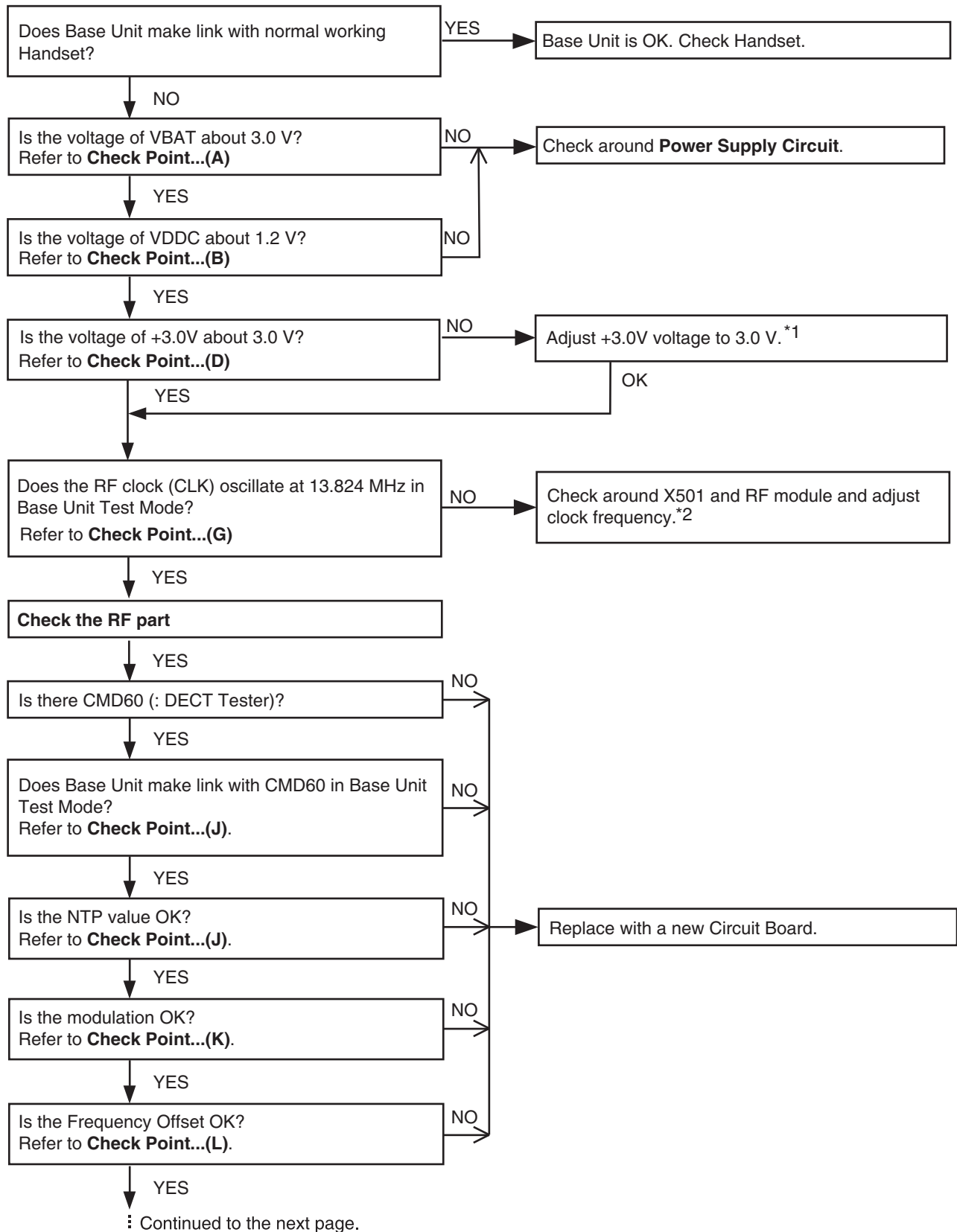


Cross Reference:

Charge Circuit (P.16)

9.1.3. Check Link

9.1.3.1. Base Unit



Cross Reference:

Power Supply Circuit/Reset Circuit (P.10)

Check the RF part (P.35)

Note:

*1 How to adjust +3.0V:

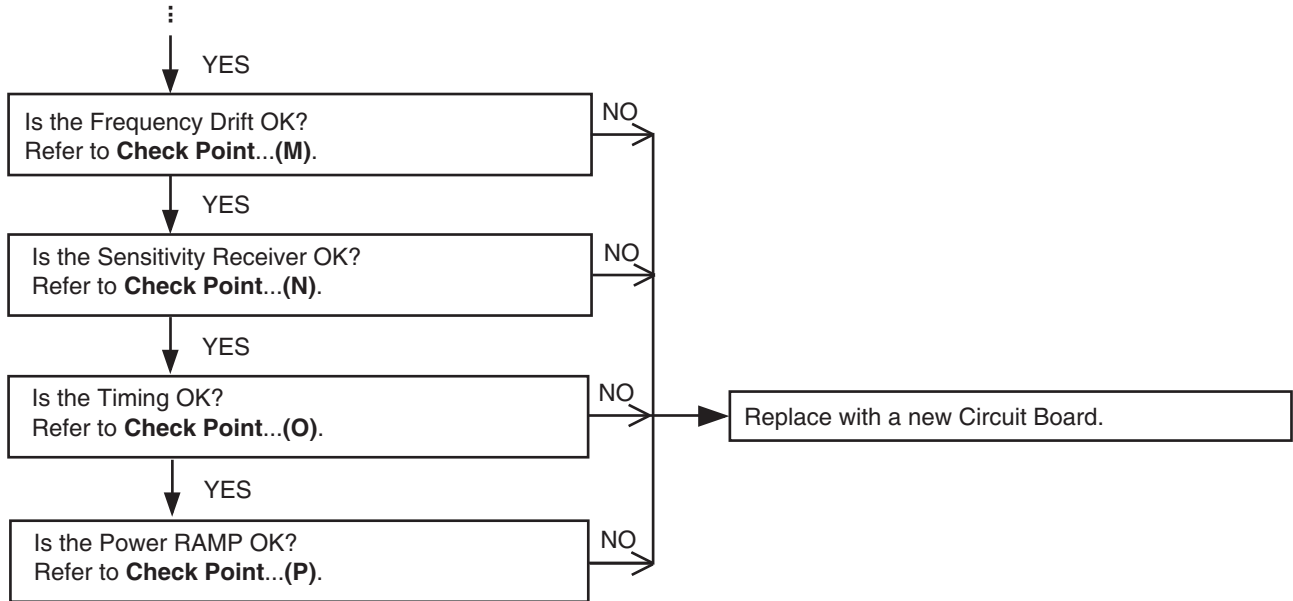
Execute the command "VDA"

Refer to Things to Do after Replacing IC or X'tal (P.xx) for Base Unit.

*2 How to adjust the frequency of X501:

To see the frequency, execute the command "SFR", then check the TP_CKM (IC501-57pin).

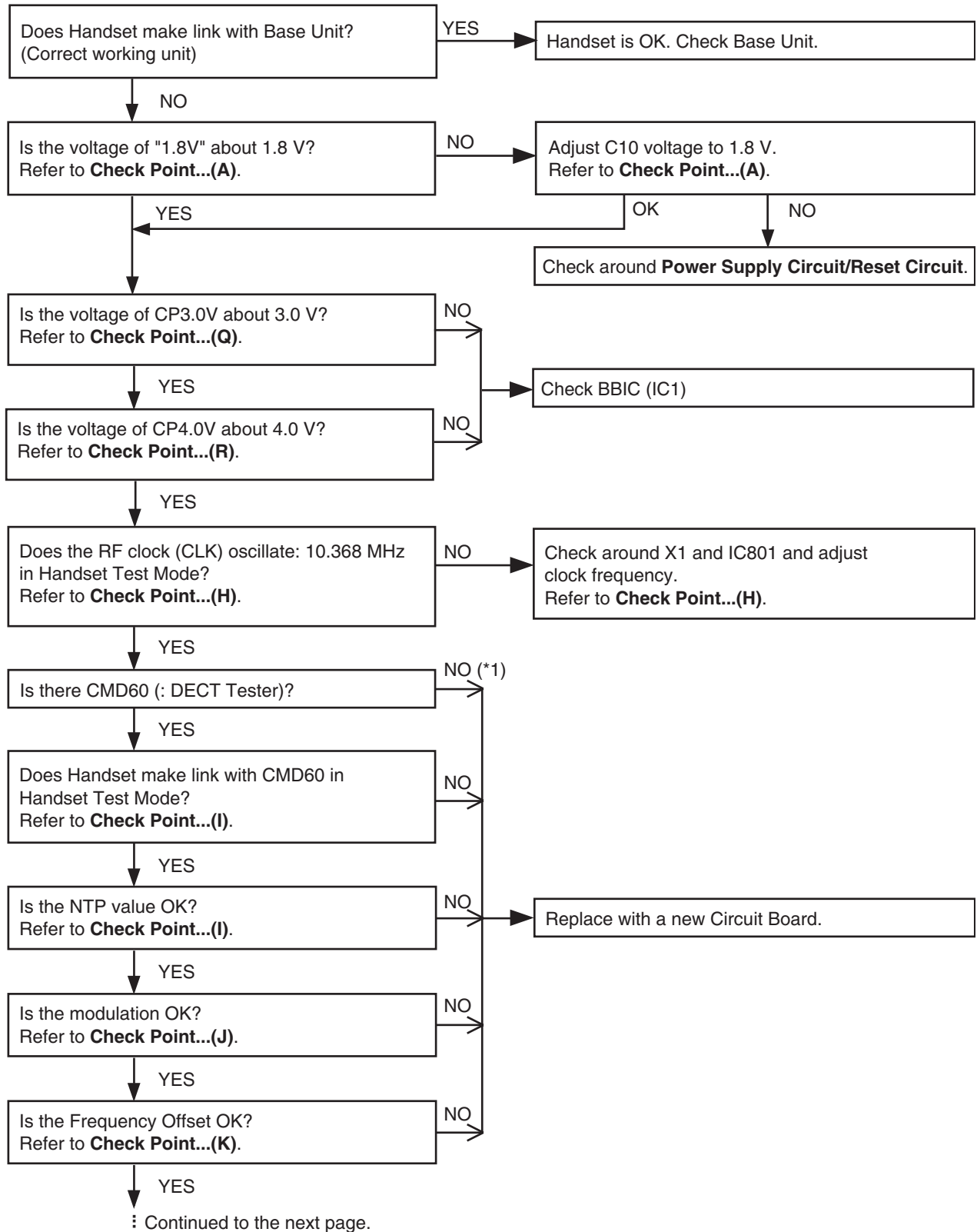
To adjust frequency, send command "SFR" until the frequency counter becomes 13.824 MHz±55Hz.



Cross Reference:

Check Point (Base Unit) (P.41)

9.1.3.2. Handset



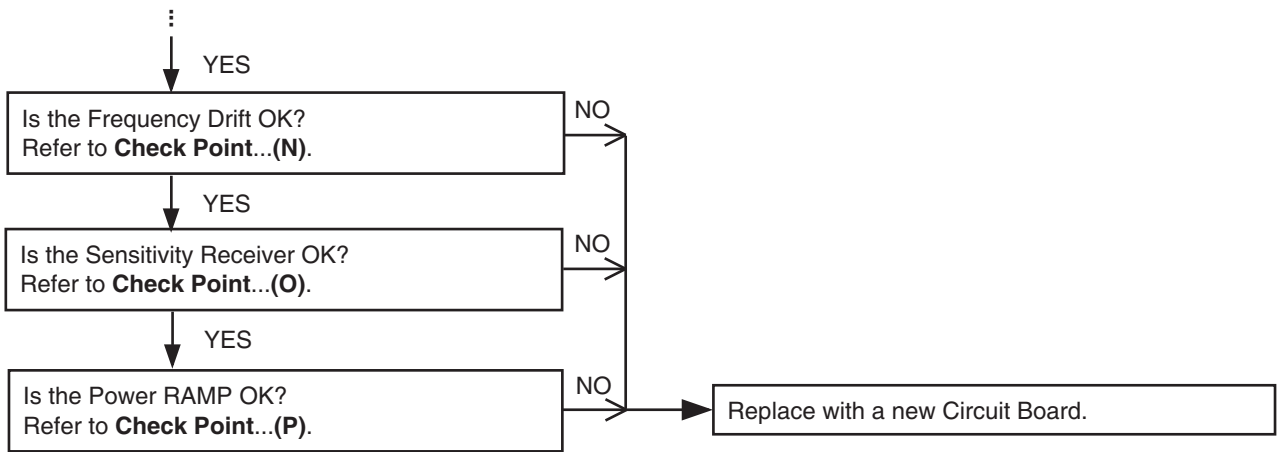
Note:

(*1) Refer to **Troubleshooting by Symptom (Handset)** (P.44)

Cross Reference:

Check Point (Handset) (P.44)

Power Supply Circuit/Reset Circuit (P.16)



Cross Reference:

Check Point (Handset) (P.44)

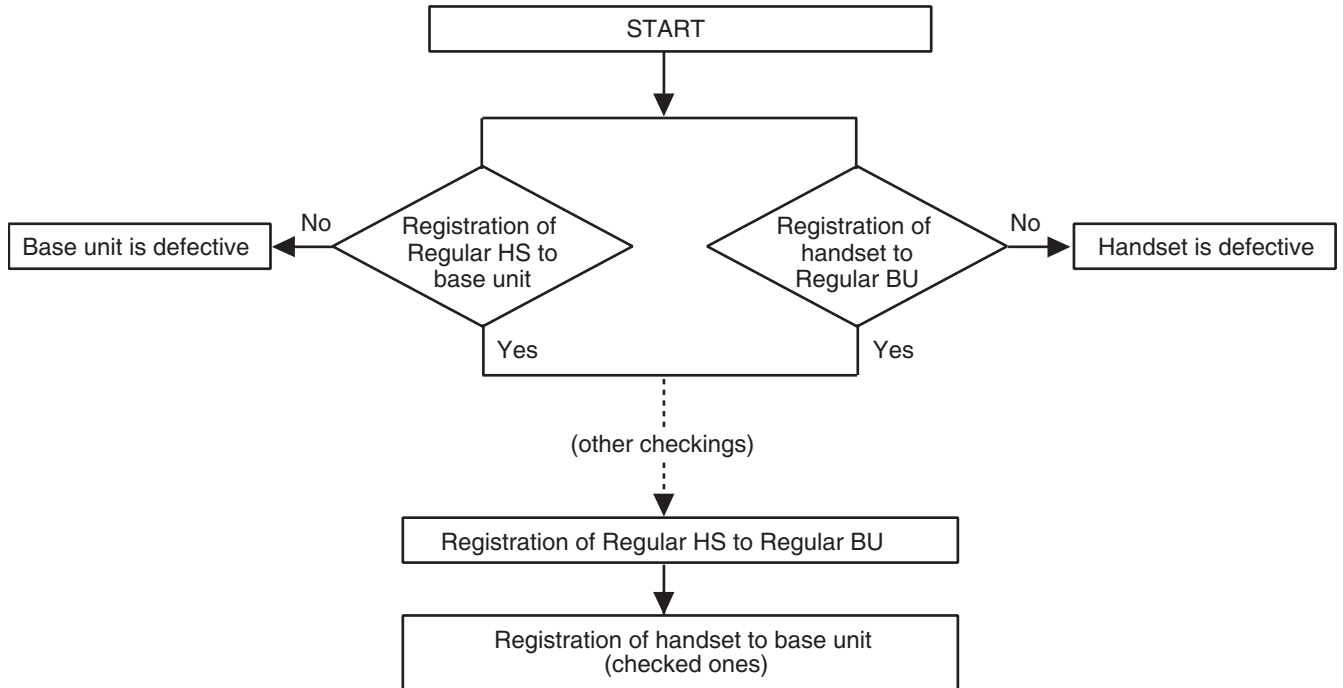
9.1.4. Check the RF part

9.1.4.1. Finding out the Defective part

1. Prepare Regular HS(*1) and Regular BU(*2).
2. a. Re-register regular HS (Normal mode) to base unit (to be checked).
If this operation fails in some ways, the base unit is defective.
- b. Re-register handset (to be checked) to regular BU (Normal mode).
If this operation fails in some ways, the handset is defective.

After All the Checkings or Repairing

1. Re-register the checked handset to the checked base unit, and Regular HS to Regular BU.



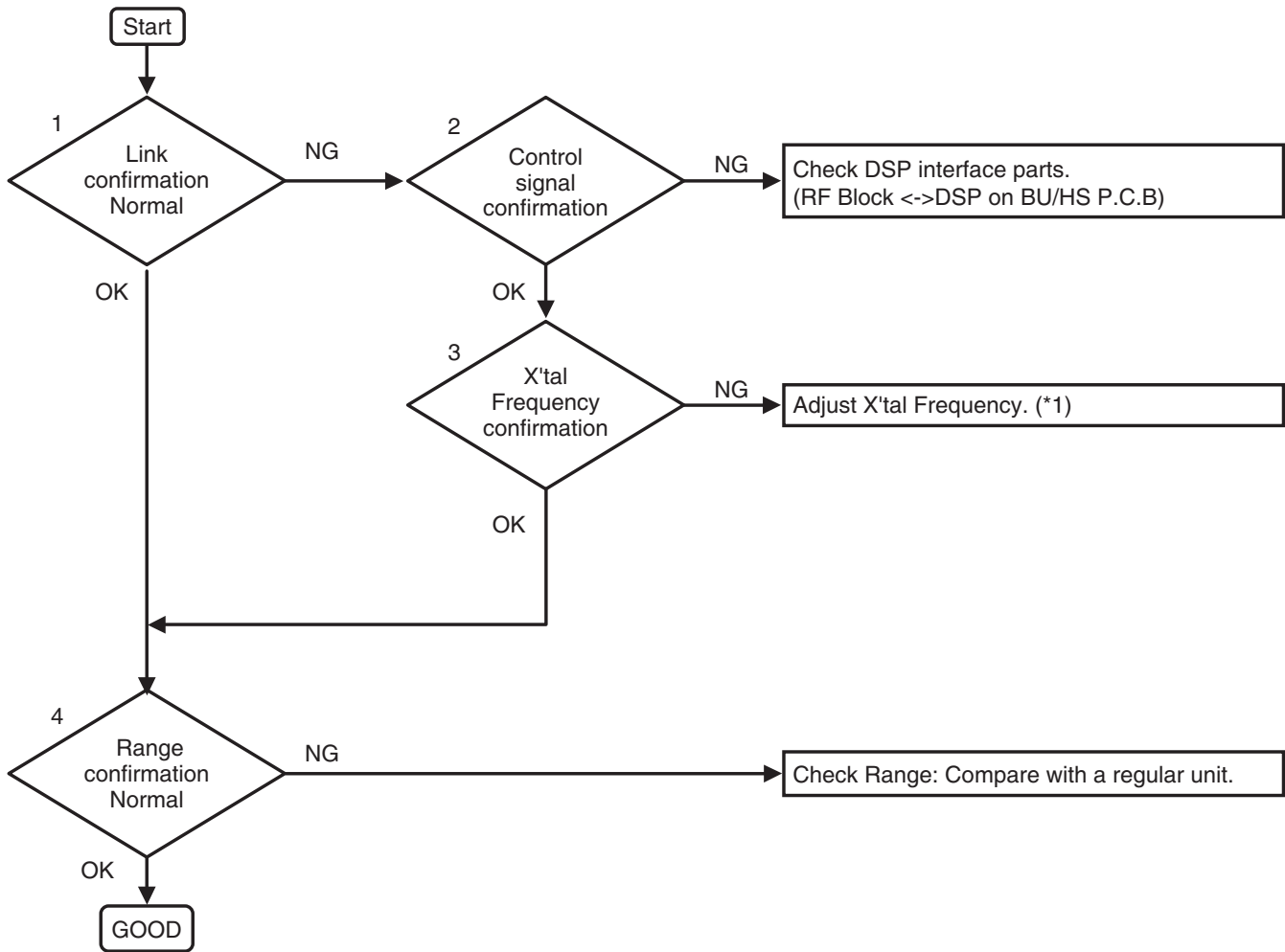
Note:

- (*1) HS: Handset
(*2) BU: Base Unit

9.1.4.2. RF Check Flowchart

Each item (1 ~ 3) of RF Check Flowchart corresponds to **Check Table for RF part** (P.37).

Please refer to the each item.



Note:

(*1) Base unit - refer to (G) of **Check Point (Base Unit)** (P.41)

Handset - refer to (H) of **Check Point (Handset)** (P.44)

9.1.4.3. Check Table for RF part


No.	Item	BU (Base Unit) Check	HS (Handset) Check
1	Link Confirmation Normal HS, BU Mode: [Normal mode]	1. Register Regular HS to BU (to be checked). 2. Press [Talk] key of the Regular HS to establish link.	1. Register HS (to be checked) to Regular BU. 2. Press [Talk] key of the HS to establish link.
2	X'tal Frequency confirmation	1. Check X'tal Frequency. (*1) (13.824 MHz \pm 100 Hz)	1. Check X'tal Frequency. (*2) (10.368 MHz \pm 100Hz)
3	Range Confirmation Normal HS, BU Mode: [Normal mode]	1. Register Regular HS to BU (to be checked). 2. Press [Talk] key of the Regular HS to establish link. 3. Compare the range of the BU (being checked) with that of the Regular BU.	1. Register HS (to be checked) to Regular BU. 2. Press [Talk] key of the HS to establish link. 3. Compare the range of the HS (being checked) with that of the Regular HS.



Note:

(*1) Refer to **Adjustment Standard (Base Unit)** (P.55)

(*2) Refer to **Adjustment Standard (Handset)** (P.59)

9.1.5. Registering a Handset to the Base Unit

The supplied handset and base unit are pre-registered. If for some reason the handset is not registered to the base unit (for example,  is displayed even when the handset is near the base unit), re-register the handset.


- 1 **Handset:**
 → **[#][1][3][0]**
- 2 **Base unit:**
Press and hold **[••]** for about 5 seconds, until the registration tone sounds.
 - If all registered handsets start ringing, press the same button to stop. Then repeat this step.
 - The next step must be completed within 90 seconds.
- 3 **Handset:**
Wait until “**Base PIN**” is displayed. → Enter the base unit PIN (default: “0000”).
→ **OK**
 - If you forget your PIN, see page 46.
 - When the handset has been registered successfully,  is displayed.

Note:

- While registering, “**Base in registering**” is displayed on all registered handsets.
- When you purchase an additional handset, refer to the additional handset’s installation manual for registration.

9.1.6. Deregistering a Handset

A handset can cancel its own registration (or the registration of another handset) that is stored to the base unit. This allows the handset to end its wireless connection with the system.

- 1  → **[#][1][3][1]**
 - All handsets registered to the base unit are displayed.
- 2 **[▼]/[▲]**: Select the handset you want to cancel. → **OK**
- 3 **[▼]/[▲]**: “**Yes**” → **OK**
 - A confirmation tone sounds.
 - The handset does not beep when cancelling its own registration.
- 4 **[✕⏻]**

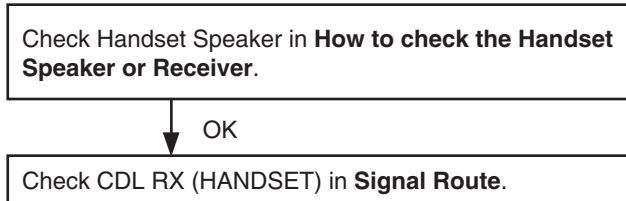
9.1.7. Check Handset Transmission



Cross Reference:

Signal Route (P.18)

9.1.8. Check Handset Reception



Cross Reference:

How to Check the Handset Speaker or Receiver (P.63).

Signal Route (P.18)

9.1.9. Check Caller ID

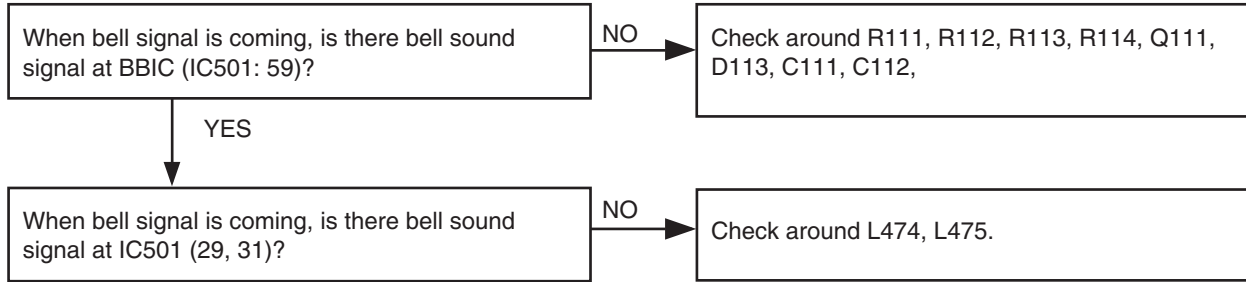


Cross Reference:

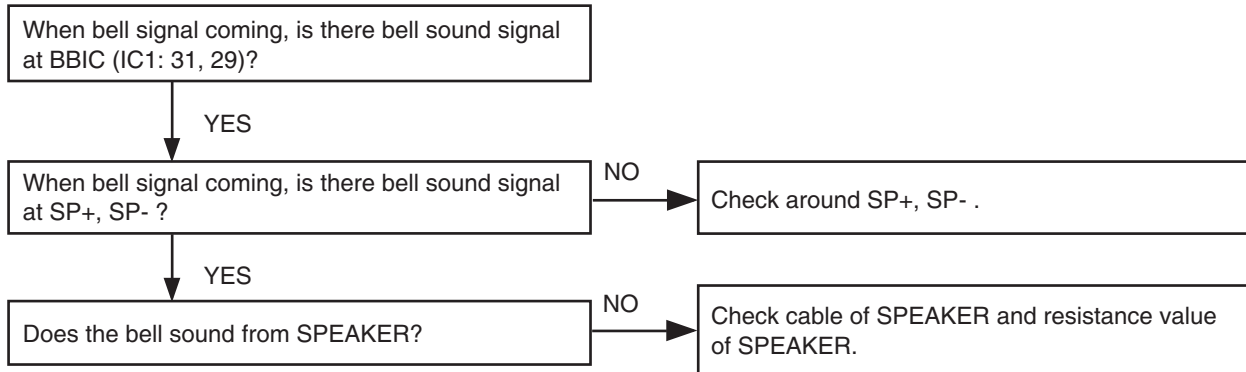
Signal Route (P.18)

9.1.10. Bell Reception

9.1.10.1. Base Unit



9.1.10.2. Handset



Cross Reference:

Telephone Line Interface (P.12)

Check Link (P.31)

How to Check the Handset Speaker or Receiver (P.63)

9.2. Troubleshooting by Symptom (Base Unit and Charger Unit)

If your unit has below symptoms, follow the instructions in remedy column. Remedies depend on whether you have DECT tester (*1) or not.

Symptom	Remedy (*2)	
	You don't have DECT Tester.	You have DECT Tester. (Model Number : CMD60)
You cannot dial.	Check item (A)-(I),(T).	Check item (A)-(I), (J)-(P),(T).
You cannot hear the caller's voice.	Check item (A)-(G),(Q),(T).	Check item (A)-(G), (J)-(P), (Q),(T).
You cannot use handset a little away from base unit even if the handset is within range of the base unit.	-	Check item (J)-(P).
The acoustic transmit level is high or low.	Check item (Q).	Check item (Q).
The acoustic reception level is high or low.	Check item (Q).	Check item (Q).
Base unit and handset do not link each other.	Check item (A)-(I).	Check item (A)-(P).

Note:

(*1) A general repair is possible even if you don't have the DECT tester because it is for confirming the levels, such as Acoustic level in detail.

(*2) Refer to **Check Point (Base Unit)** (P.41)

9.2.1. Check Point (Base Unit)

Please follow the items below when BBIC or EEPROM or FLASH is replaced.

Note:

After the measuring, suck up the solder of TP.

*: **The Setting Method of JIG (Base Unit)** (P.53) is required beforehand.

The connections of simulator equipments are as shown in **Adjustment Standard (Base Unit)** (P.55).

	Items	Check Point	Procedure	Check or Replace Parts				
(A)	3.0 V Supply Confirmation	VBAT	1. Confirm that the voltage between test point VDD3 and GND is 3.0 V ± 0.2 V.	C304, C310, C303, D301, C341, F301, Q301, L301, Q302, IC301, R301, R303, R308, R306				
(B)	1.2 V Supply Confirmation	VDDC	1. Confirm that the voltage between test point VDDC and GND is 1.2 V ± 0.1 V.	IC501				
(D)	Charge Pump 3.0V Supply Confirmation	+3.0V	1. Confirm that the voltage between test point +3.0V and GND is 3.0 V ± 0.2 V.	IC601, C504, C521				
(E)*	BBIC Confirmation	-	1. BBIC Confirmation (Execute the command "getchk"). 2. Confirm the returned checksum value. Connection of checksum value and program number is shown below. <div>ex.)<table><tr><td>checksum value</td><td>program number</td></tr><tr><td>82D2</td><td>DC01EN</td></tr></table></div>	checksum value	program number	82D2	DC01EN	IC501, X501, RA504, R505
checksum value	program number							
82D2	DC01EN							
(F)*	EEPROM Confirmation	-	1. EEP-ROM Confirmation (Execute the command "sendchar EPV"). 2. Confirm the returned Value. (Value for reference is written at "EEPROM C/ SUM" in Software_Version_Table.xls).	IC661, IC501, R612, R606, R605				
(G)*	BBIC Clock Adjustment	CLK	1. Input Command " sendchar sfr", then you can confirm the current value. 2. Check X'tal Frequency. (13.824 MHz ± 100 Hz). 3. If the frequency is not 13.824 MHz ± 100 Hz, adjust the frequency of CLK executing the command "sendchar sfr xx xx (where xx is the value)" so that the reading of the frequency counter is 13.824 MHz ± 7 Hz.	IC501, X501, C508, C509				
(H)*	Hookswitch Check with DC Characteristics	-	1. Connect Telephone Socket to Tel-simulator which is connected with 600 Ω. 2. Set line voltage to 48 V and line current to 40mA at off-hook condition of normal telephone. 3. Execute the command "hookoff" 4. Confirm that the line current is 40 mA ± 5 mA. 5. Execute the command "hookon". 6. Confirm that the line current is less than + 0.8 mA.	P101, D101, R141, R142, Q142, R144, R145, D141, R162, R165, Q161, R161, R164, R163, R167, R651, R152				

	Items	Check Point	Procedure	Check or Replace Parts
(I)	DTMF Generator Check	-	<ol style="list-style-type: none"> 1. Connect Telephone Socket to DTMF tester. (Load=600 Ω) 2. Link Handset and push dial key. 3. Confirm DTMF character. 4. Confirm that the high Group is $-3.0 \pm 2\text{dBm}$. 5. Confirm that the low Group is $-6.0 \pm 2\text{dBm}$. 	R181, C184, Q161, D141
(J)*	Transmitted Power Confirmation	- ANT 1	<p>Remove the Antenna before starting step from 1 to 7.</p> <ol style="list-style-type: none"> 1. Configure the DECT tester (CMD60) as follows; <Setting> <ul style="list-style-type: none"> • Test mode: FP • Traffic Carrier: 5 • Traffic Slot: 4 • Mode: Loopback • PMID: 00000 • PACKET: PP32Z • RF LEVEL = -70 dBm. * Do the sequence 2 to 5 is 14 second. 2. Execute the command "sendchar TST". 3. Execute the command "sendchar dmv 2 2". 4. Check that "Signalling Status" has been set to "Locked", then press "ACCEPT RFPI". 5. Initiate connection from Dect tester ("set up connect") 6. Execute the command "ANT1". 7. Confirm that the NTP value at ANT is 18.5 dBm ~ 23.5 dBm. 	IC501, C805, C806, C810, C814, C811, C813, C812, L809, C825, C895, L897, C894, R806, C859, C896, DA801, DA802, C891, R891
(K)*	Modulation Check	- ANT 1	<p>Follow steps 1 to 6 of (J).</p> <ol style="list-style-type: none"> 7. Confirm that the B-Field Modulation is $-330 \pm 30 / +330 \pm 30 \text{ kHz/div}$ & Modulated width $\geq 620 \text{ kHz}$ using data type Fig31. 	IC501, C805, C806, C810, C814, C811, C813, C812, L809, C825, C895, L897, C894, R806, C859, C896, DA801, DA802, C891, R891
(L)*	Frequency Offset Check	- ANT 1	<p>Follow steps 1 to 6 of (J).</p> <ol style="list-style-type: none"> 7. Confirm that the frequency offset is $< \pm 50 \text{ kHz}$. 	IC501, C805, C806, C810, C814, C811, C813, C812, L809, C825, C895, L897, C894, R806, C859, C896, DA801, DA802, C891, R891, X501, C508, C509
(M)*	Frequency Drift Confirmation	- ANT 1	<p>Follow steps 1 to 6 of (J).</p> <ol style="list-style-type: none"> 7. Confirm that the frequency drift is $< \pm 35 \text{ kHz/ms}$. 	IC501, C805, C806, C810, C814, C811, C813, C812, L809, C825, C895, L897, C894, R806, C859, C896, DA801, DA802, C891, R891
(N)*	Sensitivity Receiver Confirmation	- ANT 1	<p>Follow steps 1 to 6 of (J).</p> <ol style="list-style-type: none"> 7. Set DECT tester power to -90 dBm. 8. Confirm that the BER is $< 1000 \text{ ppm}$. 	IC501, C805, C806, C810, C814, C811, C813, C812, L809, C825, C895, L897, C894, R806, C859, C896, DA801, DA802, C891, R891, C820, C863, C826, C822, C827, R807, R892, C852

	Items	Check Point	Procedure	Check or Replace Parts
(O)*	Timing Confirmation	- ANT 1	Follow steps 1 to 6 of (J). 7. Confirm that the Timing accuracy is • ± 5.0 ppm (When adjust the frequency of CLK in item (G)). • ± 15 ppm (When do not adjust the frequency of CLK in item (G)).	IC501, C805, C806, C810, C814, C811, C813, C812, L809, C825, C895, L897, C894, R806, C859, C896, DA801, DA802, C891, R891, X501
(P)*	Power RAMP Confirmation	-	Follow steps 1 to 6 of (J). 7. Confirm that Power RAMP is matching.	IC501, C805, C806, C810, C814, C811, C813, C812, L809, C825, C895, L897, C894, R806, C859, C896, DA801, DA802, C891, R891
(Q)	Audio Check	-	1. Link with Handset which is connected to Line Simulator. 2. Set line voltage to 48V and line current to 50mA. 3. Input -45dBm(600 Ω)/1kHz to MIC of Handset. Measure the Level at Line I/F and distortion level. 4. Confirm that the level is -1dBm ± 2 dBm and that the distortion level is <5% at TEL Line (600 Ω Load). 5. Input -20dBm(600 Ω)/1kHz to Line I/F. Measure the Level at Receiver of Handset and distortion level (Receive volume set to second position from minimum). 6. Confirm that the level is -25dBm ± 2 dBm and that the distortion level is <5% at Receiver (110 Ω Load).	P101, D101, R141, R142, Q142, R144, R145, D141, R162, R165, Q161, R161, R164, R163, R167, R651, R152, IC501, C805, C806, C810, C814, C811, C813, C812, L809, C825, C895, L897, C894, R806, C859, C896, DA801, DA802, C891, R891, C173, Q171, C178, R178, IC501
(R)	Charging Check	-	1. Connect Charge Contact 12 Ω /2 W resistor between charge+ and charge-. 2. Measure and confirm voltage across the resistor is 3.3 V \pm 0.3 V.	R55, R56, D22, D23, D24, C623, C624
(S)	2.4V Supply Confirmation VDD2	VDD2	1. Confirm that the voltage between test point VDD2 and GND is 2.5V \pm 0.2V.	IC7, Q9, C617

9.2.2. Check Point (Charger Unit)

	Items	Check Point	Procedure	Check or Replace Parts
(A)	Charging Check	-	1. Connect Charge Contact 12 Ω /2 W resistor between charge+ and charge-. 2. Measure and confirm voltage across the resistor is 3.1 V \pm 0.3 V.	R1, F1

Note:

After the measuring, suck up the solder of TP.

The connection of adjustment equipment is as shown in **Adjustment Standard (Charger Unit)** (P.56).

9.3. Troubleshooting by Symptom (Handset)

If your unit has below symptoms, follow the instructions in remedy column. Remedies depend on whether you have DECT tester (*1) or not.

Symptom	Remedy (*2)	
	You don't have DECT Tester.	You have DECT Tester. (Model Number : CMD60)
Battery strength is not indicated correctly by Battery icon.	Check item (A)-(D), (E)-(G).	Check item (A)-(D), (E)-(G).
You cannot hear the caller's voice.	Check item (A)-(C), (H),(O).	Check item (A)-(C), (H-(M))-(O)
You cannot use handset a little away from base unit even if the handset is within range of the base unit.	-	Check item (I)-(N).
Does not link between base unit and handset.	Check item (A)-(C), (H).	Check item (A)-(C), (I)-(N).
The Audio level is high or low.	Check item (O).	Check item (O).
The SP-Phone level is high or low.	Check item (P).	Check item (P).

Note:

(*1) A general repair is possible even if you don't have the DECT tester because it is for confirming the levels, such as Acoustic level in detail.

(*2) Refer to **Check Point (Handset)** (P.44)

9.3.1. Check Point (Handset)

Please follow the items below when BBIC or EEPROM is replaced.

Note:

After the measuring, suck up the solder of TP.

*: **Connections** (P.57) is required beforehand.

The connections of adjustment equipments are as shown in **Adjustment Standard (Handset)** (P.59).

	Items	Check Point	Procedure	Check or Replace Parts				
(A)*	1.8 V Supply Adjustment	VDD1	1. Confirm that the voltage between test point VDD1 and GND is 1.8 V ± 0.02 V. 2. Execute the command "VDD", then check the current value. 3. Adjust the 1.8V voltage of VDD1 executing command "VDD XX"(XX is the value).	IC1, Q2, C48, D1, C1, C44, R45, C40, C45, F1				
(B)*	BBIC Confirmation	-	1. BBIC Confirmation (Execute the command "getchk"). 2. Confirm the returned checksum value. Connection of checksum value and program number is shown below. <div style="text-align: center;"><div>ex.)</div><table><tr><td>checksum value</td><td>program number</td></tr><tr><td>E74A</td><td>DBS2RN</td></tr></table></div>	checksum value	program number	E74A	DBS2RN	IC1, X1, RA61, R64, R66
checksum value	program number							
E74A	DBS2RN							
(C)*	EEP-ROM Confirmation	-	1. EEP-ROM Confirmation (Execute the command "sendchar EPV"). 2. Confirm the returned Value. (Value for reference is written at "EEPROM C/ SUM" in Software_Version_Table.xls).	IC1, IC3, RA40, C172				
(D)	Charge Control Check & Charge Current Monitor Check	-	1. Apply 3.5 V between CHG(+) and CHG(-) with DC power supply and set current limit to 250 mA. Confirm the indication of "charging" on LCD. 2. Confirm that the current limit LED of DC power supply is ON/OFF. Confirm it after waiting over 1 minute at least. 3. Decrease current limit of DC power supply to 100 mA. 4. Confirm that the current limit LED of DC power supply is stable. (Current limiter is ON.) (If charge control cannot be confirmed by this procedure, please use battery to handset power supply and try again.)	IC1, Q4 Q9, D7, R6, R7, F1, C1, R2, R30, R31, R8, R45				
(E)*	Charge Detection (OFF) Check	-	1. Stop supplying 3.5 V to CHG (+) and CHG (-). 2. Confirm the indication of "charging" has been cleared.	IC1, Q4 Q9, D7, R6, R7, F1, C1, R2, R30, R31, R8, R45				

	Items	Check Point	Procedure	Check or Replace Parts
(F)*	Battery Monitor Check	-	<ol style="list-style-type: none"> 1. Apply 2.25 V between BATT+ and BATT-. 2. Execute the command sendchar PAD sendchar LED 0 sendchar CRX 0 1 sendchar AD1 It assumes that the return value is XX. a) $6c \leq XX \leq 71$: No need to adjust b) $XX: 6A \sim 6B$: Need to adjust $XX: 72 \sim 74$: Need to adjust Write AD value of 2.25 V to EEPROM. ex) read data: $XX = 6A$, write data: $YY = 6A$ read data: $XX = 73$, write data: $YY = 73$ EEPROM = 0009(Low Voltage) write "YY" Execute the command "wreeprom 00 09 01 YY". EEPROM = 000A(No Voltage) write "YY - 1D" Execute the command "xwreeprom 00 0A 01 ZZ". Note: ZZ = YY - 1D No Voltage writing data limit is '00'. c) $XX: 00 \sim 69$: Reject $XX: 75 \sim FF$: Reject 	IC1, F1, C1, R45
(G)	Battery Low Confirmation	-	<ol style="list-style-type: none"> 1. Apply 2.40 V between BATT+ and BATT-. 2. Confirm that there is no flashing of Battery Icon. 3. Apply $2.25 \text{ V} \pm 0.08 \text{ V}$ between BATT+ and BATT-. 4. Confirm that there is flashing of Battery Icon. 	IC1, F1, C1, R45
(H)*	BBIC Clock Adjustment	CLK	<ol style="list-style-type: none"> 1. Apply 2.6 V between BATT+ and BATT- with DC power. 2. Input Command "sendchar sfr", then you can confirm the current value. 3. Check X'tal Frequency. ($10.368 \text{ MHz} \pm 100 \text{ Hz}$). 4. If the frequency is not $10.368 \text{ MHz} \pm 100 \text{ Hz}$, adjust the frequency of CLK executing the command "sendchar sfr xx xx (where xx is the value)" so that the reading of the frequency counter is $10.368000 \text{ MHz} \pm 5 \text{ Hz}$. <p>Note: Clear the registered information for Base Unit before measurement, because the Frequency will not possibly get stable due to the registered information. Pressing the button of "3" "7" "9" "#" clears the registration. Register to it on Base Unit after measurement.</p>	IC1, X1, C47
(I)*	Transmitted Power Confirmation	-	<p>Remove the Antenna before starting step from 1 to 4.</p> <ol style="list-style-type: none"> 1. Configure the DECT tester (CMD60) as follows; <Setting> • Test mode: PP • RFPI: 0102030405 • Traffic Carrier: 5 • Traffic Slot: 4 • Mode: Loopback • RF LEVEL = -70 dBm • PACKET: PP32Z 2. Execute the command "sendchar TST 01 02 03 04 05". 3. Initiate connection from DECT tester. 4. Confirm that the NTP value at ANT is 19 dBm ~ 25 dBm. 	IC1, C802~C806, C808~C814, C819~C820, C822, C825~C827, C834, C860~C864, L801~L804, DA801, R801~R808
(J)*	Modulation Check	-	<p>Follow steps 1 to 3 of (K).</p> <ol style="list-style-type: none"> 4. Confirm that the B-Field Modulation is $-370 \pm 30 / +370 \pm 30 \text{ kHz/div}$ & Modulated width $\geq 690 \text{ kHz}$ using data type Fig 31. 	IC1, C802~C806, C808~C814, C819~C820, C822, C825~C827, C834, C860~C864, L801~L804, DA801, R801~R808

	Items	Check Point	Procedure	Check or Replace Parts
(K)*	Frequency Offset Confirmation	-	Follow steps 1 to 3 of (I). 4. Confirm that the frequency Offset is $< \pm 50$ kHz.	IC1, C802~C806, C808~C814, C819~C820, C822, C825~C827, C834, C860~C864, L801~L804, DA801, R801~R808
(L)*	Frequency Drift Confirmation	-	Follow steps 1 to 3 of (I). 4. Confirm that the frequency Drift is $< \pm 35$ kHz/ms.	IC1, C802~C806, C808~C814, C819~C820, C822, C825~C827, C834, C860~C864, L801~L804, DA801, R801~R808
(M)*	Sensitivity Receiver Confirmation	-	Follow steps 1 to 3 of (I). 4. Set DECT tester power to -88 dBm. 5. Confirm that the BER is < 1000 ppm.	IC1, C802~C806, C808~C814, C819~C820, C822, C825~C827, C834, C860~C864, L801~L804, DA801, R801~R808
(N)*	Power RAMP Confirmation	-	Follow steps 1 to 3 of (I). 4. Confirm that Power RAMP is matching.	IC1, C802~C806, C808~C814, C819~C820, C822, C825~C827, C834, C860~C864, L801~L804, DA801, R801~R808
(O)	Audio Check and Confirmation	-	1. Link to BASE which is connected to Line Simulator. 2. Set line voltage to 48V and line current to 50mA. 3. Input -45dBm(600Ω)/1kHz to MIC of Handset. Measure the Level at Line I/F and distortion level. 4. Confirm that the level is -1.0dBm \pm 2 dBm and that the distortion level is $< 5\%$ at TEL Line (600Ω Load). 5. Input -20dBm(600Ω)/1kHz to Line I/F. Measure the Level at Receiver of Handset and distortion level (Receive volume set to second position from minimum). 6. Confirm that the level is -25dBm \pm 2 dBm and that the distortion level is $< 5\%$ at Receiver (110Ω Load).	IC1, C12, C96, C97, R215, R27, RA4, C11, C13, R28, D3, D4, MIC, R73, R74
(P)	SP phone Audio Check and Confirmation	-	1. Link to Base which is connected to Line Simulator. 2. Set line voltage to 48V and line current to 50mA. 3. Set the handset off-hook using SP-Phone key. 4. Input -25 dBm(600Ω)/1kHz to Line I/F and measure Receiving level at SP+ and SP-. 5. Confirm that the level is -9.5 dBm \pm 2 dBm and that the distortion level is $< 5\%$. (vol = 3)	IC1, C12, C73, D13, D14, R73, R74, MIC, C11, C13, RA4, R27, R28, C96, C97, R215, C72
(Q)	Charge Pump 3.0V Supply Confirmation	CP3.0V	1. Confirm that the voltage between testpoint CP3.0V and GND is 3.0 \pm 0.3V.	C49, C52~C54
(R)	Charge Pump 4.0V Supply Confirmation	CP4.0V	1. Confirm that the voltage between testpoint CP4.0V and GND is 4.0V \pm 0.3V.	C50, C51, C55

9.3.2. Troubleshooting for Speakerphone

When the customer's telephone line corresponds to the following conditions, and the transmission signal of SP-Phone is interrupted, performing the next set up to a cordless handset will improve it to some extent.

Conditions

1. When customer's line has less line loss.
ex.) The customer is using optical fiber, ISDN terminal adaptor, or PBX.
In this case, receiving signal is strong and it may affect transmission signal.
2. When the other party is talking from noisy place.
ex.) The other party is using cellular phone. The background noise is very loud.
In this case, the noise from the other party (i.e. surrounding noise) may affect transmission signal.

Setting Method

- Change the handset address of EEPROM (0129) from 00 to 01 by **Engineering Mode**.

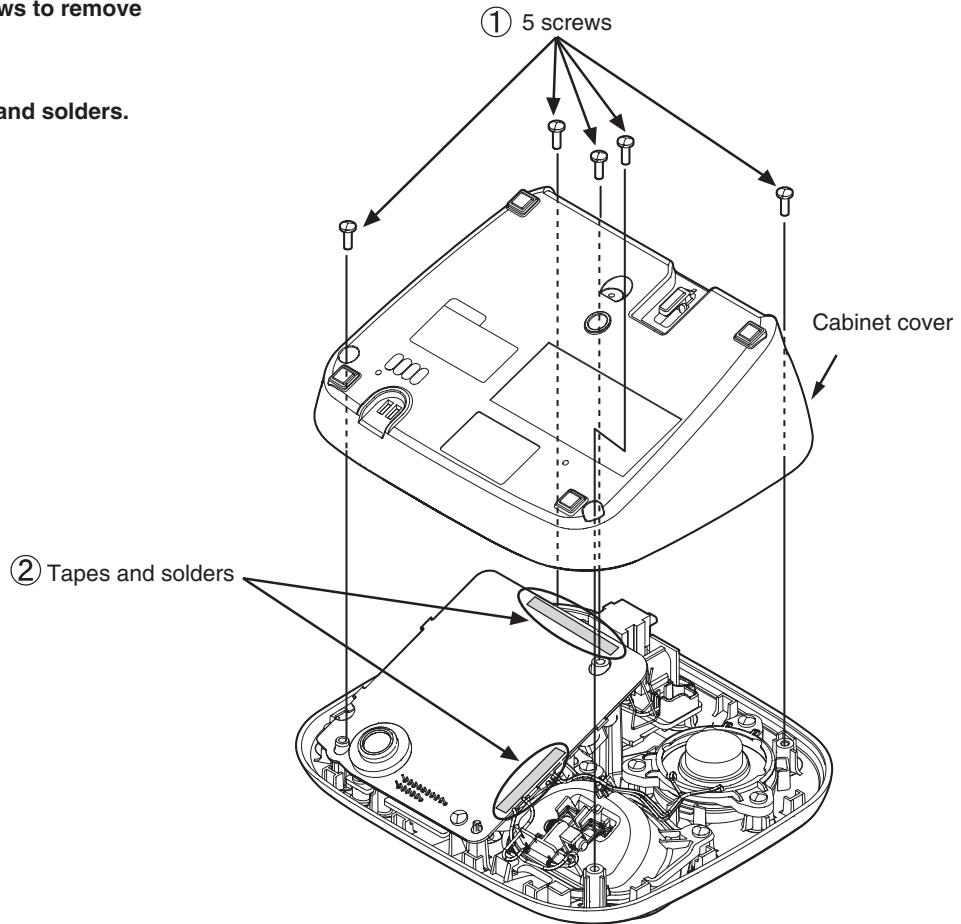
10 Disassembly and Assembly Instructions

10.1. Disassembly Instructions

10.1.1. Base Unit

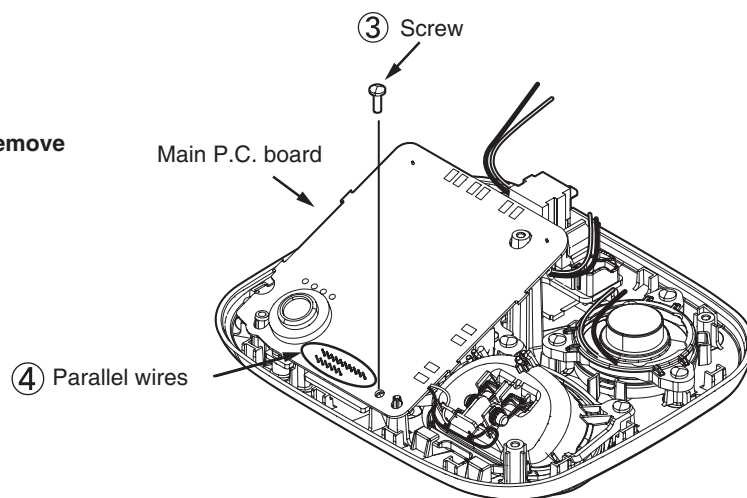
- ① Remove the 5 screws to remove the cabinet cover.

- ② Remove the tapes and solders.

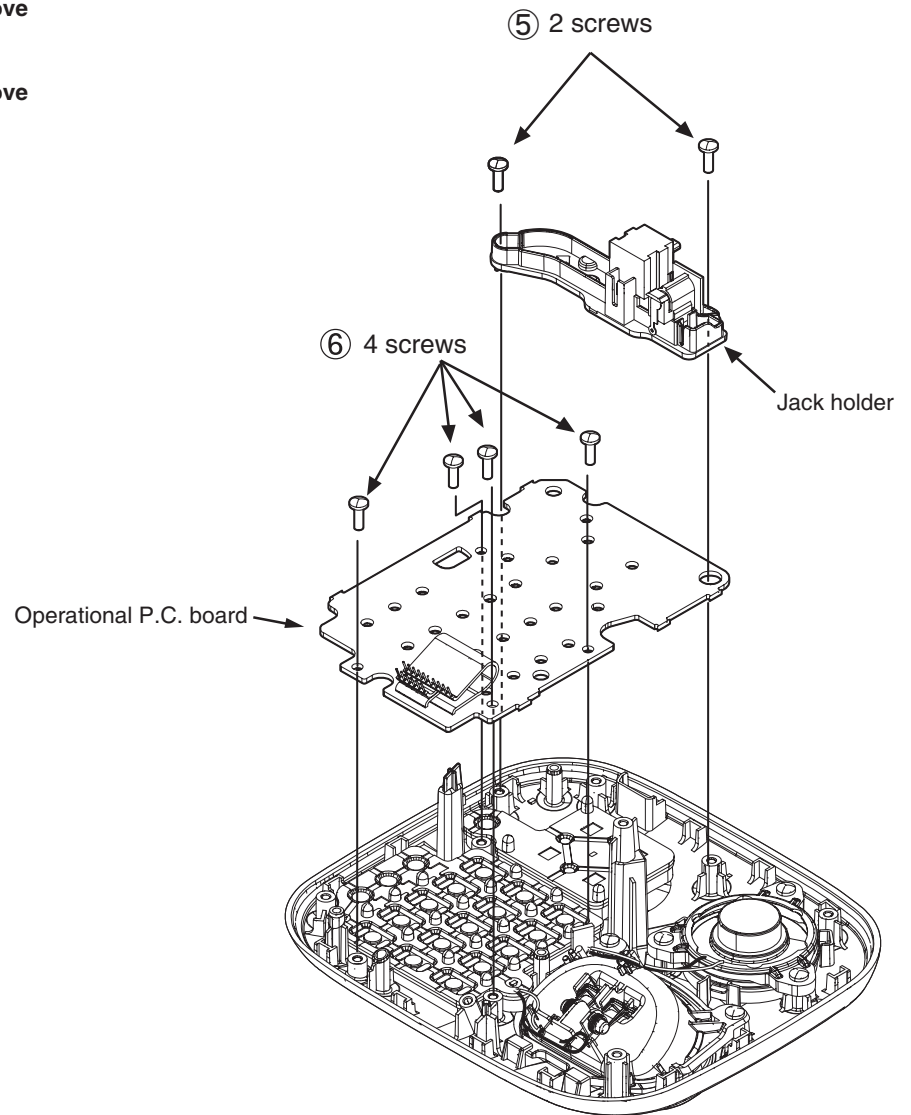


- ③ Remove the screw .

- ④ Remove the parallel wires to remove the main P.C. board.

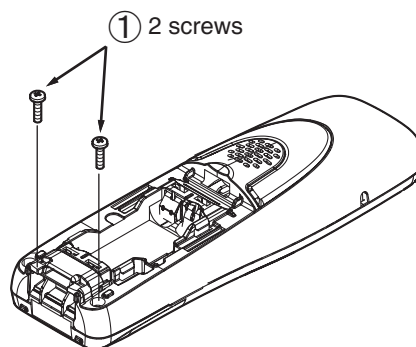


- ⑤ Remove the 2 screws to remove the jack holder.
- ⑥ Remove the 4 screws to remove the operational P.C. board.

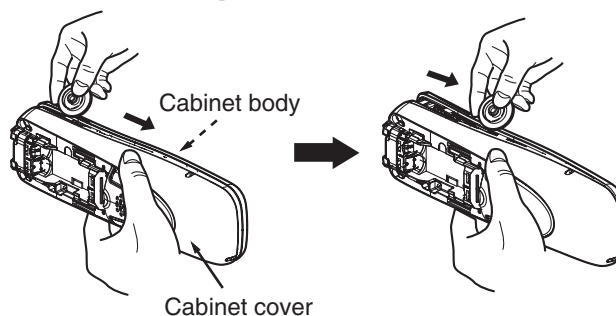


10.1.2. Handset

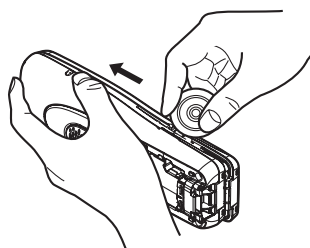
- ① Remove the 2 screws.



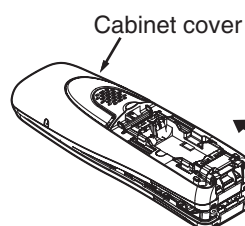
- ② Insert a JIG (PQDJ10006Y) between the cabinet body and the cabinet cover, then pull it along the gap to open the cabinet.



- ③ Likewise, open the other side of the cabinet.



- ④ Remove the cabinet cover by pushing it upward.



- ⑤ Remove the solders and tape.

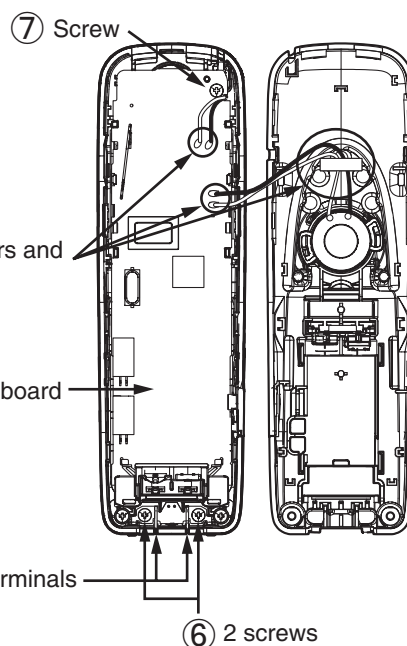
- ⑤ Solders and Tape

- ⑥ Remove the 2 screws to remove the 2 charge terminals.

Main P.C. board

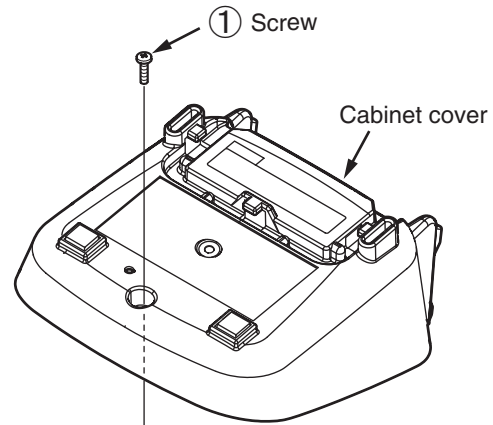
- ⑥ 2 charge terminals

- ⑥ 2 screws

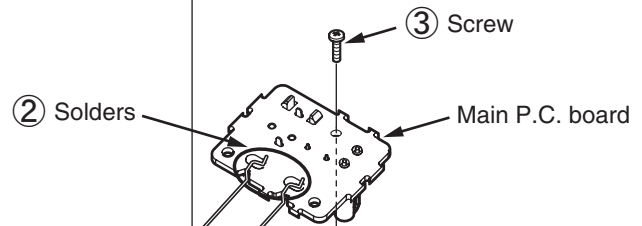


10.1.3. Charger Unit

- ① Remove the screw to remove the cabinet cover.

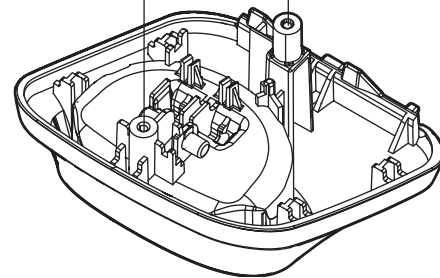


- ② Remove the solders to remove the 2 charge terminals.



- ③ Remove the screw to remove the main P.C. board.

2 charge terminals

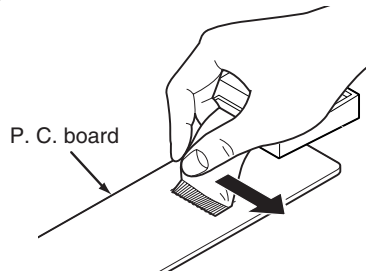


10.2. How to Replace the Handset LCD

Note:

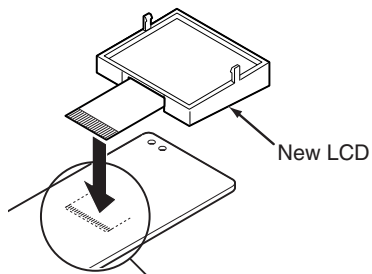
The illustrations are simplified in this page.
They may differ from the actual product.

①

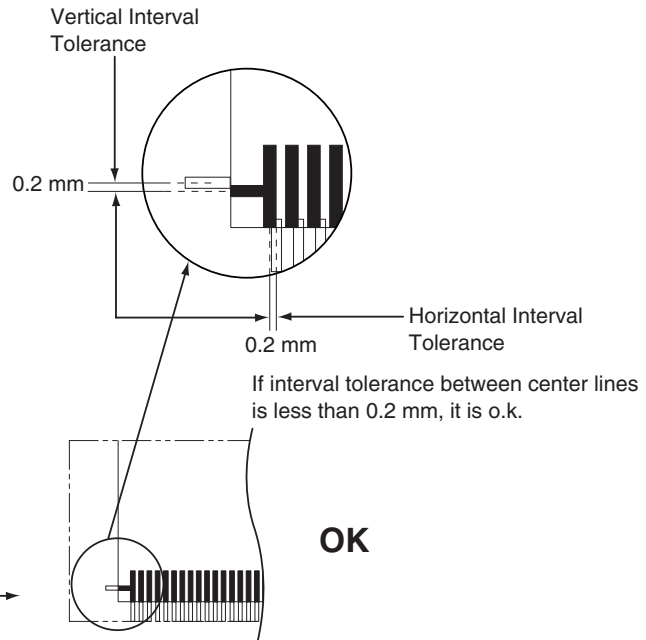


Peel off the FFC (Flexible Flat Cable) from the LCD, in the direction of the arrow. Take care to ensure that the foil on the P.C. board is not damaged.

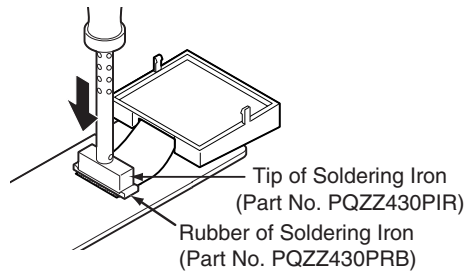
②



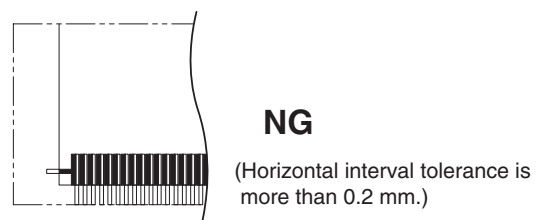
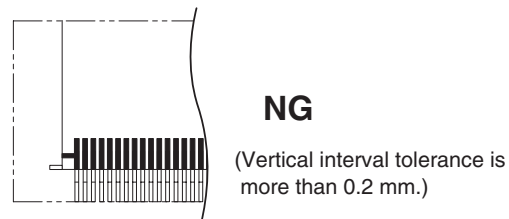
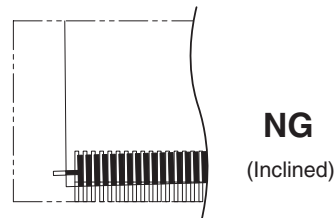
Fit the heatseal of a new LCD.



③



Heatweld with the tip of the soldering iron about 5 to 8 seconds (in case of 60W soldering iron).



11 Measurements and Adjustments

This chapter explains the measuring equipment, the JIG connection, and the PC setting method necessary for the measurement in **Troubleshooting Guide** (P.28)

11.1. Equipment Required

- Digital multi-meter (DMM): it must be able to measure voltage and current.
- Oscilloscope.
- Frequency counter: It must be precise enough to measure intervals of 1 Hz (precision; ± 4 ppm)
Hewlett Packard, 53131A is recommended.
- DECT tester: Rohde & Schwarz, CMD 60 is recommended.

This equipment may be useful in order to precisely adjust like a mass production.

11.2. The Setting Method of JIG (Base Unit)

This section explains the PC setting to use command required in **Check Point (Base Unit)**(P.41).

<Preparation>

- Serial JIG cable: PQZZ1CD300E*
- PC which runs in DOS mode
- **Batch file CD-ROM** for setting: PNZZTG6551CA

(PQZZ1CD505E), change the following values of resistance. Then you can use it as a JIG Cable for both TCD300 and TCD500 series. (It is an upper compatible JIG Cable.)

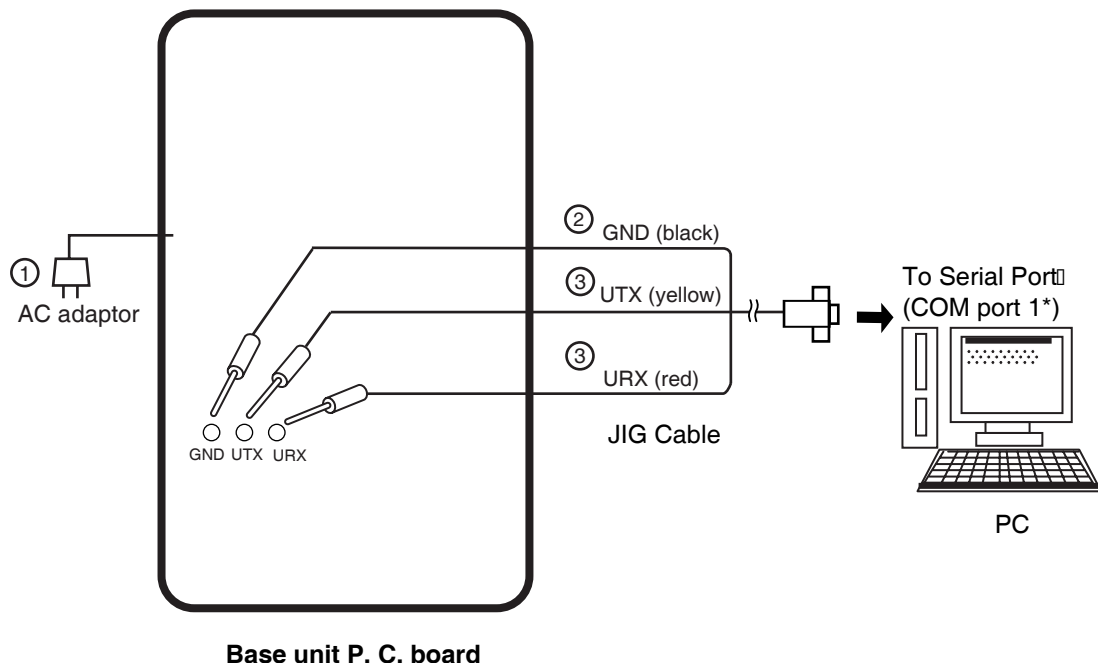
Resistor	Old value (k Ω)	New value (k Ω)
R2	22	3.3
R3	22	3.3
R4	22	4.7
R7	4.7	10

Note:

*: If you have the JIG Cable for TCD500 series

11.2.1. Connections

- ① Connect the AC adaptor to DC-JACK (base unit).
- ② Connect the JIG Cable GND (black) to GND.
- ③ Connect the JIG Cable RX (red) to URX and TX (yellow) to UTX.



Note:

*: COM port names may vary depending on what your PC calls it.

11.2.2. How to install Batch file into P.C.

1. Insert the Batch file CD-ROM into CD-ROM drive and copy PNZZTG**** folder to your PC (example: D drive).

2. Open an MS-DOS mode window.

<Example for Windows>

On your computer, click **[Start]**, select **Programs** (**All Programs** for Windows XP/Windows Server 2003), then click

MS-DOS Prompt. (for Windows 95/Windows 98)

Or

Accessories-MS-DOS Prompt. (for Windows Me)

Or

Command Prompt. (for Windows NT 4.0)

Or

Accessories-Command Prompt.

(for Windows 2000/Windows XP/Windows Server 2003)

3. At the DOS prompt, type "**D:**" (for example) to select the drive, then press the **Enter** key.

4. Type "**CD ¥PNZZTG******", then press the **Enter** key.

5. Type "**SET_COM=X**", then press the **Enter** key
(**X**: COM port number used for the serial connection on your PC).

6. Type "**READID**", then press the **Enter** key.
• If any error messages appear, change the port number or check the cable connection.
• If any value appear, go to next step.

7. Type "**DOSKEY**", then press the **Enter** key.

<Example>

```
C: ¥Documents and Settings>D:
D: ¥>CD ¥PNZZTG****
D: ¥PNZZTG**** >SET_COM=X
D: ¥PNZZTG****>READID
00 52 4F A8 A8
D: ¥PNZZTG****>DOSKEY
D: ¥PNZZTG****>_
```

<Example: error happens>

```
C: ¥Documents and Settings>D:
D: ¥>CD ¥PNZZTG****
D: ¥PNZZTG**** >SET_COM=X
D: ¥PNZZTG****>READID
CreateFile error
ERROR 10: Can't open serial port
D: ¥PNZZTG ****>_
```

Note:

- "****" varies depending on the country or models.

11.2.3. Commands

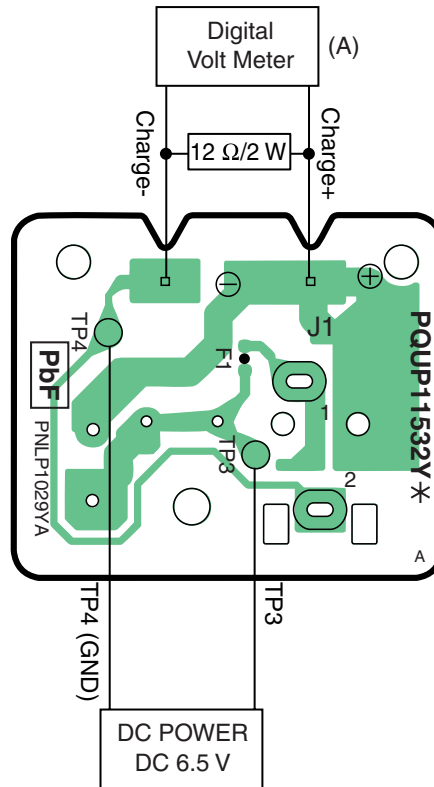
See the table below for frequently used commands.

Command name	Function	Example
rdeeprom	Read the data of EEPROM	Type "rdeeprom 00 00 FF", and the data from address "00 00" to "FF" is read out.
readid	Read ID (RFPI)	Type "readid", and the registered ID is read out.
writeid	Write ID (RFPI)	Type "writeid 00 18 E0 0E 98", and the ID "0018 E0 0E 98" is written.
hookoff	Off-hook mode on Base	Type "hookoff".
hookon	On-hook mode on Base	Type "hookon".
getchk	Read checksum	Type "getchk".
wreeprom	Write the data of EEPROM	Type "wreeprom 01 23 45". "01 23" is address and "45" is data to be written.

11.4. Adjustment Standard (Charger Unit)

When connecting the simulator equipment for checking, please refer to below.

11.4.1. Bottom View



Note:

(A) is referred to **Check Point (Charger Unit) (P.43)**

11.5. The Setting Method of JIG (Handset)

This section explains the PC setting to use command required in **Check Point (Handset)**(P.44).

<Preparation>

- Serial JIG cable: PQZZ1CD300E*
- PC which runs in DOS mode
- **Batch file CD-ROM** for setting: PNZZTG6551CA

(PQZZ1CD505E), change the following values of resistance. Then you can use it as a JIG Cable for both TCD300 and TCD500 series. (It is an upper compatible JIG Cable.)

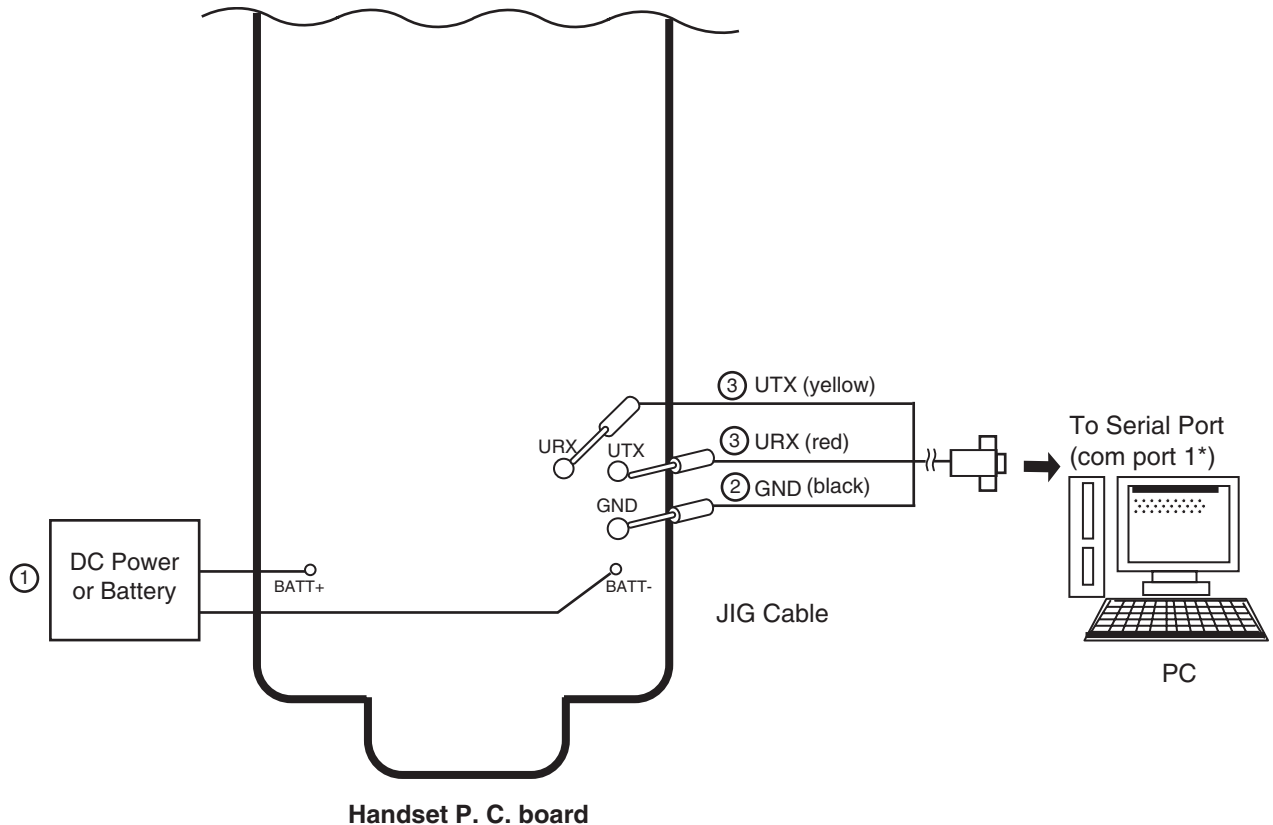
Resistor	Old value (kΩ)	New value (kΩ)
R2	22	3.3
R3	22	3.3
R4	22	4.7
R7	4.7	10

Note:

*: If you have the JIG Cable for TCD500 series

11.5.1. Connections

- ① Connect the DC Power or Battery to BATT+ and BATT-.
- ② Connect the JIG cable GND (black) to GND.
- ③ Connect the JIG cable UTX (yellow) to UTX and URX (red) to URX.



Note:

*: COM port names may vary depending on what your PC calls it.

11.5.2. How to install Batch file into P.C.

1. Insert the Batch file CD-ROM into CD-ROM drive and copy PNZZTG***** folder to your PC (example: D drive).

2. Open an MS-DOS mode window.

<Example for Windows>

On your computer, click **[Start]**, select **Programs** (**All Programs** for Windows XP/Windows Server 2003), then click

MS-DOS Prompt. (for Windows 95/Windows 98)

Or

Accessories-MS-DOS Prompt. (for Windows Me)

Or

Command Prompt. (for Windows NT 4.0)

Or

Accessories-Command Prompt.

(for Windows 2000/Windows XP/Windows Server 2003)

3. At the DOS prompt, type "**D:**" (for example) to select the drive, then press the **Enter** key.

4. Type "**CD ¥PNZZTG*******", then press the **Enter** key.

5. Type "**SET RTX_COM=X**", then press the **Enter** key
(**X**: COM port number used for the serial connection on your PC).

6. Type "**READID**", then press the **Enter** key.

- If any error messages appear, change the port number or check the cable connection.
- If any value appear, go to next step.

7. Type "**DOSKEY**", then press the **Enter** key.

<Example>

```
C: ¥Documents and Settings>D:
D: ¥>CD ¥PNZZTG*****
D: ¥PNZZTG***** >SET RTX_COM=X
D: ¥PNZZTG*****>READID
00 52 4F A8 A8
D: ¥PNZZTG*****>DOSKEY
D: ¥PNZZTG*****> _
```

<Example: Error happens>

```
C: ¥Documents and Settings>D:
D: ¥>CD ¥PNZZTG*****
D: ¥PNZZTG***** >SET RTX_COM=X
D: ¥PNZZTG*****>READID
CreateFile error
ERROR 10: Can't open serial port
D: ¥PNZZTG*****> _
```

Note:

- "*****" varies depending on the country or models.

11.5.3. Commands

See the table below for frequently used commands.

Command name	Function	Example
rdeeprom	Read the data of EEPROM	Type "rdeeprom 00 00 FF", and the data from address "00 00" to "FF" is read out.
readid	Read ID (RFPI)	Type "readid", and the registered ID is read out.
writeid	Write ID (RFPI)	Type "writeid 00 18 E0 0E 98", and the ID "0018 E0 0E 98" is written.
getchk	Read checksum	Type "getchk".
wreeprom	Write the data of EEPROM	Type "wreeprom 01 23 45". "01 23" is address and "45" is data to be written.

11.7. Things to Do after Replacing IC or X'tal

If repairing or replacing EEPROM and X'tal, it is necessary to download the required data such as Programming data or adjustment data, etc in memory.

The set doesn't operate if it is not executed.

11.7.1. How to download the data

11.7.1.1. Base Unit

First, operate the PC setting according to **The Setting Method of JIG (Base Unit)** (P.53).

Then download the appropriate data according to the following procedures.

Items		How to download/Required adjustment
BBIC (IC501)	Programming data is stored in memory.	1) Make sure to connect the JIG cable, then disconnect the DC Power in order to download the data. 2) Execute the command "flw480 *****.hex". 3) Connect the DC Power. 4) Press the PC Enter key once. 5) After a few minutes, "Successful upgrade" is displayed on the PC indicating downloading has finished. 6) Detach the JIG cable, then disconnect the DC Power. 7) Connect the DC Power. 8) Connect the JIG cable again, and execute the command "getchk", then confirm the checksum value is correct. . If the downloading fails, start again from step 1). 9) Default batch file: Execute the command "default.bat". 10) Country version batch file: Execute the command "TG6551EUXXrevYY.bat". (*1) 11) Clock adjustment: Refer to Check Point (G). (*2)
EEPROM (IC611)	Adjusted parameter data is stored in memory. (country version batch file, default batch file, etc.)	1) Change the address "0001" of EEPROM to "55" to download the data. 2) Default batch file: Execute the command "default.bat". 3) Country version batch file: Execute the command "TG6551EUXXrevYY.bat". (*1) 4) Clock adjustment
X'tal (X1)	System clock	Clock adjustment data is in EEPROM, adjust the data again after replacing it. 1) Apply 6.5V between DCP and DCM with DC power. 2) Input Command "sendchar sfr", then you can confirm the current value. 3) Check X'tal Frequency.(13.824 MHz \pm 100 Hz). 4) If the frequency is not 13.824 MHz \pm 100 Hz, adjust the frequency of CLK executing the command "sendchar sfr xx xx (where xx is the value)" so that the reading of the frequency counter is 13.824000 MHz \pm 15 Hz.

Note:

(*1) XX: country code, YY: revision number

"XX", "YY" vary depending on the country version. You can find them in the batch file, PNZZ- mentioned in **The Setting Method of JIG (Base Unit)** (P.53).

11.7.1.2. Handset

First, operate the PC setting according to **The Setting Method of JIG (Handset)**(P.57).

Then download the appropriate data according to the following procedures.

Items		How to download/Required adjustment
BBIC (FLASH type) (IC1)	Programming data is stored in memory.	1) Make sure to connect the JIG cable, then disconnect the DC Power in order to download the data. 2) Execute the command "flw480 *****.hex". 3) Connect the DC Power. 4) Press and hold the handset Power key. 5) While holding down the handset Power key, press the PC Enter key once. 6) After a few minutes, "Successful upgrade" is displayed on the PC indicating downloading has finished. 7) Detach the JIG cable, then press the handset Power key to turn it on. 8) Connect the JIG cable again, and execute the command "getchk", then confirm the checksum value is correct. • If the downloading fails, start again from step 1). 9) Default batch file: Execute the command "default.bat". 10) Default batch file (remaining): Execute the command "TGA650RUDEFrevYY.bat". (*3). 11) Country version batch file: Execute the command "TGA650RUXXrevYY.bat". (*3). 12) Clock adjustment: Refer to Check Point (H). (*4). 13) 1.8 V setting and battery low detection: Refer to Check Point (A), (F) and (G). (*4).
EEPROM (IC3)	Adjusted parameter data is stored in memory. (country version batch file, default batch file, etc.)	1) Default batch file: Execute the command "default.bat". 2) Default batch file (remaining): Execute the command "TGA650RUDEFrevYY.bat". (*3) 3) Country version batch file: Execute the command "TGA650RUXXrevYY.bat". (*3) 4) Clock adjustment: Refer to Check Point (H). (*4) 5) 1.8 V setting and battery low detection: Refer to Check Point (A), (F) and (G). (*4)
X'tal (X1)	System clock	Clock adjustment data is in EEPROM, adjust the data again after replacing it. 1) Refer to Check Point (C). (*4)

Note:

(*3) XX: country code, YY: revision number

"XX" and "YY" vary depending on the country version. You can find them in the batch file, PNZZ- mentioned in **The Setting Method of JIG (Handset)** (P.57).

(*4) Refer to **Check Point (Handset)** (P.44)

11.8. RF Specification

11.8.1. Base Unit

Item	Value	Refer to -. *
TX Power	19 dBm ~ 25 dBm	Check Point (Base Unit) (J)
Modulation	-370±30/+370±30 kHz/div & Modulated width \geq 690 kHz	Check Point (Base Unit) (K)
Frequency Offset	-50 kHz ~ +50 kHz	Check Point (Base Unit) (L)
Frequency Drift	< \pm 35 kHz / ms	Check Point (Base Unit) (M)
RX Sensitivity	< 1000 ppm	Check Point (Base Unit) (N)
Timing Accuracy	< \pm 5.0 ppm/<±15.0ppm	Check Point (Base Unit) (O)
Power RAMP	Power RAMP is matching	Check Point (Base Unit) (P)

*: Refer to **Check Point (Base Unit) (P.41)**

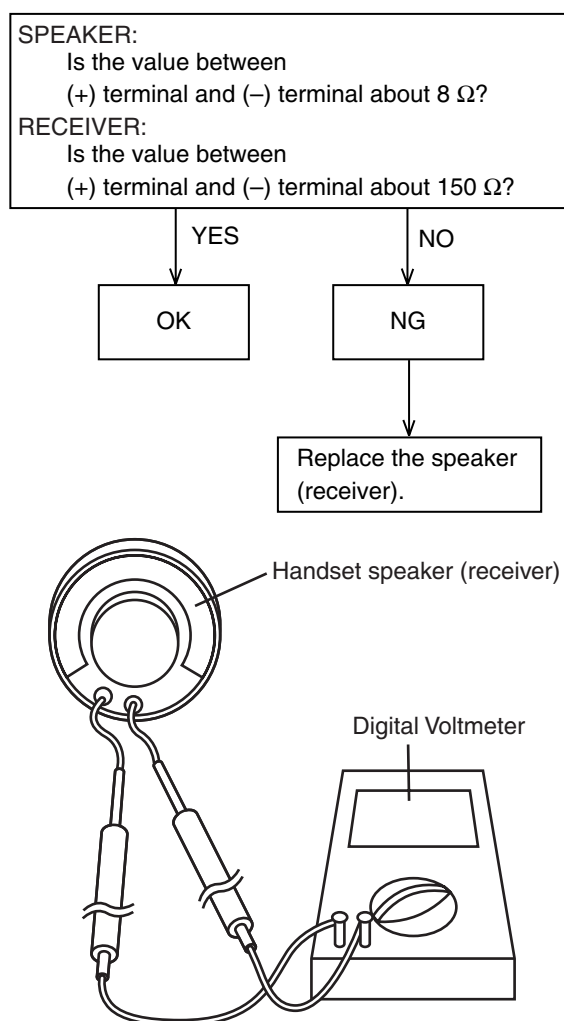
11.8.2. Handset

Item	Value	Refer to -. **
TX Power	19 dBm ~ 25 dBm	Check Point (Handset) (I)
Modulation	-370±30/+370±30 kHz/div & Modulated width \geq 690 kHz	Check Point (Handset) (J)
Frequency Offset	-50 kHz ~ +50 kHz	Check Point (Handset) (K)
Frequency Drift	< \pm 35 kHz / ms	Check Point (Handset) (L)
RX Sensitivity	< 1000 ppm	Check Point (Handset) (M)
Power RAMP	Power RAMP is matching	Check Point (Handset) (N)

: Refer to **Check Point (Handset) (P.44)

11.9. How to Check the Handset Speaker or Receiver

1. Prepare the digital voltmeter, and set the selector knob to ohm meter.
2. Put the probes at the speaker terminals as shown below.



11.10. Frequency Table (MHz)

Channel No	BASE UNIT		HANDSET	
	Transmit Frequency	Receive Frequency	Transmit Frequency	Receive Frequency
1	1897.344	1897.344	1897.344	1897.344
2	1895.616	1895.616	1895.616	1895.616
3	1893.888	1893.888	1893.888	1893.888
4	1892.160	1892.160	1892.160	1892.160
5	1890.432	1890.432	1890.432	1890.432
6	1888.704	1888.704	1888.704	1888.704
7	1886.976	1886.976	1886.976	1886.976
8	1885.248	1885.248	1885.248	1885.248
9	1883.520	1883.520	1883.520	1883.520
10	1881.792	1881.792	1881.792	1881.792

Note:

Channel No. 10: In the Test Mode on Base Unit and Handset.

12 Miscellaneous

12.1. How to Replace the Flat Package IC

Even if you do not have the special tools (for example, a spot heater) to remove the Flat IC, with some solder (large amount), a soldering iron and a cutter knife, you can easily remove the ICs that have more than 100 pins.

12.1.1. Preparation

- PbF (: Pb free) Solder
- Soldering Iron

Tip Temperature of 700 °F ± 20 °F (370 °C ± 10 °C)

Note: We recommend a 30 to 40 Watt soldering iron. An expert may be able to use a 60 to 80 Watt iron where someone with less experience could overheat and damage the PCB foil.

- Flux

Recommended Flux: Specific Gravity → 0.82.

Type → RMA (lower residue, non-cleaning type)

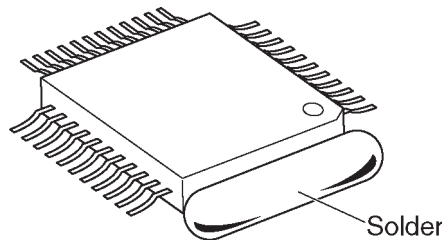
Note: See **About Lead Free Solder (Pbf: Pb free)** (P.4)

12.1.2. How to Remove the IC

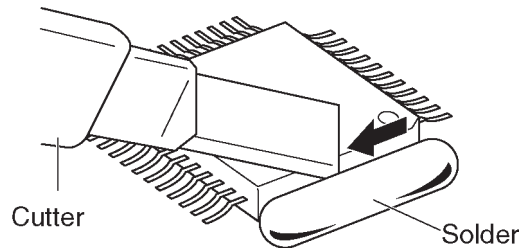
1. Put plenty of solder on the IC pins so that the pins can be completely covered.

Note:

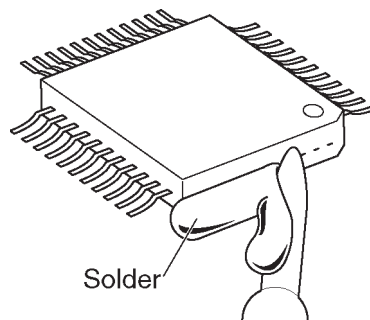
If the IC pins are not soldered enough, you may give pressure to the P.C. board when cutting the pins with a cutter.



2. Make a few cuts into the joint (between the IC and its pins) first and then cut off the pins thoroughly.



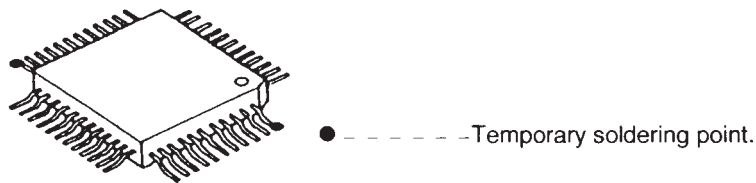
3. While the solder melts, remove it together with the IC pins.



When you attach a new IC to the board, remove all solder left on the board with some tools like a soldering wire. If some solder is left at the joint on the board, the new IC will not be attached properly.

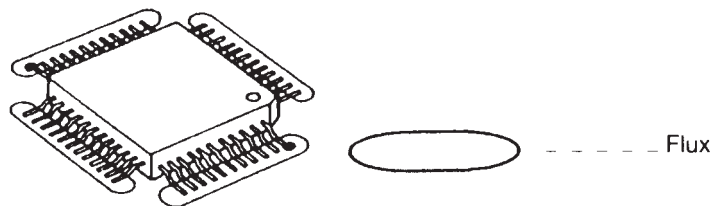
12.1.3. How to Install the IC

1. Temporarily fix the FLAT PACKAGE IC, soldering the two marked pins.

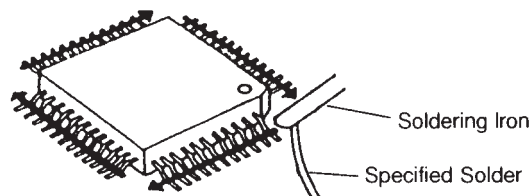


*Check the accuracy of the IC setting with the corresponding soldering foil.

2. Apply flux to all pins of the FLAT PACKAGE IC.

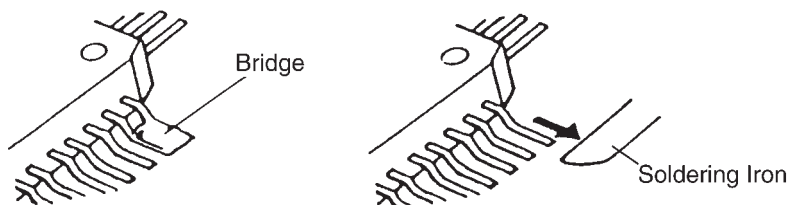


3. Solder the pins, sliding the soldering iron in the direction of the arrow.



12.1.4. How to Remove a Solder Bridge

1. Lightly resolder the bridged portion.
2. Remove the remaining solder along the pins using a soldering iron as shown in the figure below.



12.2. How to Replace the LLP (Leadless Leadframe Package) IC

Note:

This description is only applied on the model with Shield case.

12.2.1. Preparation

- PbF (: Pb free) Solder
- Soldering Iron
Tip Temperature of $700^{\circ}\text{F} \pm 20^{\circ}\text{F}$ ($370^{\circ}\text{C} \pm 10^{\circ}\text{C}$)

Note:

We recommend a 30 to 40 Watt soldering iron. An expert may be able to use a 60 to 80 Watt iron where someone with less experience could overheat and damage the PCB foil.

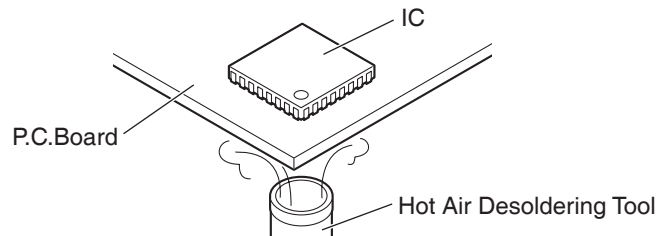
- Hot Air Desoldering Tool
Temperature: $608^{\circ}\text{F} \pm 68^{\circ}\text{F}$ ($320^{\circ}\text{C} \pm 20^{\circ}\text{C}$)

12.2.2. Caution

- To replace the IC efficiently, choose the right sized nozzle of the hot air desoldering tool that matches the IC package.
- Be careful about the temperature of the hot air desoldering tool not to damage the PCB and/or IC.

12.2.3. How to Remove the IC

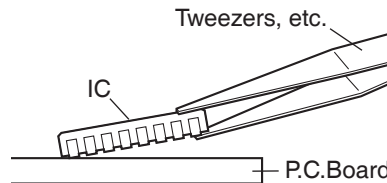
1. Heat the IC with a hot air desoldering tool through the P.C.Board.



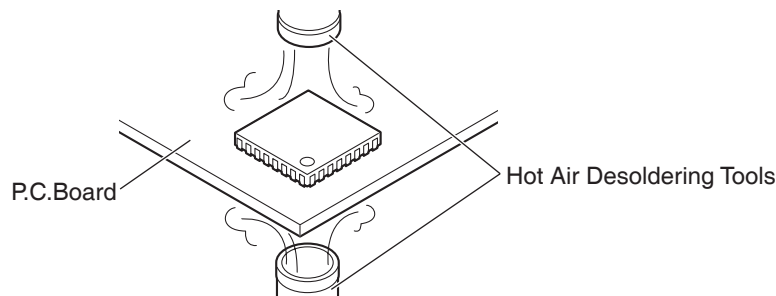
2. Pick up the IC with tweezers, etc. when the solder is melted completely.

Note:

- Be careful not to touch the peripheral parts with tweezers, etc. They are unstable.



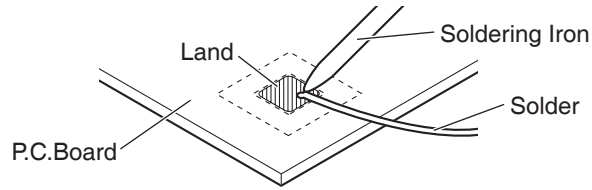
When it is hard to melt the solder completely, heat it with a hot air desoldering tool through the IC besides through the P.C.Board.



3. After removing the IC, clean the P.C.Board of residual solder.

12.2.4. How to Install the IC

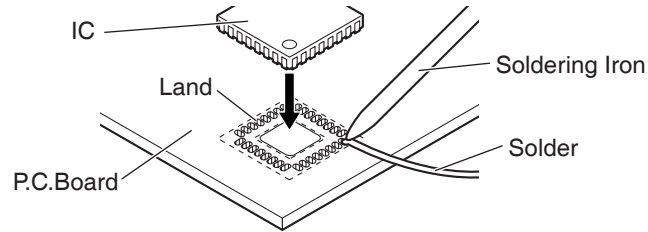
1. Place the solder a little on the land where the radiation GND pad on IC bottom is to be attached.



2. Place the solder a little on the land where IC pins are to be attached, then place the IC.

Note:

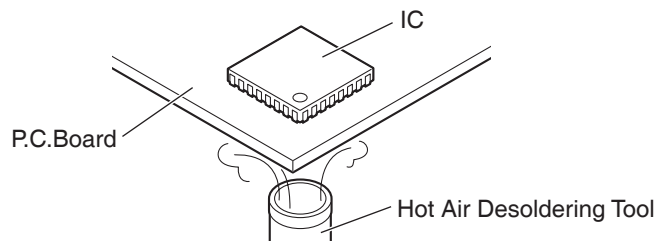
- When placing the IC, the positioning should be done very carefully.



3. Heat the IC with a hot air desoldering tool through the P.C.Board until the solder on IC bottom is melted.

Note:

- Be sure to place it precisely, controlling the air volume of the hot air desoldering tool.



4. After soldering, confirm there are no short and open circuits with visual inspection.

12.3. How to Replace the Shield Case

12.3.1. Preparation

- PbF (: Pb free) Solder
- Soldering Iron
Tip Temperature of 700°F ± 20°F (370°C ± 10°C)

Note:

We recommend a 30 to 40 Watt soldering iron. An expert may be able to use a 60 to 80 Watt iron where someone with less experience could overheat and damage the PCB foil.

- Hot Air Desoldering Tool
Temperature: 608°F ± 68°F (320°C ± 20°C)

12.3.2. Caution

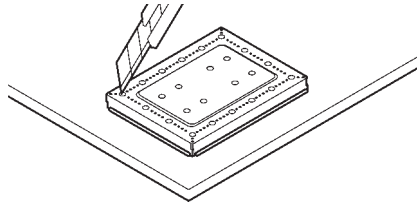
- To replace the IC efficiently, choose the right sized nozzle of the hot air desoldering tool that matches the IC package.
- Be careful about the temperature of the hot air desoldering tool not to damage the PCB and/or IC.

12.3.3. How to Remove the Shield Case

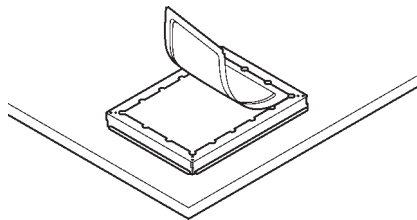
Note:

If you don't have special tools (ex. Hot air disordering tool), conduct the following operations.

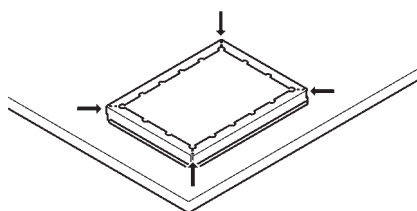
1. Cut the case along perforation.



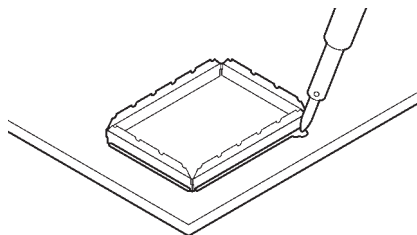
2. Remove the cut part.



3. Cut the four corners along perforation.



4. Remove the remains by melting solder.

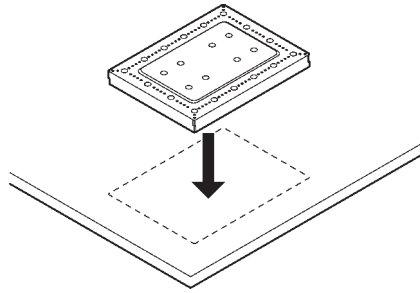


12.3.4. How to Install the Shield Case

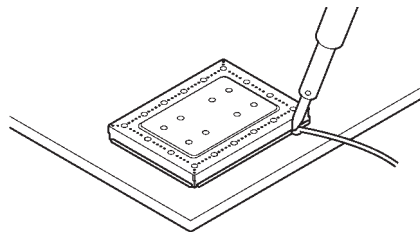
Note:

- If you don't have special tools (ex. Hot air disordering tool), conduct the following operations.
- Shield case's No. : PNMC1013Z

1. Put the shield case.



2. Solder the surroundings.



12.4. Terminal Guide of the ICs, Transistors, Diodes and Electrolytic Capacitors

12.4.1. Base Unit

 (Reverse View) 44 23 45 22 66 1 67 88 C2HBCY000059	 4 5 1 2 3 B1ZBZ0000065 C0DBAGZ00026	 4 1 5 8 PNWITG6521EH	 B C E 2SC6054JSL, B1ABCE000009 PQVTBF822T7, UNR92A6J0L UNR92A9J0L, 2SB1218A UNR92A2J0L	
 E C B B1ACGP000007	 B C E 2SD0874AS	 + ~ - B0EDER000009	 Cathode Anode MA111 PQVDRLZ20A MA8033 B0ECKM000008	 Cathode Anode B0DDCD000001
 Cathode Anode LNJ308G8JRA	 Cathode Anode PQVD BR1111C	 - + F2A1C1010119		

12.4.2. Handset

 (Reverse View) 40 21 41 20 60 1 61 80 C1CB00002906	 4 1 5 8 PNWIGA651EXR	 5 1 6 10 C1CB00001842	 B C E UN9219J, 2SC6054JSL B1ADGE000004, B1ADCF000161	
 Cathode Anode MA8043M MA2YD2120L MA2ZD0200L	 Cathode Anode B0DDCD000001	 (Reverse View) Cathode Anode B3ACB0000216	 Cathode Anode B3AEB0000124	 - + F2A0J3310067

13 Schematic Diagram

13.1. For Schematic Diagram

13.1.1. Base Unit (Schematic Diagram (Base Unit))

Notes:

1. DC voltage measurements are taken with voltmeter from the negative voltage line.

Important Safety Notice:
Components identified by ⚠ mark have special characteristics important for safety. When replacing any of these components, use only the manufacturer's specified parts.

2. The schematic diagrams may be modified at any time with the development of new technology.

13.1.2. Handset (Schematic Diagram (Handset))

Notes:

1. DC voltage measurements are taken with an oscilloscope or a tester with a ground.
2. The schematic diagram may be modified at any time with the development of new technology.

13.1.3. Charger Unit (Schematic Diagram (Charger Unit))

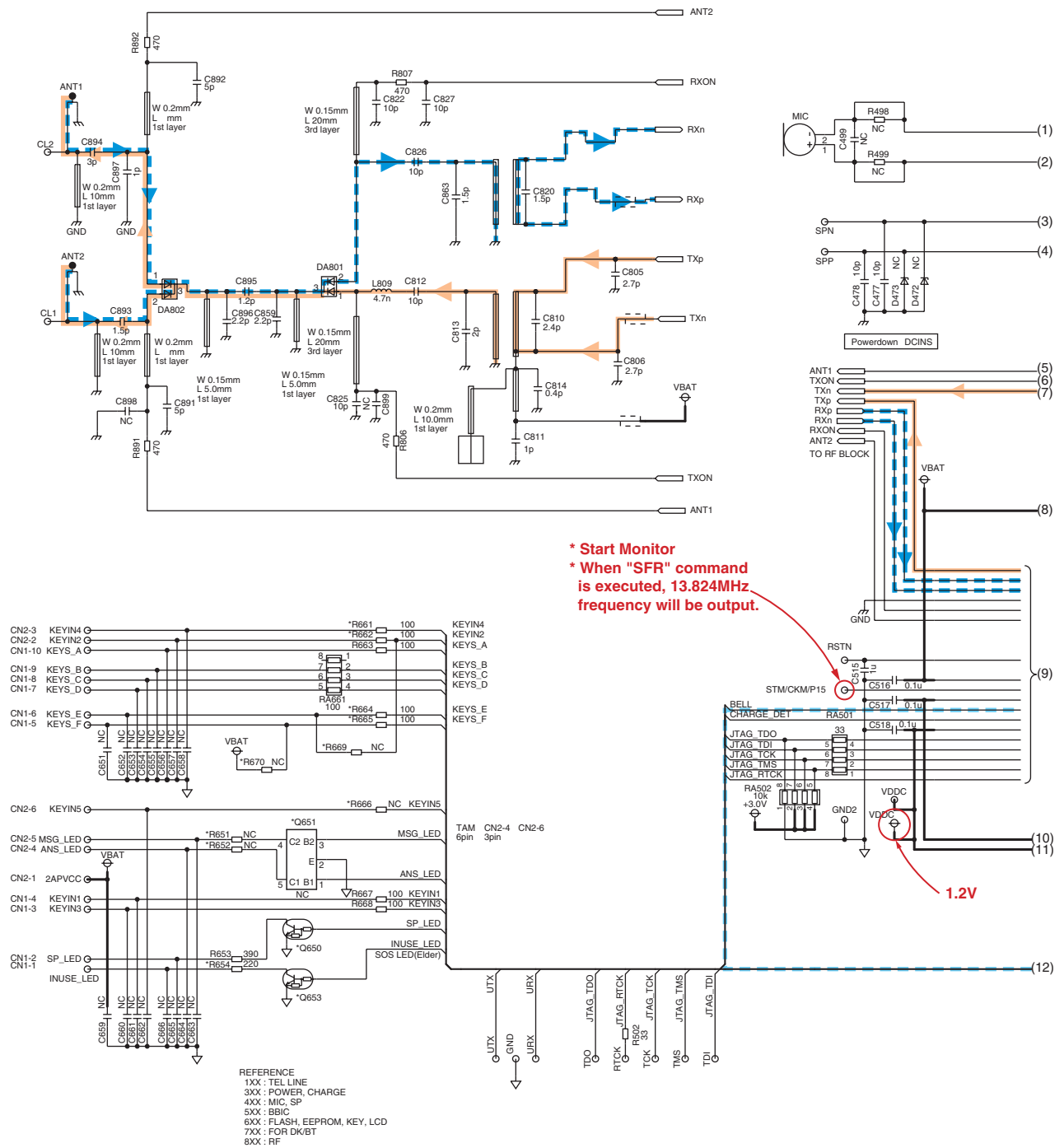
Notes:

1. DC voltage measurements are taken with voltmeter from the negative voltage line.

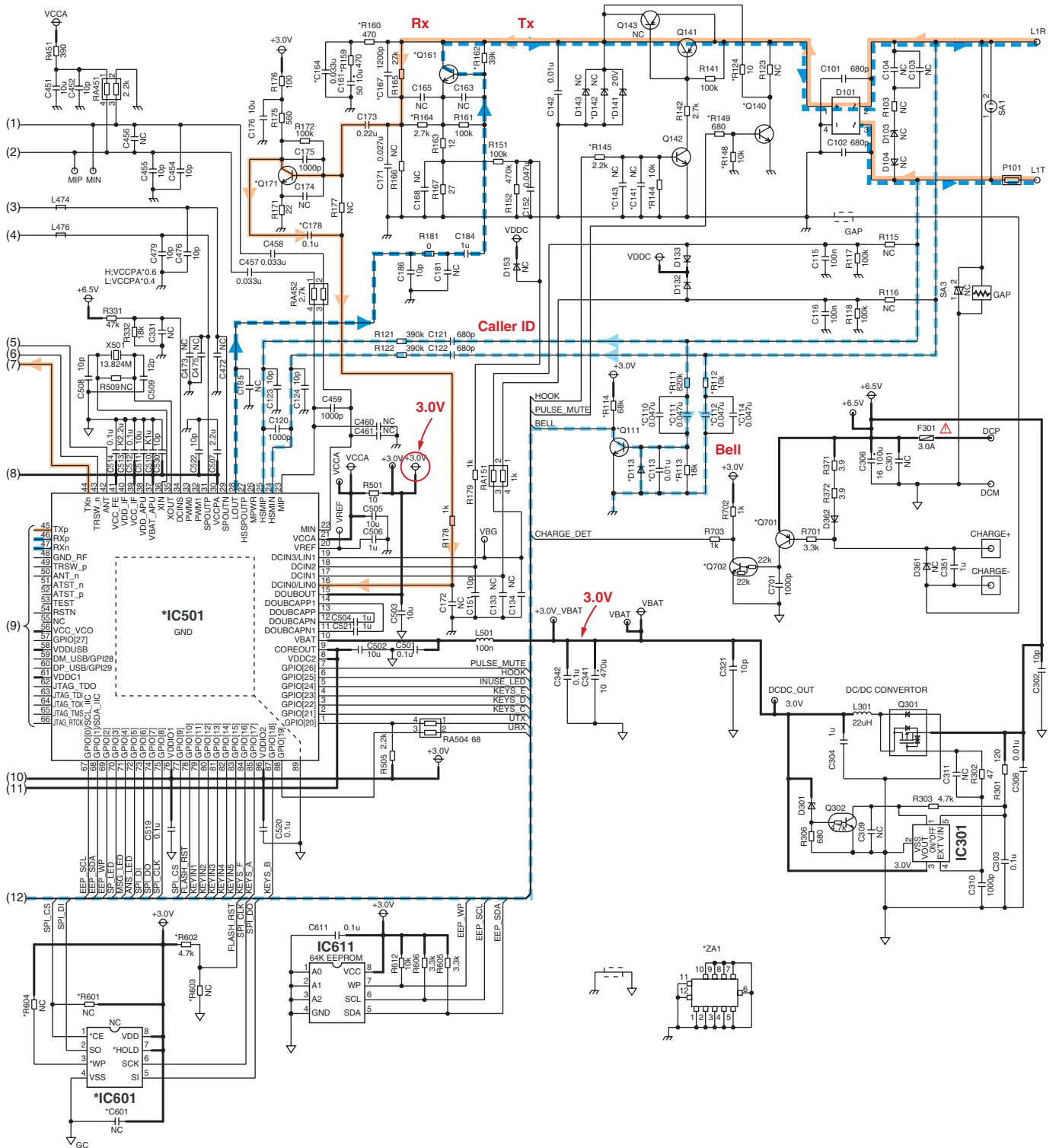
Important Safety Notice:
Components identified by ⚠ mark have special characteristics important for safety. When replacing any of these components, use only the manufacturer's specified parts.

2. The schematic diagram may be modified at any time with the development of new technology.

13.2. Schematic Diagram (Base Unit)



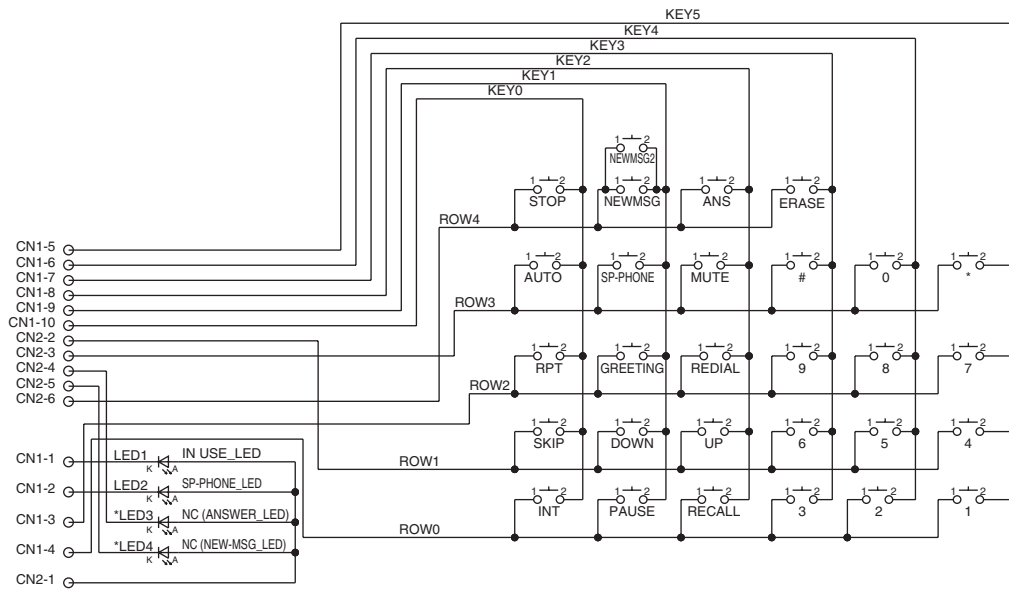
NC: No Components



NC: No Components

KX-TG6551CA SCHEMATIC DIAGRAM (Base Unit)

13.3. Schematic Diagram (Base Unit_Operation)



NC: No Components

KX-TG6551 SCHEMATIC DIAGRAM (Base Unit_Operation)

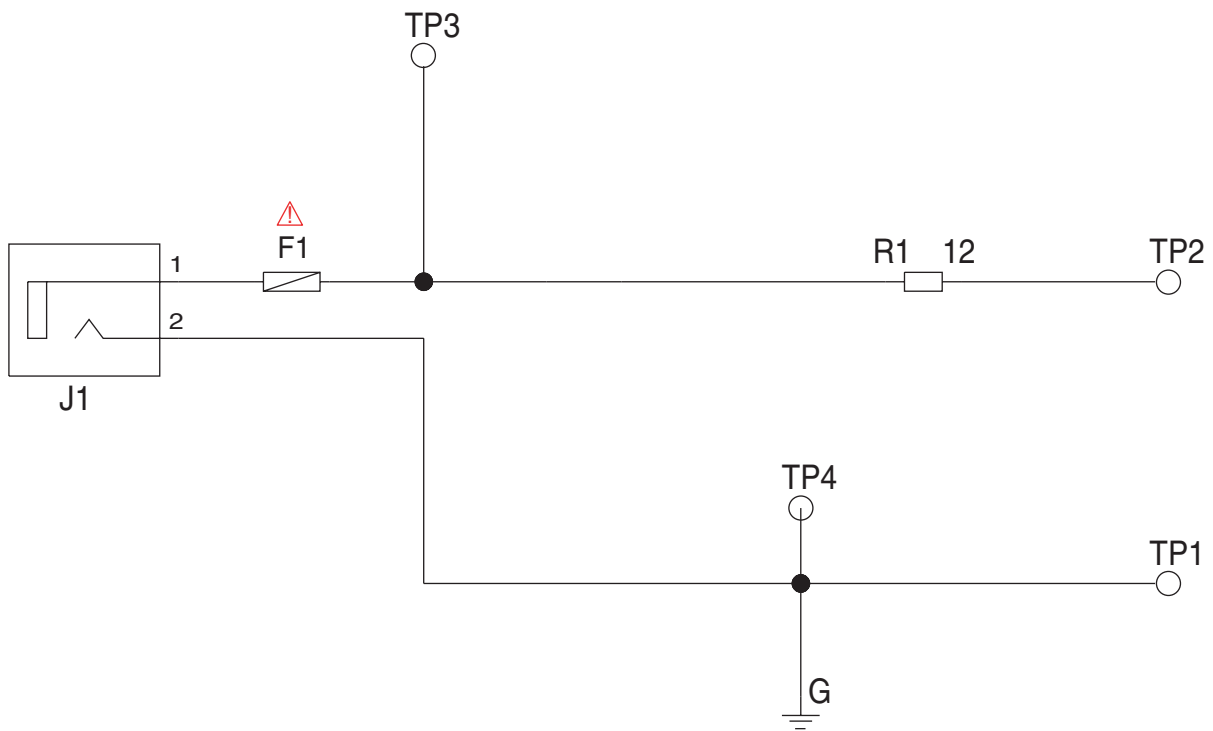
Memo



NC: No Components

KX-TGA650/651 SCHEMATIC DIAGRAM (Handset_Main)

13.5. Schematic Diagram (Charger Unit)

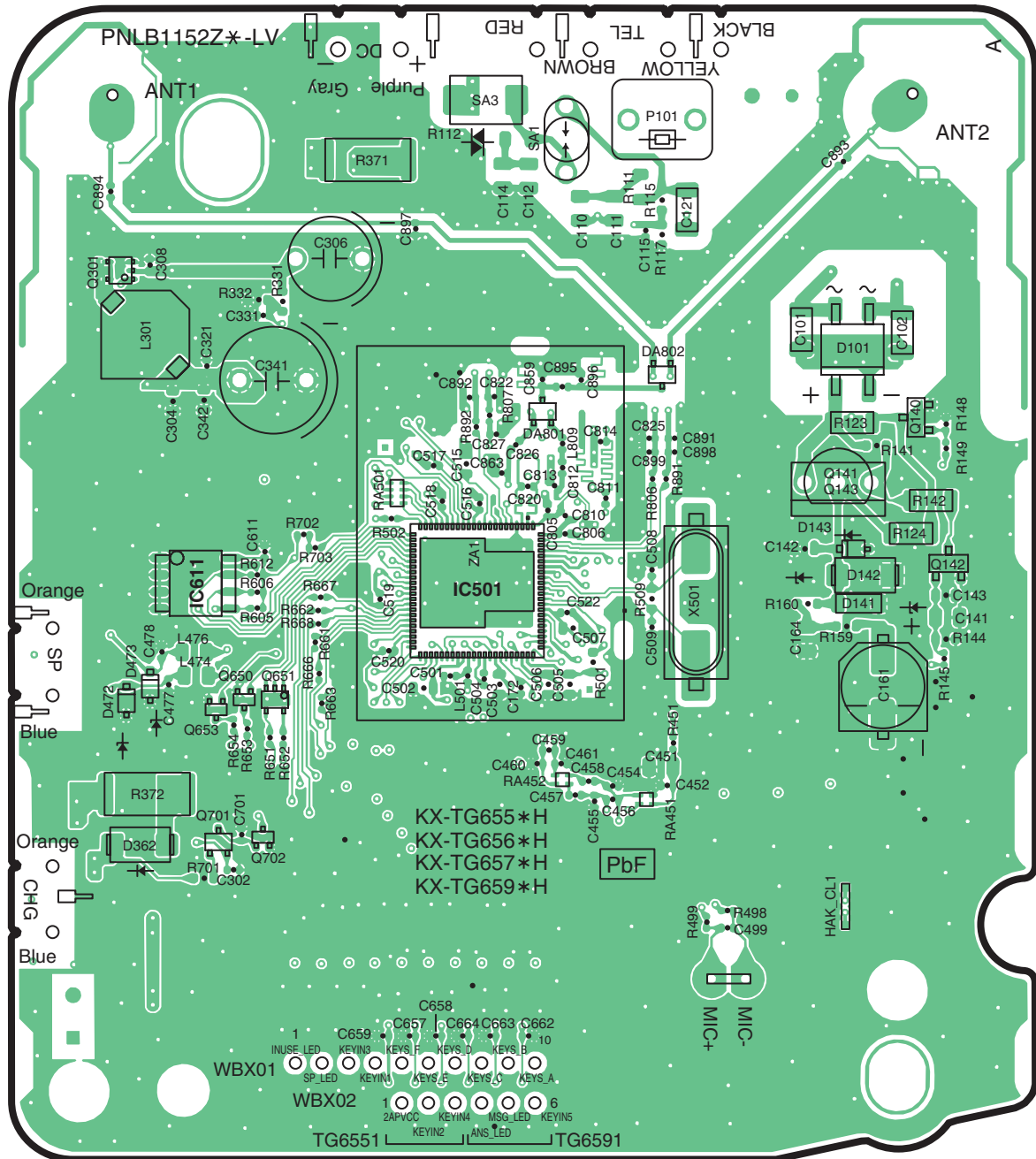


SCHEMATIC DIAGRAM (Charger Unit)

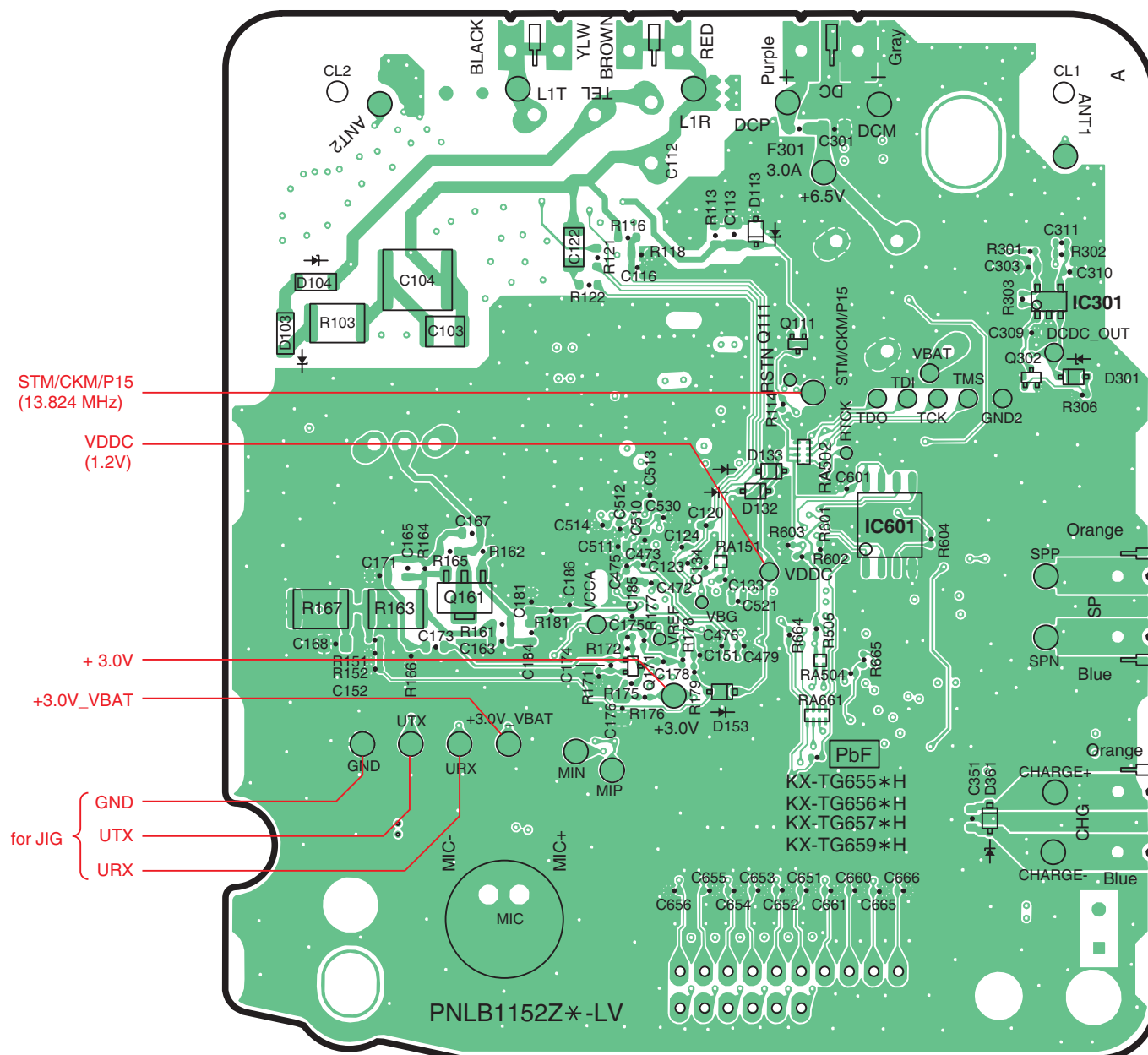
14 Printed Circuit Board

14.1. Circuit Board (Base Unit_Main)

14.1.1. Component View

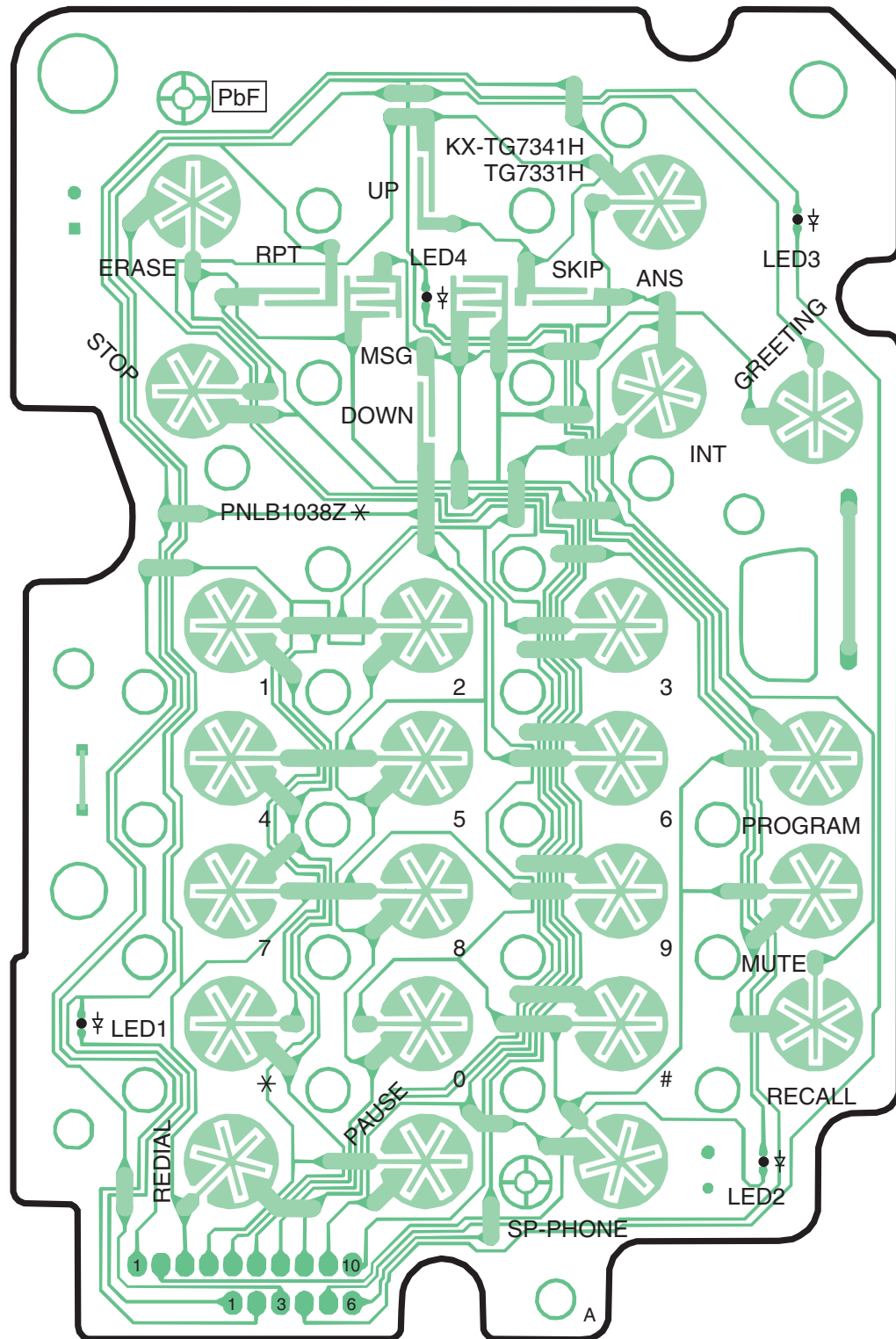


14.1.2. Bottom View



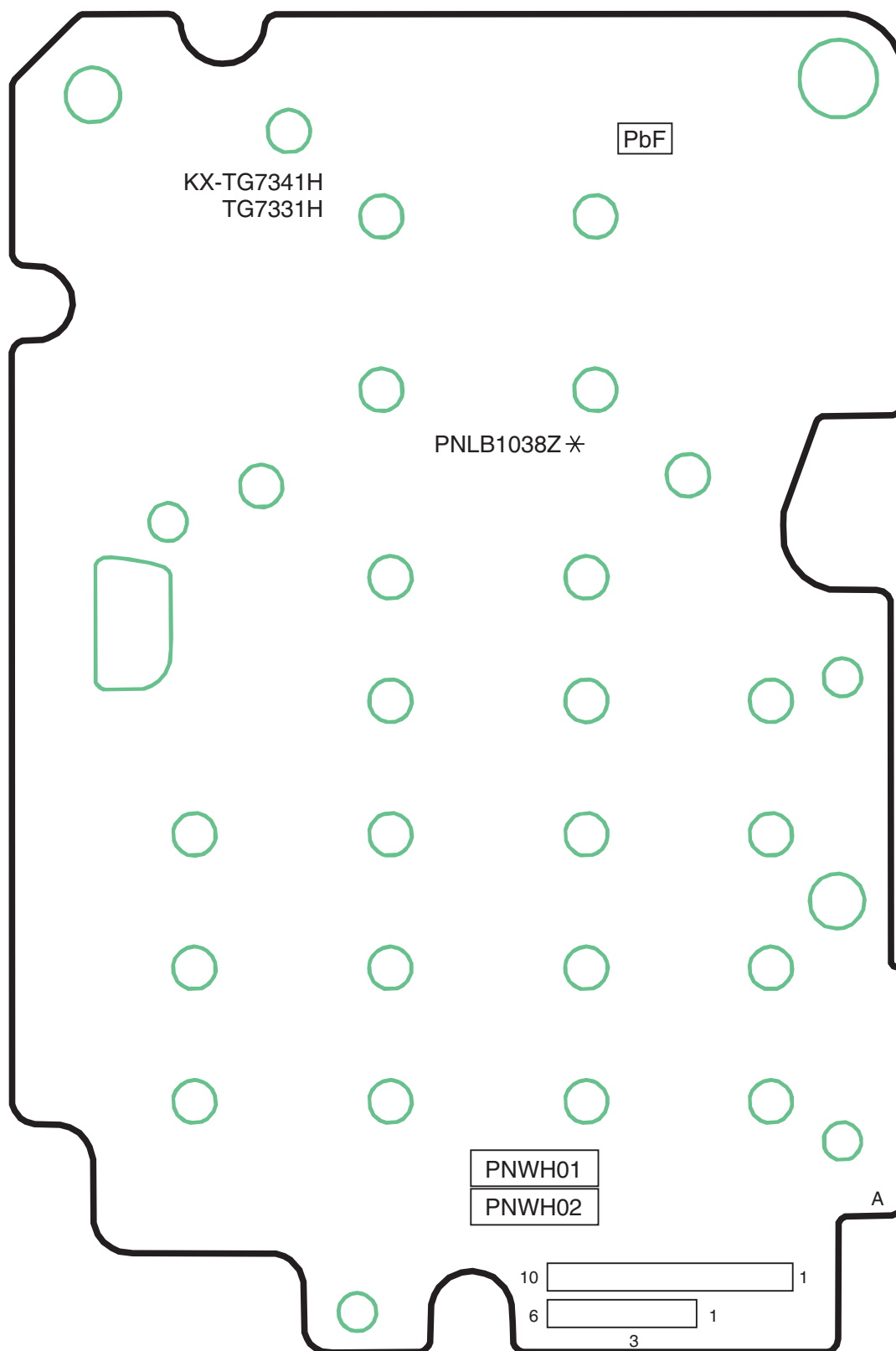
14.2. Circuit Board (Base Unit_Operation)

14.2.1. Component View



KX-TG6551 CIRCUIT BOARD (Base Unit_Operation (Component View))

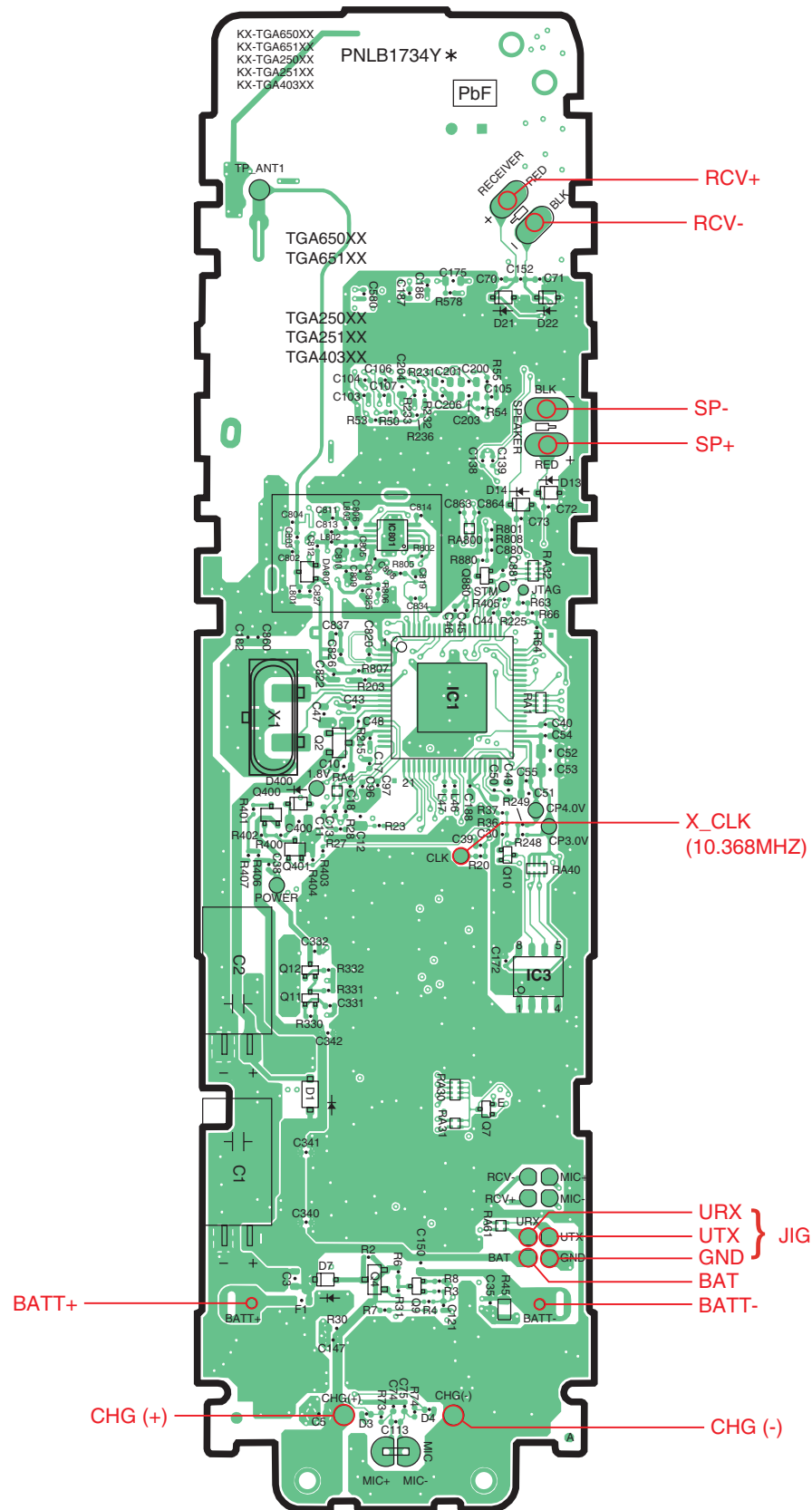
14.2.2. Bottom View



KX-TG6551 CIRCUIT BOARD (Base Unit_Operation (Bottom View))

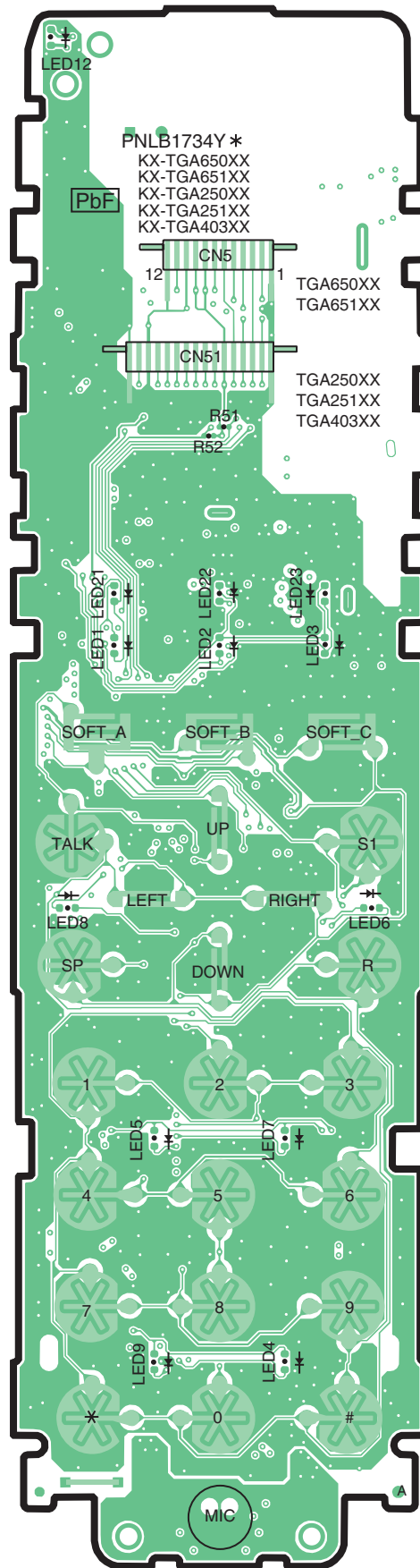
14.3. Circuit Board (Handset)

14.3.1. Component View



KX-TGA650/651 CIRCUIT BOARD (Handset_Main (Component View))

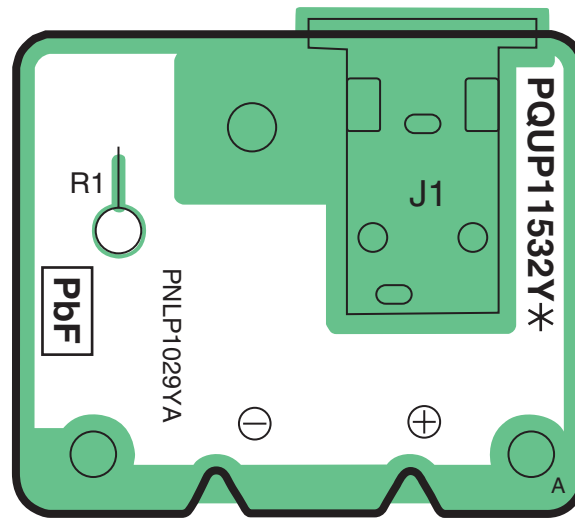
14.3.2. Bottom View



KX-TGA650/651 CIRCUIT BOARD (Handset_Main (Bottom View))

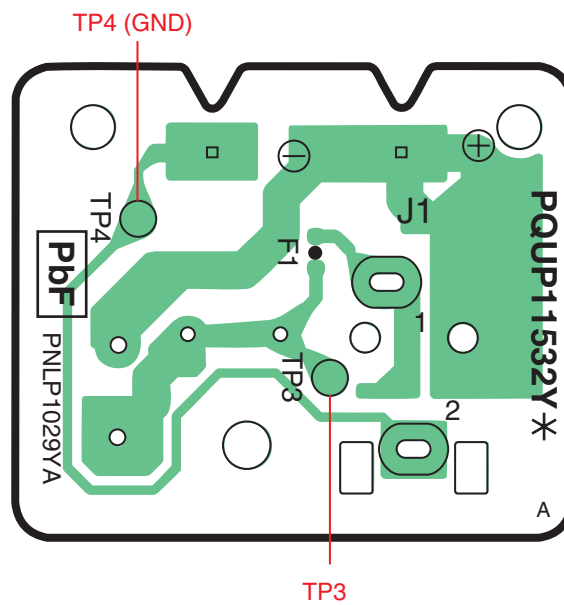
14.4. Circuit Board (Charger Unit)

14.4.1. Component View



CIRCUIT BOARD (Charger unit (Component View))

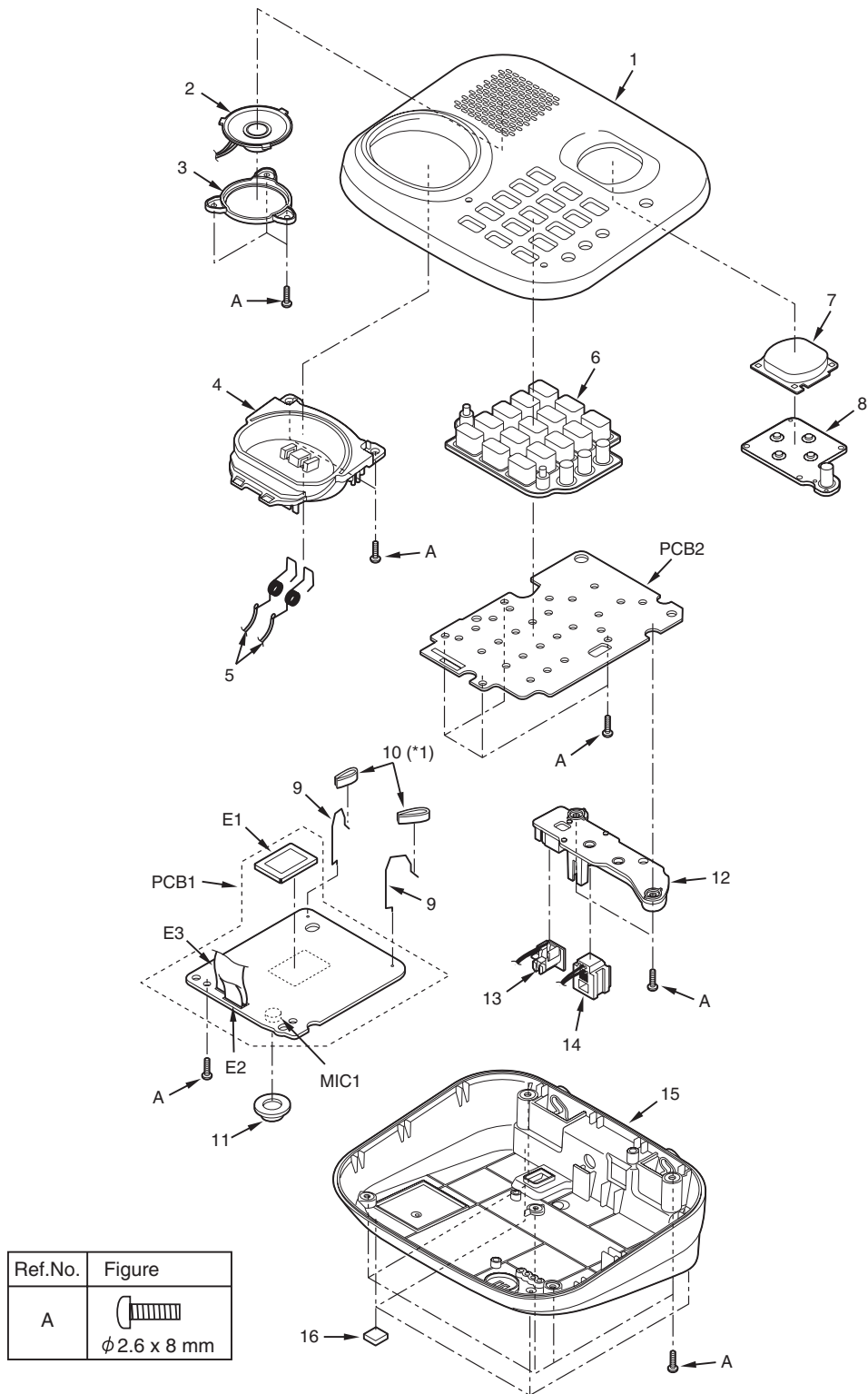
14.4.2. Bottom View



CIRCUIT BOARD (Charger unit (Bottom View))

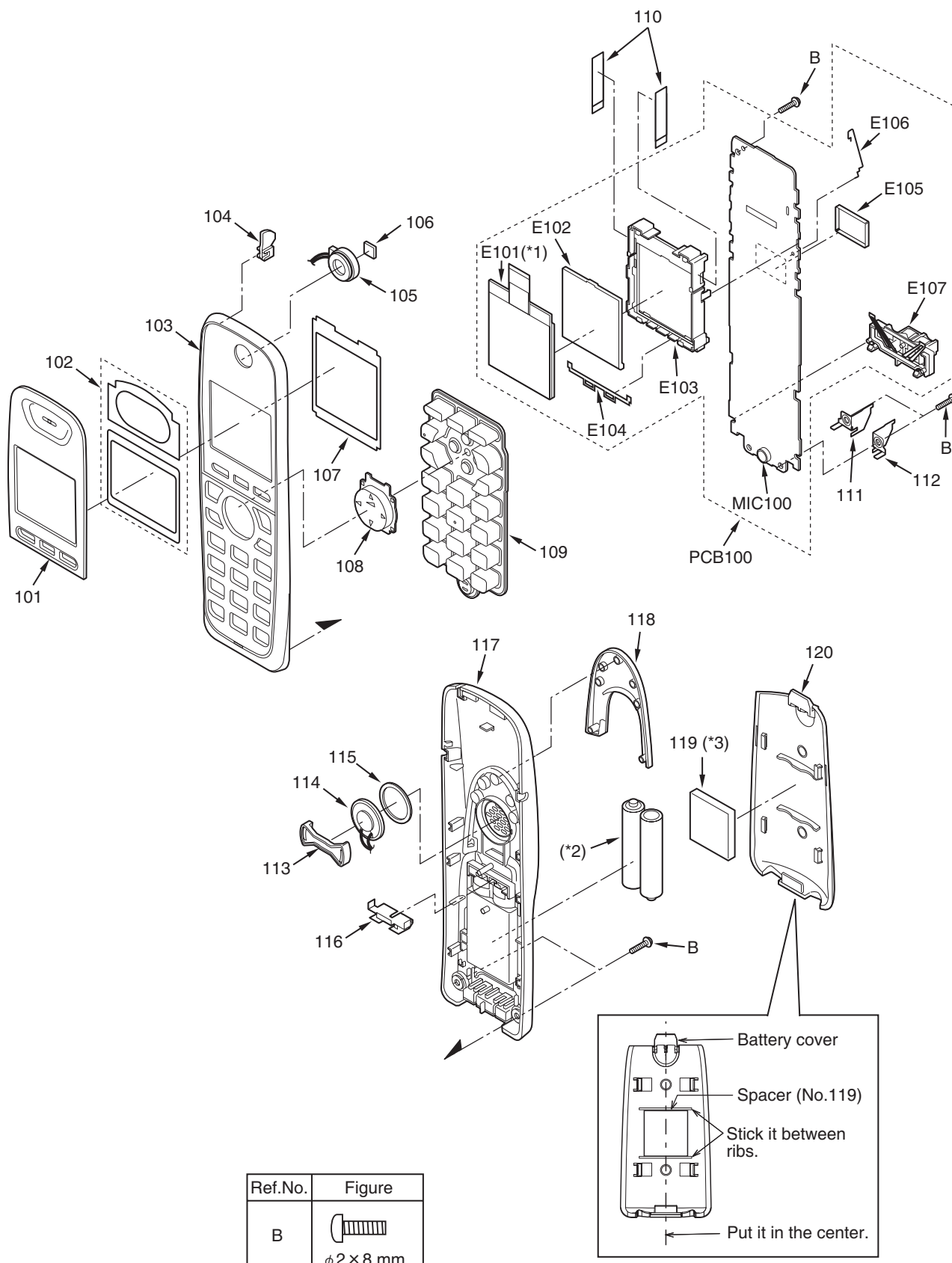
15 Exploded View and Replacement Parts List

15.1. Cabinet and Electrical Parts (Base Unit)



Note:
 (*1) The SPACERS (No.10) are cut from the excess parts of SPACER (No.107) of **Cabinet and Electrical Parts (Handset)** (P.87).

15.2. Cabinet and Electrical Parts (Handset)



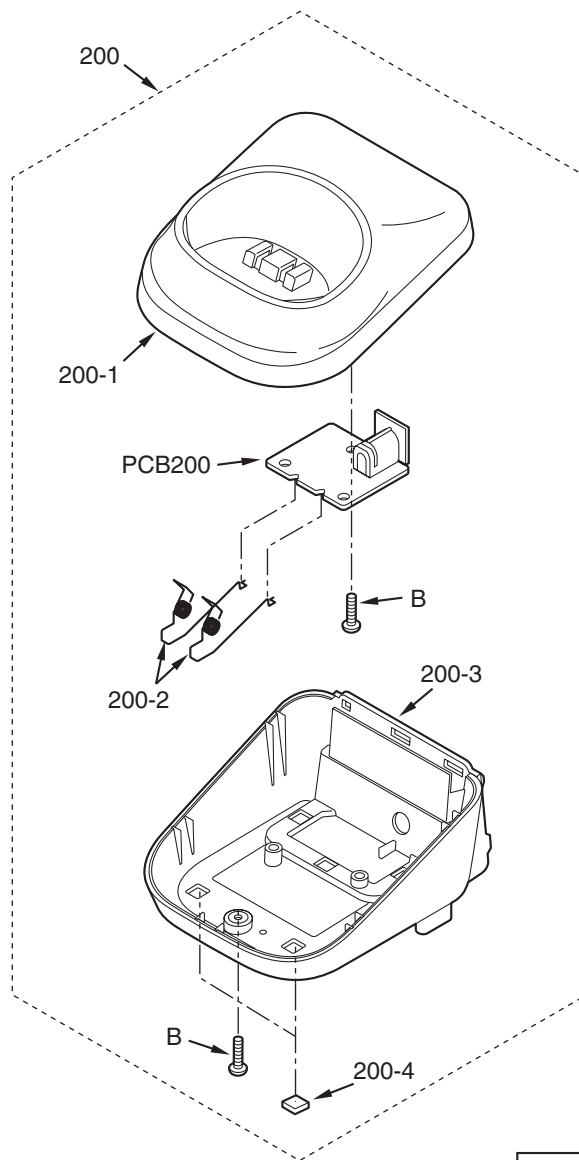
Note:


(*1) This cable is fixed by welding. Refer to **How to Replace the Handset LCD** (P.52).

(*2) The rechargeable Ni-MH battery P03P or HHR-4NGE is available through sales route of Panasonic.

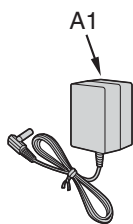
(*3) Attach the spacer (No. 119) to the exact location described above.

15.3. Cabinet and Electrical Parts (Charger Unit)



Ref.No.	Figure
B	 $\phi 2 \times 8 \text{ mm}$

15.4. Accessories



15.5. Replacement Part List

1. RTL (Retention Time Limited)

Note:

The "RTL" marking indicates that its Retention Time is Limited.

When production is discontinued, this item will continue to be available only for a specific period of time. This period of time depends on the type of item, and the local laws governing parts and product retention.

At the end of this period, the item will no longer be available.

2. Important safety notice

Components identified by the Δ mark indicates special characteristics important for safety. When replacing any of these components, only use specified manufacture's parts.

3. The S mark means the part is one of some identical parts.

For that reason, it may be different from the installed part.

4. ISO code (Example: ABS-94HB) of the remarks column shows quality of the material and a flame resisting grade about plastics.

5. RESISTORS & CAPACITORS

Unless otherwise specified;

All resistors are in ohms (Ω) k=1000 Ω , M=1000 k Ω

All capacitors are in MICRO FARADS (μ F)p= μ F

*Type & Wattage of Resistor

Type

ERC:Solid	ERX:Metal Film	PQ4R:Chip
ERDS:Carbon	ERG:Metal Oxide	ERS:Fusible Resistor
ERJ:Chip	ER0:Metal Film	ERF:Cement Resistor

Wattage

10,16:1/8W	14,25:1/4W	12:1/2W	1:1W	2:2W	3:3W
------------	------------	---------	------	------	------

*Type & Voltage Of Capacitor

Type

ECFD:Semi-Conductor	ECCD,ECKD,ECBT,F1K,ECUV:Ceramic
ECQS:Styrol	ECQE,ECQV,ECQG:Polyester
ECUV,PQCUV,ECUE:Chip	ECEA,ECST,EEE:Electlytic
ECQMS:Mica	ECQP:Polypropylene

Voltage

ECQ Type	ECQG ECQV Type	ECSZ Type	Others		
1H:50V	05:50V	0F:3.15V	0J :6.3V	1V :35V	
2A:100V	1:100V	1A:10V	1A :10V	50,1H:50V	
2E:250V	2:200V	1V:35V	1C :16V	1J :16V	
2H:500V		0J:6.3V	1E,25:25V	2A :100V	

15.5.1. Base Unit

15.5.1.1. Cabinet and Electrical Parts

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	1	PNKM1149Y2	CABINET BODY	PS-HB
	2	L0AA04A00028	SPEAKER	
	3	PQHR11082Z	GUIDE, SPEAKER	POM-HB
	4	PNKE1061Z1	CASE, CHARGE TERMINAL	PS-HB
	5	PNJT1003Z	CHARGE TERMINAL	
	6	PNJK1024S	KEYBOARD SWITCH, DIAL	
	7	PNBC1242X2	BUTTON, VOL KEY	ABS-HB
	8	PNJK1026Y	KEYBOARD SWITCH	
	9	PNLA1030Z	ANTENNA	
	10	PNYE1029Z	SPACER, ANTENNA	
	11	PQMG10025W	RUBBER PARTS, MIC	
	12	PNHR1038Z	GUIDE, JACK	PS-HB

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	13	K2ECYZ000001	JACK, DC	
	14	PQJJ1T039M	JACK, MODULAR	
	15	PNKF1032Z1	CABINET COVER	PS-HB
	16	PQHA10023Z	RUBBER PARTS, FOOT CUSHION	

15.5.1.2. Main P.C.Board Parts

Note:

(*1) When replacing IC501, IC611 or X501, make the adjustment using PNZZTG6551CA. Refer to **How to download the data (P.60) of Things to Do after Replacing IC or X'tal.**

(*2) When removing E1, use special tools (ex. Hot air disordering tool).

(*3) Backside of this IC has a ground plate. Refer to **How to Replace the Flat Package IC (P.64)**

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	PCB1	PNWP16551CAH	MAIN P.C.BOARD ASS'Y (RTL)	
			(ICs)	
	IC301	C0DBAGZ00026	IC	
	IC501	C2HBCY000059	IC (*1) (*3)	
	IC611	PNWITG6521EH	IC (EEPROM) (*1)	
			(TRANSISTORS)	
	Q111	2SC6054JSL	TRANSISTOR (SI)	
	Q140	B1ABCE000009	TRANSISTOR (SI)	
	Q141	B1ACGP000007	TRANSISTOR (SI)	
	Q142	PQVTBF822T7	TRANSISTOR (SI)	
	Q161	2SD0874AS	TRANSISTOR (SI)	
	Q171	2SC6054JSL	TRANSISTOR (SI)	
	Q301	B1ZBZ0000065	TRANSISTOR (SI)	
	Q302	UNR92A6J0L	TRANSISTOR (SI)	
	Q650	UNR92A9J0L	TRANSISTOR (SI)	
	Q653	UNR92A9J0L	TRANSISTOR (SI)	
	Q701	2SB1218A	TRANSISTOR (SI)	
	Q702	UNR92A2J0L	TRANSISTOR (SI)	
			(DIODES)	
	D101	B0EDER000009	DIODE (SI)	
	D113	MA111	DIODE (SI)	S
	D132	MA111	DIODE (SI)	S
	D133	MA111	DIODE (SI)	S
	D141	PQVDRZ20A	DIODE (SI)	S
	D301	MA8033	DIODE (SI)	
	D362	B0ECKM000008	DIODE (SI)	
	DA801	B0DDCD000001	DIODE (SI)	
	DA802	B0DDCD000001	DIODE (SI)	
			(COILS)	
	L301	G1C220M00037	COIL	S
	L474	PQLQR1WT	COIL	S
	L476	PQLQR1WT	COIL	S
	L501	G1CR10J00010	COIL	
	L809	G1C4N7Z00006	COIL	
			(RESISTOR ARRAYS)	
	RA151	D1H410220001	RESISTOR ARRAY	
	RA451	D1H422200001	RESISTOR ARRAY	
	RA452	D1H427220001	RESISTOR ARRAY	
	RA501	D1H83304A024	RESISTOR ARRAY	
	RA502	D1H81034A024	RESISTOR ARRAY	
	RA504	D1H468020001	RESISTOR ARRAY	
	RA661	D1H81014A024	RESISTOR ARRAY	
			(VARISTOR)	
	SA1	PQVDDSS301L	VARISTOR (SURGE ABSORBER)	S
			(RESISTORS)	
	R111	PQ4R10XJ824	820k	S
	R112	PQ4R10XJ103	10k	S
	R113	ERJ3GEYJ183	18k	S
	R114	ERJ2GEJ683	68k	S
	R117	ERJ3GEYJ104	100k	S

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	R118	ERJ3GEYJ104	100k	S
	R121	ERJ3GEYJ394	390k	S
	R122	ERJ3GEYJ394	390k	S
	R124	PQ4R18XJ100	10	S
	R141	ERJ3GEYJ104	100k	S
	R142	PQ4R18XJ272	2.7k	S
	R144	ERJ3GEYJ103	10k	S
	R145	ERJ2GEJ222	2.2k	S
	R148	ERJ2GEJ103	10k	S
	R149	ERJ2GEJ681	680	S
	R151	ERJ2GEJ104	100k	S
	R152	ERJ2GEJ474X	470k	S
	R159	ERJ3GEYJ471	470	S
	R160	ERJ3GEYJ471	470	S
	R161	ERJ3GEYJ104	100k	S
	R162	ERJ3GEYJ393	39k	S
	R163	ERJ12YJ120	12	S
	R164	ERJ2GEJ272	2.7k	S
	R165	ERJ3GEYJ273	27k	S
	R167	ERJ12YJ270	27	S
	R171	ERJ2GEJ220	22	S
	R172	ERJ2GEJ104	100k	S
	R175	ERJ2GEJ561	560	S
	R176	ERJ2GEJ101	100	S
	R178	ERJ2GEJ102	1k	S
	R179	ERJ2GEJ102	1k	S
	R181	ERJ2GE0R00	0	S
	R301	ERJ2GEJ121	120	S
	R302	ERJ2GEJ470	47	S
	R303	ERJ2GEJ472X	4.7k	S
	R306	ERJ2GEJ681	680	S
	R331	ERJ3EKF4702	47k	S
	R332	ERJ3EKF1802	18k	S
	R371	ERJ1TYJ3R9U	3.9	S
	R372	ERJ1TYJ3R9U	3.9	S
	R451	ERJ2GEJ391	390	S
	R501	ERJ3GEYJ100	10	S
	R502	ERJ2GEJ330	33	S
	R505	ERJ2GEJ222	2.2k	S
	R602	ERJ2GEJ472X	4.7k	S
	R605	ERJ2GEJ332	3.3k	S
	R606	ERJ2GEJ332	3.3k	S
	R612	ERJ2GEJ103	10k	S
	R653	ERJ2GEJ391	390	S
	R654	ERJ2GEJ221	220	S
	R661	ERJ2GEJ101	100	S
	R662	ERJ2GEJ101	100	S
	R663	ERJ2GEJ101	100	S
	R664	ERJ2GEJ101	100	S
	R665	ERJ2GEJ101	100	S
	R667	ERJ2GEJ101	100	S
	R668	ERJ2GEJ101	100	S
	R701	ERJ3GEYJ332	3.3k	S
	R702	ERJ2GEJ102	1k	S
	R703	ERJ2GEJ102	1k	S
	R806	ERJ2GEJ471	470	S
	R807	ERJ2GEJ471	470	S
	R891	ERJ2GEJ471	470	S
	R892	ERJ2GEJ471	470	S
			(CAPACITORS)	
	C101	F1K2H681A008	680p	
	C102	F1K2H681A008	680p	
	C110	F1J2A473A024	0.047	
	C111	F1J2A473A024	0.047	
	C112	F1J2A473A024	0.047	
	C113	PQCUV1H103KB	0.01	
	C114	F1J2A473A024	0.047	
	C115	ECUE1A104KBQ	0.1	
	C116	ECUE1A104KBQ	0.1	
	C120	ECUE1H102KBQ	0.001	
	C121	F1K2H681A008	680p	
	C122	F1K2H681A008	680p	
	C123	ECUE1H100DCQ	10p	

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	C124	ECUE1H100DCQ	10p	
	C142	ECUV1H103KBV	0.01	
	C151	ECUE1H100DCQ	10p	
	C152	ECJ0EB1A473K	0.047	
	C161	F2G1H1000009	10	
	C164	PQCUV1H333JC	0.033	S
	C167	ECUV1H122KBV	0.0012	
	C171	ECUV1C273KBV	0.027	
	C173	ECUV1A224KBV	0.22	
	C175	ECUE1H102KBQ	0.001	
	C176	PQCUV0J106KB	10	
	C178	ECUE1A104KBQ	0.1	
	C184	ECUV1A105KBV	1	
	C186	ECUE1H100DCQ	10p	
	C302	ECUE1H100DCQ	10p	
	C303	ECUV1C104KBV	0.1	
	C304	ECUV1A105KBV	1	
	C306	F2A1C1010119	100	
	C308	ECUE1C103KBQ	0.01	
	C310	ECUE1H102KBQ	0.001	
	C321	ECUE1H100DCQ	10p	
	C341	F2A1A4710032	470	
	C342	ECUV1C104KBV	0.1	
	C351	ECUV1C105KBV	1	
	C451	PQCUV0J106KB	10	
	C452	ECUE1H100DCQ	10p	
	C454	ECUE1H100DCQ	10p	
	C455	ECUE1H100DCQ	10p	
	C457	ECUE1C333KBQ	0.033	
	C458	ECUE1C333KBQ	0.033	
	C459	ECUE1H102KBQ	0.001	
	C476	ECUE1H100DCQ	10p	
	C477	ECUE1H100DCQ	10p	
	C478	ECUE1H100DCQ	10p	
	C479	ECUE1H100DCQ	10p	
	C501	ECUE1A104KBQ	0.1	
	C502	ECJ1VB0G106M	10	
	C503	ECJ1VB0G106M	10	
	C504	ECUE0J105KBQ	1	
	C505	ECJ1VB0G106M	10	
	C506	ECUV1A105KBV	1	
	C507	ECUV1A225KB	2.2	
	C508	ECUE1H100DCQ	10p	
	C509	ECUE1H120JCQ	12p	
	C510	ECUV1A105KBV	1	
	C511	ECJ1VB0G106M	10	
	C512	ECUE1A104KBQ	0.1	
	C513	ECUV1A225KB	2.2	
	C514	ECUE1A104KBQ	0.1	
	C515	ECUV1A105KBV	1	
	C516	ECUE1A104KBQ	0.1	
	C517	ECUE1A104KBQ	0.1	
	C518	ECUE1A104KBQ	0.1	
	C519	ECUE1A104KBQ	0.1	
	C520	ECUE1A104KBQ	0.1	
	C521	ECUE0J105KBQ	1	
	C522	ECUE1H100DCQ	10p	
	C530	ECUE1H100DCQ	10p	
	C611	ECUE1A104KBQ	0.1	
	C701	ECUE1H102KBQ	0.001	
	C805	F1G1H2R7A480	2.7p	
	C806	F1G1H2R7A480	2.7p	
	C810	F1G1H2R4A480	2.4p	
	C811	F1G1H1R0A480	1p	
	C812	F1G1H100A723	10p	
	C813	F1G1H2R0A480	2p	
	C814	F1G1HR40A561	0.4p	
	C820	F1G1H1R5A480	1.5p	
	C822	F1G1H100A723	10p	
	C825	F1G1H100A723	10p	
	C826	F1G1H100A723	10p	
	C827	F1G1H100A723	10p	
	C859	F1G1H2R2A480	2.2p	

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	C863	F1G1H1R5A480	1.5p	
	C891	F1G1H5R0A480	5p	
	C892	F1G1H5R0A480	5p	
	C893	F1G1H1R5A480	1.5p	
	C894	F1G1H3R0A480	3p	
	C895	F1G1H1R2A480	1.2p	
	C896	F1G1H2R2A480	2.2p	
	C897	F1G1H1R0A480	1p	
			(OTHERS)	
	MIC1	L0CBAY000018	MICROPHONE	
	E1	PNMC1018Z	MAGNETIC SHIELD, CASE (*2)	
	E2	PNWHK03SH05C	LEAD WIRE, PARALLEL WIRE	
	E3	PNWHK10SH05C	LEAD WIRE, PARALLEL WIRE	
△	F301	K5H302Y00003	FUSE	
	P101	D4DAY220A022	THERMISTOR (POSISTOR)	S
	X501	H0J138500011	CRYSTAL OSCILLATOR (*1)	

15.5.1.3. Operational P.C.Board Parts

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	PCB2	PNWP27331FXH	OPERATIONAL P. C. BOARD ASS'Y (RTL)	
			(LEDS)	
	LED1	LNJ308G8JRA	LED	
	LED2	PQVDBR1111C	LED	S

15.5.2. Handset

15.5.2.1. Cabinet and Electrical Parts

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	101	PNGP1085Z4	PANEL, LCD	PMMA-HB
	102	PNYE1026Z	TAPE, DOUBLESIDED	
	103	PNKM1121X3	CABINET BODY	PS-HB
	104	PNHR1248Z	OPTIC CONDUCTIVE PARTS, LED LENS	PS-HB
	105	L0AD01A00017	RECEIVER	
	106	PQHG10729Z	RUBBER PARTS, RECEIVER	
	107	PNYE1029Z	SPACER, CUSHIONLCD	
	108	PNBC1003Z2	BUTTON, VOLUME KEY	ABS-HB
	109	PNJK1072U	KEYBOARD SWITCH	
	110	PNHX1165Z	COVER, LCD SHEET	
	111	PNJT1027Z	CHARGE TERMINAL (L)	
	112	PNJT1026Z	CHARGE TERMINAL (R)	
	113	PQHR11315Z	GUIDE, SPEAKER HOLDER	ABS-HB
	114	L0AA02A00095	SPEAKER	
	115	PQHS10784Y	SPACER, SPEAKER NET	
	116	PQJC10056W	BATTERY TERMINAL	
	117	PNKF1091Y1	CABINET COVER	ABS-HB
	118	PNKE1052Z1	COVER, RUBBER GRIP	
	119	PNHS1079Z	SPACER, BATTERY COVER	
	120	PNKK1038Y1	LID, BATTERY COVER	ABS-HB

15.5.2.2. Main P.C.Board Parts

Note:

(*1) Reconfirm the model No. written on the handset's name plate when replacing PCB100. Because the model No. of the optional handset may differ from the included handset.

(*2) When replacing IC1, IC3 or X1, make the adjustment using PNZZTG6551CA. Refer to **Handset** (P.61) of **Things to Do after Replacing IC or X'tal**.

(*3) When removing E105, use special tools (ex. Hot air disordering tool).

(*4) When replacing the handset LCD, See **How to Replace the Handset LCD**(P.52).

(*5) Backside of this IC has a ground plate. Refer to **How to Replace the Flat Package IC** (P.64)

(*6) Supplied IC is Flat Package Type.

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	PCB100	PNWPGA650RUR	MAIN P.C.BOARD ASS'Y (RTL) (for KX-TGA650RUM) (*1)	
	PCB100	PNWPGA651RUR	MAIN P.C.BOARD ASS'Y (RTL) (for KX-TGA651RUM) (*1)	
			(ICs)	
	IC1	C1CB00002906	IC (BBIC (FLASH)) (*2) (*5) (*6)	
	IC3	PNWIGA651EXR	IC (EEPROM) (*2)	
	IC801	C1CB00001842	IC (*5)	
			(TRANSISTORS)	
	Q2	B1ADGE000004	TRANSISTOR (SI)	
	Q4	B1ADGE000004	TRANSISTOR (SI)	
	Q7	UN9219J	TRANSISTOR (SI)	S
	Q9	2SC6054JSL	TRANSISTOR (SI)	
	Q11	B1ADCF000161	TRANSISTOR (SI)	
	Q12	B1ADCF000161	TRANSISTOR (SI)	
			(DIODES)	
	D1	MA2YD2120L	DIODE (SI)	
	D7	MA2ZD0200L	DIODE (SI)	
	D13	MA8043M	DIODE (SI)	
	D14	MA8043M	DIODE (SI)	
	D21	MA8043M	DIODE (SI)	S
	D22	MA8043M	DIODE (SI)	S
	DA801	B0DDCD000001	DIODE (SI)	
			(LEDS)	
	LED1	B3AEB0000124	LED	
	LED2	B3AEB0000124	LED	
	LED3	B3AEB0000124	LED	
	LED4	B3AEB0000124	LED	
	LED5	B3AEB0000124	LED	
	LED6	B3AEB0000124	LED	
	LED7	B3AEB0000124	LED	
	LED8	B3AEB0000124	LED	
	LED9	B3AEB0000124	LED	
	LED12	B3ACB0000216	LED	
			(COILS)	
	F1	PQLQR2M5N6K	COIL	S
	L801	G1C27NJ00010	COIL	
	L802	G1C3N6ZA0063	COIL	
	L803	G1C3N6ZA0063	COIL	
			(RESISTOR ARRAYS)	
	RA1	D1H810240004	RESISTOR ARRAY	S
	RA4	D1H433220001	RESISTOR ARRAY	
	RA30	EXB28V561JX	RESISTOR ARRAY	S
	RA31	D1H456120001	RESISTOR ARRAY	
	RA32	EXB28V151JX	RESISTOR ARRAY	
	RA40	EXB28V103	RESISTOR ARRAY	
	RA61	D1H422120001	RESISTOR ARRAY	
	RA800	D1H410220001	RESISTOR ARRAY	
			(IC FILTERS)	
	L46	J0JDC0000045	IC FILTER	
	L47	J0JDC0000045	IC FILTER	
			(RESISTORS)	
	R3	ERJ2GEJ102	1k	
	R7	ERJ2GEJ122	1.2k	
	R8	ERJ2GEJ101	100	
	R20	ERJ2GEJ100	10	
	R23	ERJ2GEJ102	1k	
	R27	ERJ2GEJ821	820	
	R28	ERJ2GEJ821	820	
	R30	ERJ3GEYJ152	1.5k	
	R31	ERJ2GEJ101	100	
	R45	ERJ6RSJR10V	0.1	
	R50	ERJ2GEJ103	10k	
	R51	ERJ2GEJ471	470	
	R52	ERJ2GEJ102	1k	
	R53	ERJ2GEJ332	3.3k	

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	R54	ERJ2GEJ103	10k	
	R55	ERJ2GEJ102	1k	
	R63	ERJ2GEJ101	100	
	R64	ERJ2GEJ103	10k	
	R66	ERJ2GEJ102	1k	
	R73	ERJ2GEJ820	82	
	R74	ERJ2GEJ820	82	
	R203	D0GA563ZA006	56k	
	R215	ERJ2GE0R00	0	
	R225	ERJ2GE0R00	0	
	R249	ERJ2GE0R00	0	
	R330	ERJ2GEJ105X	1M	
	R331	ERJ2GEJ273X	27k	
	R332	ERJ2GEJ273X	27k	
	R801	ERJ2GEJ681	680	
	R802	ERJ2GEJ101	100	
	R805	ERJ2GEJ470	47	
	R806	ERJ2GEJ221	220	
	R807	ERJ2GEJ221	220	
			(CAPACITORS)	
	C1	F2A0J3310067	330	
	C2	F2A0J3310067	330	
	C5	ECUV1A105KBV	1	
	C10	ECUV1A225KB	2.2	
	C11	ECUE1A104KBQ	0.1	
	C12	PQCUV0J106KB	10	
	C13	ECUE1A104KBQ	0.1	
	C17	ECUE1H100DCQ	10p	
	C18	ECUE1H100DCQ	10p	
	C35	ECUE1H560JCQ	56p	
	C40	ECUE1A104KBQ	0.1	
	C43	ECUE1H100DCQ	10p	
	C44	ECUE1A104KBQ	0.1	
	C45	ECUE1A104KBQ	0.1	
	C46	ECUE1H100DCQ	10p	
	C47	ECUV1A105KBV	1	
	C49	ECUV1A105KBV	1	
	C50	ECUV1A105KBV	1	
	C51	ECUV1A105KBV	1	
	C52	PQCUV0J106KB	10	
	C53	PQCUV0J106KB	10	
	C54	ECUE1H100DCQ	10p	
	C55	ECUE1H100DCQ	10p	
	C72	ECUE1H100DCQ	10p	
	C73	ECUE1H100DCQ	10p	
	C74	ECUE1H100DCQ	10p	
	C75	ECUE1H100DCQ	10p	
	C96	ECUE1H100DCQ	10p	
	C97	ECUE1H100DCQ	10p	
	C103	ECUE1H101JCQ	100p	
	C104	F1G1H100A723	10p	
	C105	ECUE1H101JCQ	100p	
	C107	ECUE1H330JCQ	33p	S
	C113	ECUE1H100DCQ	10p	
	C152	ECUE1H102KBQ	0.001	
	C172	ECUE1A104KBQ	0.1	
	C175	ECUV1C105KBV	1	
	C182	F1G1H3R0A480	3p	
	C186	F1G1H2R0A480	2.0p	
	C187	F1G1H2R0A480	2.0p	
	C188	ECUE0J105KBQ	1	
	C331	ECUE0J105KBQ	1	
	C332	ECUE0J105KBQ	1	
	C341	ECUE1H390JCQ	39p	
	C580	F1G1H100A723	10p	
	C802	F1G1H2R0A480	2.0p	
	C803	F1G1H1R5A480	1.5p	
	C804	F1G1H2R0A480	2.0p	
	C805	F1G1H3R3A480	3.3p	
	C806	F1G1H3R3A480	3.3p	
	C808	ECUE1A104KBQ	0.1	
	C809	F1G1H100A723	10p	
	C810	F1G1H1R6A480	1.6p	

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	C811	F1G1H100A723	10p	
	C812	F1G1H100A723	10p	
	C813	F1G1H1R6A480	1.6p	
	C814	ECUE1H332KBQ	0.0033	
	C819	F1G1H100A723	10p	
	C822	F1G1H100A723	10p	
	C825	F1G1H100A723	10p	
	C826	F1G1H3R0A480	3p	
	C827	F1G1H100A723	10p	
	C834	F1G1H1R0A480	1p	
	C860	F1G1H100A723	10p	
	C861	F1G1H3R0A480	3p	
			(OTHERS)	
	MIC100	L0CBAY000032	MICROPHONE	
	E101	L5DYBY00001	LIQUID CRYSTAL DISPLAY (*4)	
	E102	PNHR1114Z	TRANSPARENT PLATE, LCD	PMMA-HB
	E103	PNHR1113Z	GUIDE, LCD	ABS-HB
	E104	PNHX1136Z	COVER, LCD	
	E105	PNMC1013Z	CASE, MAGNETIC SHIELD (*3)	
	E106	PNLA1020Z	ANTENNA	
	E107	PNVE1002Z	BATTERY TERMINAL	
	X1	H0J103500034	CRYSTAL OSCILLATOR (*2)	

15.5.3. Charger Unit

15.5.3.1. Cabinet and Electrical Parts

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	200	PNLC1010ZM	CHARGER UNIT ASS'Y without NAME PLATE (RTL) (for KX-TGA651RUM)	
	200-1	PNKM1131Y5	CABINET BODY	PS-HB
	200-2	PNJT1010Z	CHARGE TERMINAL	
	200-3	PNKF1098Z1	CABINET COVER	PS-HB
	200-4	PQHA10023Z	RUBBER PARTS, FOOT CUSHION	

15.5.3.2. Main P.C.Board Parts

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	PCB200	PNWPTGA641CH	MAIN P.C.BOARD ASS'Y (RTL)	
			(JACK)	
	J1	K2ECYB000001	JACK	S
			(RESISTOR)	
	R1	ERG2SJ120	12	
			(FUSE)	
△	F1	K5H302Y00003	FUSE	

15.5.4. Accessories

Note:

You can download and refer to the Operating Instructions (Instruction book) on TSN Server.

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
△	A1	PQLV219CEW	AC ADAPTOR	
	A2	PQJA10075Z	CORD, TELEPHONE	

15.5.5. Screws

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	A	XTB26+8GFJ	TAPPING SCREW	
	B	XTB2+8GFJ	TAPPING SCREW	

15.5.6. Fixtures and Tools

Note:

(*1) See **Equipment Required** (P.53), and **The Setting Method of JIG (Handset)** (P.57).

(*2) When replacing the Handset LCD, See **How to Replace the Handset LCD** (P.52).

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
		PQZZ1CD300E	JIG CABLE (*1)	
		PNZZTG6551CA	BATCH FILE CD-ROM (*1)	
		PQZZ430PIR	TIP OF SOLDERING IRON (*2)	
		PQZZ430PRB	RUBBER OF SOLDERING IRON (*2)	